HD64180R/Z 8-BIT CMOS (Micro Processing Unit)

Based on a microcoded execution unit and advanced CMOS manufacturing technology, the HD64180 is an 8-bit MPU which provides the benefits of high performance, reduced system cost and low power operation while maintaining compatibility with the large base of industry standard 8-bit software.

Performance is improved by virtue of high operating frequency, pipelining, enhanced instruction set and an integrated Memory Management Unit (MMU) with 1M or 512k bytes memory physical address space.

System cost is reduced by incorporating key system functions on-chip including the MMU, two channel refresh, two channel Asynchronous Serial Communication Interface (ASCI), Clocked Serial I/O Port (CSI/O), two channel 16-bit Programmable Reload Timer (PRT), Versatile 12 source interrupt controller and a 'dual' $(68 \times \times, 80 \times \times)$ bus interface.

Low power consumption during normal CPU operation is supplemented by two specific software controlled low power operation modes.

The HD64l80, when combined with CMOS VLSI memories and peripherals, is useful in system applications requiring high performance, battery power operation and standard software compatibility.

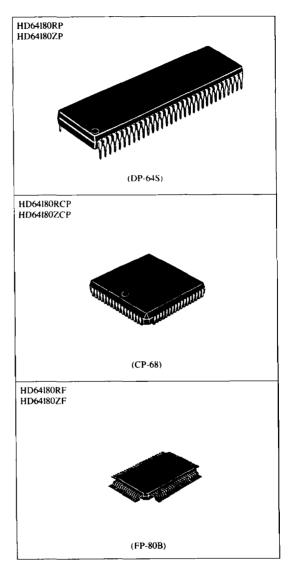
The HD64180Z is fully compatible with Z80180 (Z180) which is marketed by Zilog Inc.

■ Software Features

 Enhanced standard 8-bit software architecture: Upward compatible with CP/M-80⁻⁹

■ Hardware Features

- On-chip MMU supporting 1M byte memory (Provided 512K byte for DP-64S.
- Two channel DMAC with memory-memory, memory-I/O and memory-memory mapped I/O transfer capabilities
- Two channel, full duplex asynchronous serial communication interface (ASC) with programmable baud rate generator and modem control handshake signals
- One channel clocked serial I/O port with serial/parallel shift register
- Two channel 16-bit programmable reload timer for output waveform generation
- · Four external and eight internal interrupts
- Dual bus interface compatible with Motorola 68 family and with Intel 80 family
- · On-chip clock generator
- Operating Frequency up to 10 MHz
- · Low power dissipation: 50 mW at 4 MHz Operation (typ.)
- R = Interface with 63/68, 80xx peripherals
- Z = Interface with Z80 peripherals



Pin Function Differences in the HD64180 Series

Package * Type	Pin No.	HD64180R1	HD64180Z
	18	V _{ss}	V _{ss}
CP-68	35	A ₁₉	A ₁₉
	52	NC	TEST
	12	V _{ss}	V _{ss}
FP-80B	33	A ₁₉	A ₁₉
	53	NC	TEST

^{*&}quot;J" after package designation indicates industrial temperature parts.

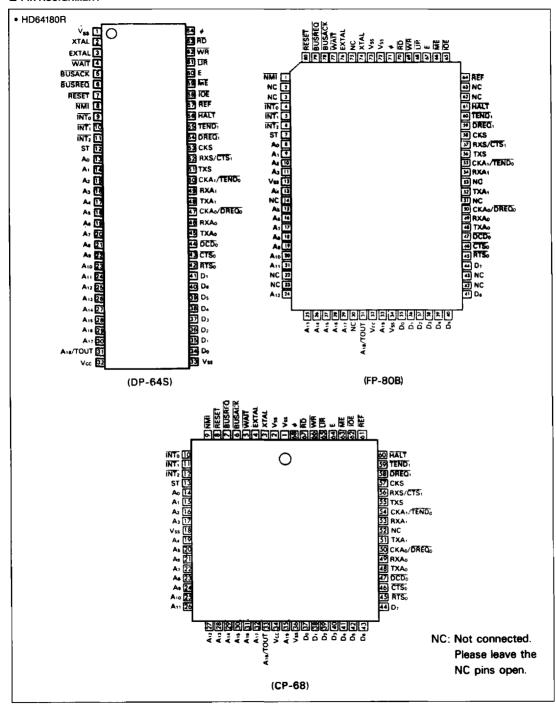
HD64180R

Part No.	Clock Frequency (MHz)	Package Type	Address Space
HD64180RP-6	6		
HD64180RP-8	8	DP-64S	512 K Byte
HD64180RP-10	10		
HD64180RF-6X	6	-	
HD64180RF-8X	8	FP-80	1 M Byte
HD64180RF-10X	10		
HD64180RCP-6X	6		
HD64180RCP-8X	8	CP-68	l M Byte
HD64180RCP-10X	10	C1-00	1 M Dyte

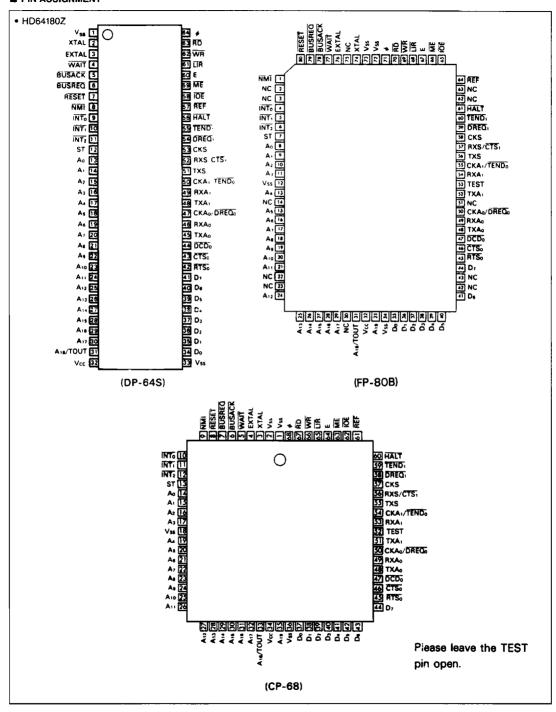
HD64180Z

Part No.	Clock Frequency (MHz)	Package Type	Address Space	
HD64180ZP-6	6			
HD64180ZP-8	8	DP-64S	512 K Byte	
HD64180ZP-10	10			
HD64180ZF-6X	6			
HD64180ZF-8X	8	FP-80	1 M Byte	
HD64180ZF-10X	10			
HD64180ZCP-6X	6			
HD64180ZCP-8X	8	CP-68	l M Byte	
HD64180ZCP-10X	10			

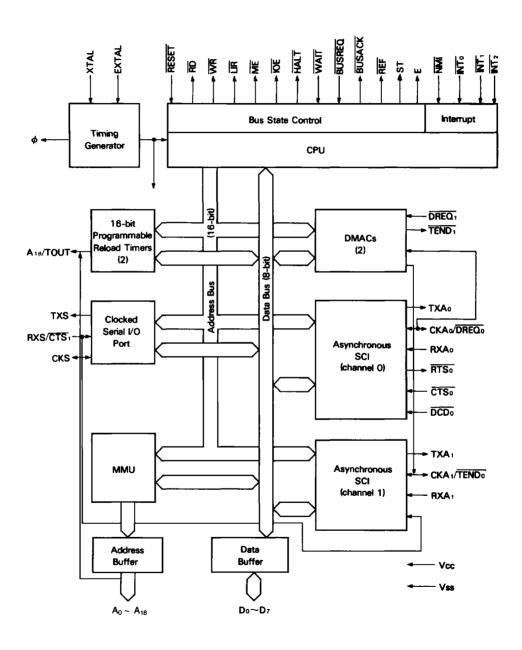
■ PIN ASSIGNMENT



■ PIN ASSIGNMENT



■ HD64180 BLOCK DIAGRAM



(A₀ ~ A₁₉: HD64180R1, HD64180Z; FP-80, CP-68)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V _{cc}	-0.3~ + 7.0	٧
Input Voltage	V _{in}	-0.3 ~ V _{cc} + 0.3	٧
Operating Temperature	T_{opr} $\frac{-20 \sim +75^{\circ}}{-40 \sim +85^{\circ}}$		°C
Storage Temperature	T _{stg}	-55 ~ <u>+ 150</u>	°C

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ ELECTRICAL CHARACTERISTICS

• DC CHARACTERISTICS ($V_{cc}=5V\pm10\%$, $V_{ss}=0V$, ta=-20 ~ +75°C, Industrial Temp Ta=-40 ~ +85°C, unless otherwise noted.)

Item	Symbol	Condition	min.	typ.	max.	Unit
Input "H" Voltage RESET, EXTAL, NMI	V _{IH1}		V _{CC} -0.6		V _{CC} + 0.3	٧
Input "H" Voltage Except RESET, EXTAL, NMI	V _{IH2}		2.0	_	V _{CC} + 0.3	٧
Input "L" Voltage RESET, EXTAL, NMI	V _{IL1}		-0.3		0.6	٧
Input "L" Voltage Except RESET, EXTAL, NMI	V _{IL2}		-0.3	_	0.8	٧
Output "H" Voltage	V _{OH}	$I_{OH} = -200\mu A$	2.4			V
All Outputs	▼ OH	$I_{OH} = -20\mu A$	V _{CC} -1.2			٧
Output "L" Voltage All Outputs	V_{OL}	I _{OL} = 2.2mA	_		0.45	٧
Input Leakage Current All Inputs Except XTAL, EXTAL	I _{IL}	$V_{in} = 0.5 \sim V_{CC} - 0.5$	_		1.0	μΑ
Three State Leakage Current	I _{TL}	$V_{in} = 0.5 \sim V_{CC} - 0.5$	_	_	1.0	μΑ
Power Dissipation	Icc*	f = 4MHz	_	10	20	
(Normal Operation)		f = 6MHz	_	15	30	
		f = 8HMz		20	40	
		f = 10MHz		25	50	mA
Power Dissipation	_	f = 4HMz	_	2.5	5.0	****
(SYSTEM STOP mode)		f = 6MHz	_	3.3	7.5	
		f = 8HMz	_	5.0	10.0	
		f = 10MHz		6.3	12.5	
Pin Capacitance	Ср	V _{in} = 0V, f = 1HMz Ta = 25°C			12	рF

 $^{^*}V_{IH}$ min. = V_{CC} -1.0V, V_{IL} max. = 0.8V (all output terminal are at no load)

^{*}Standard Temp.

^{**}Industrial Temp.

• DC CHARACTERISTICS ($V_{cc}=5V\pm10\%$, $V_{ss}=0V$, ta=-20 ~ +75°C, Industrial Temp Ta=-40 ~ +85°C, unless otherwise noted.)

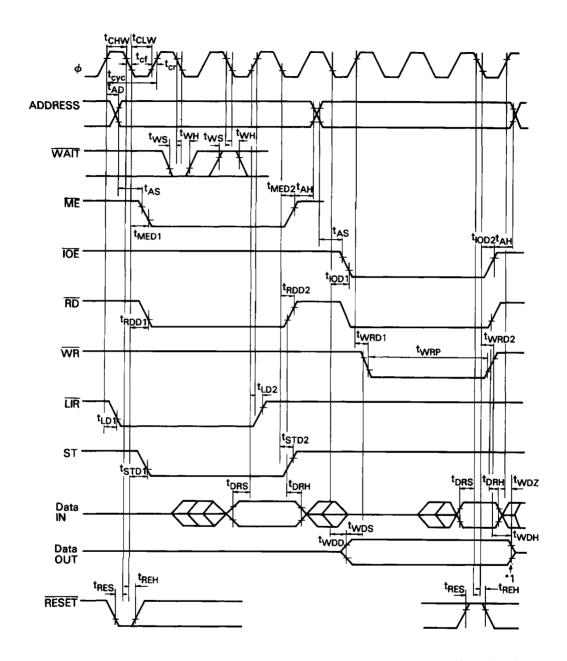
		HD64180R/Z-4		HD64180R/Z-6		HD64180R/Z-8		HD64180R/Z-10		•
Item	Symbol	min.	max.	min.	max.	min.	max.	min.	max.	unit
Clock Cycle Time	t _{cyc}	250	2000	162	2000	125	2000	100	2000	ns
Clock "H" Pulse Width	t _{CHW}	110		65		50		40		ns
Clock "L" Pulse Width	t _{CLW}	110		65		50		40		ns
Clock Fall Time	t _{cf}		15		15		15		10	ns
Clock Rise Time	t _{cr}		15		15		15		10	ns
Address Delay Time	t _{AD}		110		90		80		70	ns
Address Set-up Time (ME or IQE ↓)	tas	50		30		20			70	ns
ME Delay Time 1	t _{MED1}		85		60		45	10		ns
IO C = 1			85		60		45		50	
RD Delay Time 1 IO C = 0	t _{RDD1}		85		65		60		55	ns
LIR Delay Time 1	t _{LD1}		100		80		70*		60	ns
Address Hold Time 1 (ME, IQE, RD or WR↑)	t _{AH}	80		35		20		10		ns
ME Delay Time 2	t _{MED} 2		85		60		45		50	ns
RD Delay Time 2	t _{RDD2}	•	85		60	_	45		50	ns
LIR Delay Time 2	t _{LD2}		100		80		70*		60	ns
Data Read Set-up Time	t _{DRS}	50		40		30		25		ns
Data Read Hold Time	t _{DRH}	0		0		0		0		ns
ST Delay Time 1	t _{STD1}		110		90	_	70		60	ns
ST Delay Time 2	t _{STD2}		110		90		70		60	ns
WAIT Set-up Time	tws	80		40		40		30		ns
WAIT Hold Time	twH	70		40		40		30		ns
Write Data Floating Delay Time	t _{WDZ}		100		95		70		60	ns
WR Delay Time 1	twRD1		90		65		60		50	ns
Write Data Delay Time	twod		110		90		80		60	ns
Write Data Set-up Time (WR ↓)	twos	60		40		20		15		ns
WR Delay Time 2	t _{WRD2}		90		80		60		50	ns
WR Pulse Width	twnp	280		170		130		110		ns

^{*}For a loading capacitance of less than or equal to 40 picofarads and operating temperature from 0 to 50 degrees, subtract 10 nanoseconds from the value given in the maximum columns.

@HITACHI

		HD64180R/Z-4		HD64180R/Z-6		HD64180R/Z-8		HD64180R/Z-10		
Item	Symbol	min.	max.	min.	max.	min.	max.	min.	max.	unit
Write Data Hold Time (WR ↑)	twoH	60		40		15		10		ns
IOE Delay Time 1	t _{IOD1}		85		60		45		50	ns
		_	85		65		60		55	ns
IOE Delay Time 2	t _{IOD2}		85		60		45		50	ns
IOE Delay Time 2 (LIR↓)	t _{IOD3}	540		340		250		200		ns
INT Set-up Time (φ↓)	tINTS	80		40		40		30		ns
INT Hold Time (φ↓)	tINTH	70		40		40		30		ns
NMI Pulse Width	t _{NMIW}	120		120		100		80		ns
BUSREQ Set-up Time (φ↓)	tBRS	80		40		40		30		ns
BUSREQ Hold Time	t _{BRH}	70		40		40		30		ns
BUSACK Delay Time 1	t _{BAD1}		100		95		70		60	ns
BUSACK Delay Time 2	t _{BAD2}		100		95		70		60	ns
Bus Floating Delay Time	t _{BZD}		130		125		90		70	ns
ME Pulse Width (HIGH)	tMEWH	200		110		90		70		ns
ME Pulse Width (LOW)	tMEWL	210		125		100		80		ns
REF Delay Time 1	t _{RFD1}		110		90		80		60	ns
REF Delay Time 2	t _{RFD2}		110		90		80		60	ns
HALT Delay Time 1	t _{HAD1}		110		90		80		50	ns
HALT Delay Time 2	t _{HAD2}		110		90		80		50	ns
DREQ i Set-up Time	tDRQS	80		40		40		30		ns
DREQ i Hold Time	tDRQH	70		40		40		30		ns
TEND i Delay Time 1	t _{TED1}		85		70		60		50	ns
TEND i Delay Time 2	t _{TED2}		85		70		60		50	ns
Enable Delay Time 1	t _{ED1}		100		95		70		60	ns
Enable Delay Time 2	t _{ED2}		100		95		70		60	ns
E Pulse Width (HIGH)	PWEH	150		75		65		55		ns
E Pulse Width (LOW)	PWEL	300		180		130		110		ns

		HD641	64180R/Z-4 HD64180R/Z-6		HD64180R/Z-8		HD64180R/Z-10			
Item	Symbol	min,	max.	min.	max.	min.	max.	min.	max.	unit
Enable Rise Time	tEr		25	-	20		20		20	ns
Enable Fall Time	tef		25		20		20		20	ns
Timer Output Delay Time	tтор		300		300		200		150	ns
CSI/O Transmit Data Delay Time (Internal Clock Operation)	tstdi		200		200		200		150	ns
CSI/O Transmit Data Delay Time (External Clock Operation)	t _{STDE}		7.5tcyc + 300		7.5tcyc + 300		7.5tcyc + 200		7.5tcyc + 150	ns
CSI/O Receive Data Set-up Time (Internal Clock Operation)	tsrsi	1		1		1		1		tcyc
CSI/O Receive Data Hold Time (Internal Clock Operation)	tsrhi	1		1		1		1		tcyc
CSI/O Receive Data Set-up Time (External Clock Operation)	tsrse	1		1		1		1		tcyc
CSI/O Receive Data	tsrhe	1		1		1		1		tcyc
RESET Set-up Time	t _{RES}	120		120		100		80		ns
RESET Hold Time	tREH	80		80	Ţ	70		60		ns
Oscillator Stabilization Time	tosc		20		20		20		40	ms
External Clock Rise Time (EXTAL)	t _{EXr}		25		25		25		25	ns
External Clock Fall Time (EXTAL)	t _{EXf}		25		25		25		25	ns
RESET Rise Time	t _{Rr}		50		50		50		50	ms
RESET Fall Time	t _{Rf}		50		50		50		50	ms
Input Rise Time (except EXTAL, RESET)	t _{lr}		10		100		100		100	ns
Input Fall Time (except EXTAL, RESET)	t _{if}		100		100		100		100	ns



*1 Output buffer is off at this point.

Figure 1 CPU Timing (1)

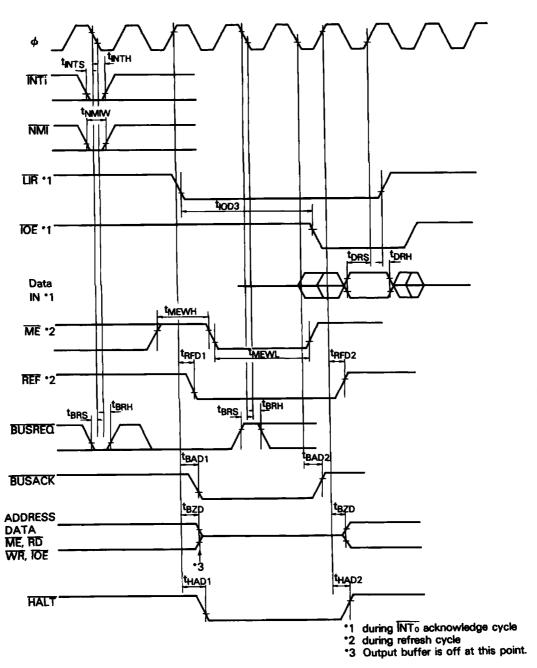


Figure 1 CPU Timing (2)

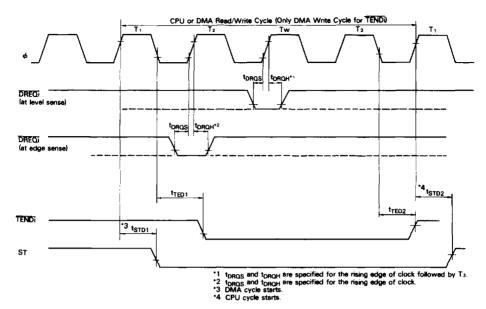


Figure 2 DMA Control Signals

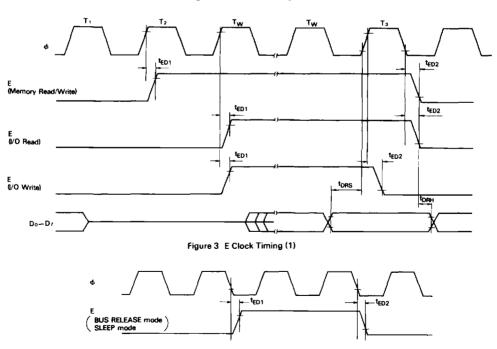


Figure 3 E Clock Timing (2)

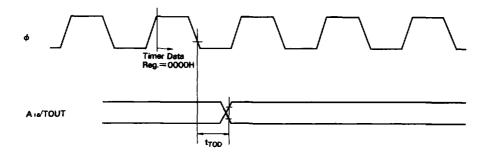


Figure 4 Timer Output Timing

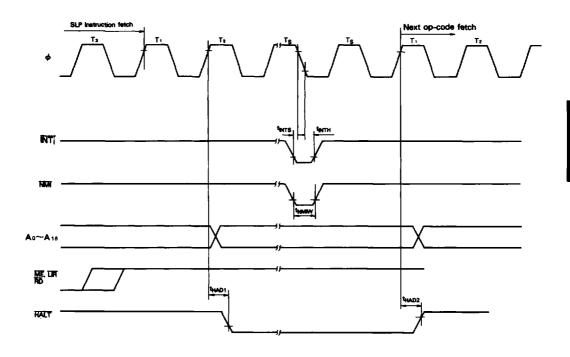


Figure 5 SLP Execution Cycle



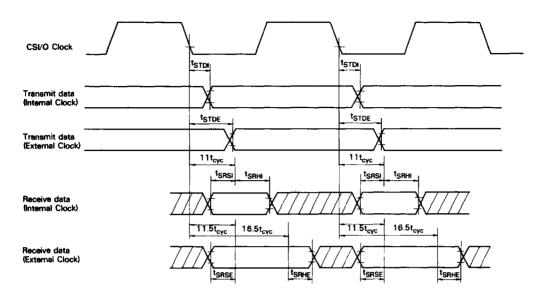
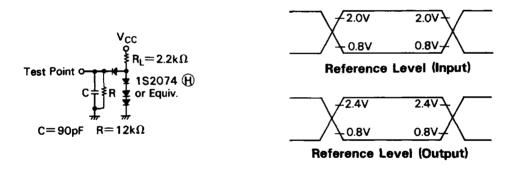
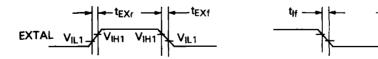


Figure 6 CSI/O Receive/Transmit Timing





EXTAL Rise time and Fall time

Inputs, other than EXTAL, Rise time and Fall time

Figure 7 Bus Timing Test Load (TTL Load)

1 PIN DESCRIPTION

XTAL (IN)

Crystal oscillator connection. Should be left open if an external TTL clock is used. It is noted this input is not a TTL level input. See Table D.C. characteristics.

EXTAL (IN)

Crystal oscillator connection. An external TTL clock can be input on this line. This input is schmitt triggered.

a (QUT)

System Clock. The frequency is equal to one-half of crystal oscillator.

RESET -- CPU Reset (IN)

When LOW, initializes the HD64180 CPU. All output signals are held inactive during RESET.

A₀-A₁₇ — Address Bus (OUT, 3-STATE) A₁₈/TOUT

19-bit address bus provides physical memory addresses of up to 512k bytes. The address bus enters the high impedance state during RESET and when another device acquires the bus as indicated by BUSREQ and BUSACK LOW. A_{1a} is multiplexed with the TOUT output from PRT channel 1. During RESET, the address bus function is selected. TOUT function can be selected under software control.

Do-D7 - Data Bus (IN/OUT, 3-STATE)

Bidirectional 8-bit data bus. The data bus enters the high impedance state during RESET and when another device acquires the bus as indicated by BUSREQ and BUSACK LOW.

RD - Read (OUT, 3-STATE)

Used during a CPU read cycle to enable transfer from the external memory or I/O device to the CPU data bus.

WR - Write (OUT, 3-STATE)

Used during a CPU write cycle to enable transfer from the CPU data bus to the external memory or I/O device.

ME - Memory Enable (OUT, 3-STATE)

Indicates memory read or write operation. The HD64180 asserts ME LOW in the following cases.

- (a) When fetching instructions and operands.
- (b) When reading or writing memory data.
- (c) During memory access cycles of DMA.
- (d) During dynamic RAM refresh cycles.

IOE - I/O Enable (OUT, 3-STATE)

Indicates I/O read or write operation. The HD64180 asserts IOE LOW in the following cases.

- (a) When reading or writing I/O data.
- (b) During I/O access cycles of DMA.
- (c) During INT, acknowledge cycle

WAIT - Bus Cycle Wait (IN)

Introduces wait states to extend memory and I/O cycles. If LOW at the falling edge of T_2 , a wait state $(\underline{T}w)$ is inserted. Wait states will continue to be inserted until the \underline{WAIT} input is sampled HIGH at the falling edge of Tw, at which time the bus cycle will proceed to completion.

E - Enable (OUT)

Synchronous clock for connection to HD63×× series and other 6800/6500 series compatible peripheral LSIs.

BUSREQ - Bus Request (IN)

Another device may request use of the bus by asserting BUSREQ LOW. The CPU will stop executing instructions and

places the address bus, data bus, \overline{RD} , \overline{WR} , \overline{ME} and \overline{IOE} in the high impedance state.

BUSACK - Bus Acknowledge (OUT)

When the CPU completes bus release (in response to BUSREQ LOW), it will assert BUSACK LOW. This acknowledges that the bus is free for use by the requesting device.

HALT - Halt/Sleep Status (OUT)

Asserted LOW after execution of the HALT or SLP instructions. Used with LIR and ST output pins to encode CPU status.

LIR - Load Instruction Register (OUT)

Asserted LOW when the current cycle is an op-code fetch cycle. Used with HALT and ST output pins to encode CPU status.

ST - Status (OUT)

Used with the HALT and LIR output pins to encode CPU status.

Table 1 Status Summary

ST	HALT	LÎR	Operation
0	1	0	CPU operation (1st op-code fetch)
1	1	0	CPU operation (2nd op-code and 3rd op-code fetch)
1	1	1	CPU operation (MC except for op-code fetch)
0	Х	1	DMA operation
0	0	ō	HALT mode
1	0	1	SLEEP mode (including SYSTEM STOP mode)

NOTE) X: Don't care
MC: Machine cycle

REF - Refresh (OUT)

When LOW, indicates the CPU is in the dynamic RAM refresh cycle and the low-order 8 bits $(A_0$ - $A_7)$ of the address bus contain the refresh address.

NMI - Non-Maskable Interrupt (IN)

When edge transition from HIGH to LOW is detected, forces the CPU to save certain state information and vector to an interrupt service routine at address 0066H. The saved state information is restored by executing the RETN (Return from Non-Maskable Interrupt) instruction.

INTo - Maskable Interrupt Level 0 (IN)

When LOW, requests a CPU interrupt (unless masked) and saves certain state information unless masked by software. INT₀ requests service using one of three software programmable interrupt modes.

Mode	Operation
0	Instruction fetched and executed from data bus
1	Instruction fetched and executed from address 0038H.
2	Vector System — Low-order 8 bits vector table address fetched from data bus.

In all modes, the saved state information is restored by executing RET1 (Return from Interrupt) instruction.

INT., INT. - Maskable Interrupt Level 1, 2 (IN)

When LOW, requests a CPU interrupt (unless masked) and saves certain state information unless masked by software. \overline{INT}_1 and \overline{INT}_2 (and internally generated interrupts) request interrupt service using a vector system similar to Mode 2 of \overline{INT}_0 .

DREQ - DMA Request - Channel 0 (IN)

When LOW (programmable edge or level sensitive), requests DMA transfer service from channel 0 of the HD64180 DMAC. \overline{DREQ}_0 is used for Channel 0 memory \Longrightarrow 1/O and memory \Longrightarrow memory mapped I/O transfers. \overline{DREQ}_0 is not used for memory \Longrightarrow memory transfers. This pin is multiplexed with CKA_0 .

TENDo - Transfer End - Channel 0 (OUT)

Asserted LOW synchronous with the last write cycle of channel 0 DMA transfer to indicate DMA completion to an external device. This pin is multiplexed with CKA₁.

DREQ. - DMA Request - Channel 1 (IN)

When LOW (programmable edge or level sense), requests DMA transfer service from channel 1 of the HD64180 DMAC. Channel 1 supports Memory \iff I/O transfers.

TEND₁ - Transfer End - Channel 1 (OUT)

Asserted LOW synchronous with the last write cycle of channel 1 DMA transfer to indicate DMA completion to an external device.

TXA₀ — Asynchronous Transmit Data — Channel 0 (OUT)

Asynchronous transmit data from channel 0 of the Asynchronous Serial Communication Interface (ASCI).

RXA₀ — Asynchronous Receive Data — Channel 0 (IN)

Asynchronous receive data to channel 0 of the ASCI.

CKA₀ - Asynchronous Clock - Channel 0 (IN/OUT)

Clock input/output for channel 0 of the ASCI. This pin is multiplexed (software selectable) with DREQ₀.

RTS₀ - Request to Send - Channel 0 (OUT)

Programmable modem control output signal for channel 0 of the ASCI.

CTS₀ - Clear to Send - Channel 0 (IN)

Modem control input signal for channel 0 of the ASCI.

DCD₀ - Data Carrier Detect - Channel 0 (IN)

Modem control input signal for channel 0 of the ASCI.

TXA₁ - Asynchronous Transmit Dats - Channel 1 (OUT) Asynchronous transmit data from channel 1 of the ASCI.

RXA₁ — Asynchronous Receive Data — Channel 1 (IN)

Asynchronous receive data to channel 1 of the ASCI.

CKA, - Asynchronous Clock - Channel 1 (IN/OUT)

Clock input/output for channel 1 of the ASCI. This pin is multiplexed (software selectable) with TENDa.

CTS, - Clear to Send - Channel 1 (IN)

Modem control input signal for channel 1 of the ASCI. This pin is multiplexed (software selectable) with RXS.

TXS - Clocked Serial Transmit Data (OUT)

Clocked serial transmit data from the Clocked Serial I/O Port (CSI/O).

RXS - Clocked Serial Receive Data (IN)

Clocked serial receive data to the CSI/O. This pin is multiplexed (software selectable) with ASCI channel 1 CTS₁ modern control input.

CKS - Serial Clock (IN/OUT)

Input or output clock for the CSI/O.

TOUT - Timer Output (OUT)

Pulse output from Programmable Reload Timer channel 1. This pin is multiplexed (software selectable) with A_{18} (Address 18).

V_{CC} - Power Supply

V_{SS} - Ground

Multiplexed pin descriptions

Asa/TOUT

During RESET, this pin is initialized as A₁₈ pin. If either TOC1 or TOC0 bit in Timer Control Register (TCR) is set to 1, TOUT function is selected.

If TOC1 and TOC0 bits are cleared to 0, A₁₄ function is selected.

CKA0/DREQ

During RESET, this pin is initialized as CKA_0 pin. If either <u>DM1</u> or SM1 in DMA Mode Register (DMODE) is set to 1, $\overline{DREQ_0}$ function is always selected.

CKA1/TENDO

During RESET, this pin is initialized as CKA₁ pin. If CKA1D bit in ASCI control register ch 1 (CNTLA1) is set to 1, TEND₀ function is selected. If CKA1D bit is set to 0, CKA₁ function is selected.

RXS/CTS.

During RESET, this pin is initialized as RXS pin. If CTS1E bit in ASCI status register ch1 (STAT1) is set to 1, CTS₁ function is selected.

If CTS1E bit is set to 0, RXS function is selected.

2 CPU REGISTERS

The HD64180 CPU registers consist of Register Set GR, Register Set GR' and Special Registers.

The Register Set GR consists of 8-bit Accumulator (A), 8-bit Flag Register (F), and three General Purpose Registers (BC, DE, and HL) which may be treated as 16-bit registers (BC, DE, and HL) or as individual 8-bit registers (B, C, D, E, H, and L) depending on the instruction to be executed. The Register Set GR' is alternate register set of Register Set GR and also contains Accumulator

(A'), Flag Register (F') and three General Purpose Registers (BC', DE', and HL'). While the alternate Register Set GR' contents are not directly accessible, the contents can be programmably exchanged at high speed with those of Register Set GR.

The Special Registers consist of 8-bit Interrupt Vector Register (I), 8-bit R Counter (R), two 16-bit Index Registers (IX and IY), 16-bit Stack Pointer (SP), and 16-bit Program Counter (PC).

Fig. 8 shows CPU registers configuration.

Register Set GR

Accumulator A	Flag Register F	
B Register	C Register	
D Register	E Register	
H Register	L Register	$\left ight $

General Purpose Registers

Register Set GR'

Accumulator A'	Flag Register F'	
B' Register	C' Register	General
D' Register	E' Register	> Purpose Registers
H' Register	L' Register	

Special Registers

Interrupt Vector Register	R Counter
1	R
Index Register	IX
Index Register	IY
Stack Pointer	SP
Program Coun	iter PC

Figure 8 CPU Register Configuration

2.1 Register Description

(1) Accumulator (A, A')

The Accumulator (A) serves as the primary register used for many arithmetic, logical and I/O instructions.

(2) Flag Registers (F, F')

The flag register stores various status bits (described in the next section) which reflect the results of instruction execution.

(3) General Purpose Registers (BC, BC', DE, DE', HL, HL')

The General Purpose Registers are used for both address and data operation. Depending on instruction, each half (8 bits) of these registers (B, C, D, E, H, and L) may also be used.

(4) Interrupt Vector Register (I)

For interrupts which require a vector table address to be calculated (INT, Mode 2, INT, INT, and internal interrupts), the Interrupt Vector Register (I) provides the most significant byte of the vector table address.

(6) R Counter (R)

The least significant seven bits of the R Counter (R) serve to count the number of instructions executed by the HD64180. R is incremented for each CPU op-code fetch cycles (each LIR cycles).

(6) Index Registers (IX, and IY)

The Index Registers are used for both address and data operations. For addressing, the contents of a displacement specified in the instruction are added to or subtracted from the Index Register to determine an effective operand address.

(7) Stack Pointer (SP)

The Stack Pointer (SP) contains the memory address based LIFO stack.

(8) Program Counter (PC)

The Program Counter (PC) contains the address of the instruction to be executed and is automatically updated after each instruction fetch.

(9) Flag Register (F)

The Flag Register stores the logical state reflecting the results of instruction execution. The contents of the Flag Register are used to control program flow and instruction operation.

bit 7 6 5 4 3 2 1 0
S Z - H - P/V N C Flag Register (F

S: Sign (bit 7)

S stores the state of the most significant bit (bit 7) of the result. This is useful for operations with signed numbers in which values with bit 7 = 1 are interpreted as negative.

Z: Zero (bit 6)

Z is set to 1 when instruction execution results containing 0. Otherwise, Z is reset to 0.

H: Half Carry (bit 4)

H is used by the DAA (Decimal Adjust Accumulator) instruction to reflect borrow or carry from the least significant 4 bits and thereby adjust the results of BCD addition and subtraction.

P/V: Parity/Overflow (bit 2)

P/V serves a dual purpose. For logical operations P/V is set to 1 if the number of 1 bit in the result is even and P/V is reset to 0 if the number of 1 bit in the result is odd. For two complement arithmetic, P/V is set to 1 if the operation produces a result which is outside the allowable range (+127 to -128 for 8-bit operations, +32767 to -32768 for 16-bit operations).

N: Negative (bit 1)

N is set to 1 if the last arithmetic instruction was a subtract operation (SUB, DEC, CP, etc.) and N is reset to 0 if the last arithmetic

8-bit Register

g or g' field	Register
0 0 0	В
0 0 1	С
0 1 0	D
0 1 1	Е
1 0 0	н
1 0 1	L
1 1 0	-
1 1 1	Α

16-bit Register

zz field	Register
0 0	ВС
0 1	DE
1 0	HL
1 1	AF

instruction was an addition operation (ADD, INC, etc.).

C: Carry (bit 0)

C is set to 1 when a carry (addition) or borrow (subtraction) from the most significant bit of the result occurs. C is also affected by Accumulator logic operations such as shifts and rotates.

3 ADDRESSING MODES

The HD64180 instruction set includes eight addressing modes.

Implied Register Register Direct

Register Indirect

Indexed

Extended

Immediate

Relative

Ю

(1) Implied Register (IMP)

Certain op-codes automatically imply register usage, such as the arithmetic operations which inherently reference the Accumulator, Index Registers, Stack Pointer and General Purpose Registers.

(2) Register Direct (REG)

Many op-codes contain bit fields specifying registers to be used for the operation. The exact bit field definition vary depending on instruction as follows.

ww field	Register
0 0	ВС
0 1	DE
1 0	HL
1 1	SP

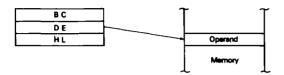
xx field	Register
0 0	ВС
0 1	DE
1 0	IX
1 1	SP

yy field	Register
0 0	B C
0 1	DE
1 0	IY
1 1	SP

Suffixed H and L to ww,xx,yy,zz (ex. wwH,IXL) indicate upper and lower 8-bit of the 16-bit register respectively.

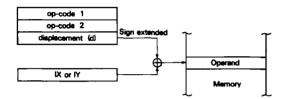
(3) Register Indirect (REG)

The memory operand address is contained in one of the 16-bit General Purpose Registers (BC, DE and HL).



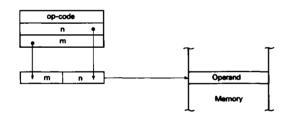
(4) Indexed (INDX)

The memory operand address is calculated using the contents of an Index Register (IX or IY) and an 8-bit signed displacement specified in the instruction.



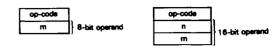
(5) Extended (EXT)

The memory operand address is specified by two bytes contained in the instruction.



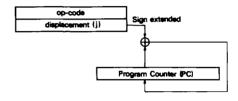
(6) Immediate (IMMED)

The memory operands are contained within one or two bytes of the instruction.



(7) Relative (REL)

Relative addressing mode is only used by the conditional and unconditional branch instructions. The branch displacement (relative to the contents of the program counter) is contained in the instruction.



(8) IO (IO)

IO addressing mode is used only by I/O instructions. This mode specifies I/O address ($\overline{IOE}=0$) and outputs them as follows.

- An operand is output to A₀-A₇. The Contents of Accumulator is output to A₈-A₁₈.
- The Contents of Register B is output to A₀-A₇. The Contents of Register C is output to A₂-A₁₅.
- (3) An operand is output to A₀-A₇. 00H is output to A₈-A₁₆. (useful for internal I/O register access)
- (4) The Contents of Register C is output to A₀-A₇. 00H is output to A₈-A₁₅. (useful for internal I/O register access)



■ CPU BUS TIMING

This section explains the HD64180 CPU timing for the following operations.

- (1) Instruction (op-code) fetch timing.
- (2) Operand and data read/write timing.
- (3) I/O read/write timing.
- (4) Basic instruction (fetch and execute) timing
- (5) RESET timing
- (6) BUSREQ/BUSACK bus exchange timing.

The basic CPU operation consists of one or more "machine cycles" (MC). A machine cycle consists of three system clocks, T_1 , T_2 and T_3 while accessing memory or I/O, or it consists of one system clock, Ti white the CPU internal operation. The system clock (ϕ) is half frequency of crystal oscillation (Ex. 8 MHz crystal \longrightarrow ϕ of 4

MHz, 250 nsec). For interfacing to slow memory or peripherals, optional wait states (Tw) may be inserted between T_2 and T_3 .

· Instruction (op-code) Fetch Timing

Fig. 9 shows the instruction (op-code) fetch timing with no wait states.

An op-code fetch cycle is externally indicated when the LIR (Load Instruction Register) output pin is LOW.

In the first half of T₁, the address bus (A₀-A₁₈) is driven with the contents of the Program Counter (PC). Note that this is the translated address output of the HD64180 on-chip MMU.

In the second half of T₁, the ME (Memory Enable) and RD (Read) signals are asserted LOW, enabling the memory.

The op-code on the data bus is latched at the rising edge of T_3 and the bus cycle terminates at the end of T_3 .

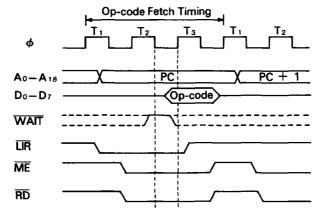


Figure 9 Op-Code Fetch Timing

Fig. 10 illustrates the insertion of wait states (Tw) into the opcode fetch cycle. Wait states (Tw) are controlled by the external WAIT input combined with an on-chip programmable wait state generator.

At the falling edge of T, the combined WAIT input is sampled. If

 $\overline{\text{WAIT}}$ input is asserted LOW, a wait state (Tw) is inserted. The address bus, $\overline{\text{ME}}$, $\overline{\text{RD}}$ and $\overline{\text{LIR}}$ are held stable during wait states. When the $\overline{\text{WAIT}}$ is sampled inactive HIGH at the falling edge of Tw, the bus cycle enters T_s and completes at the end of T_s .

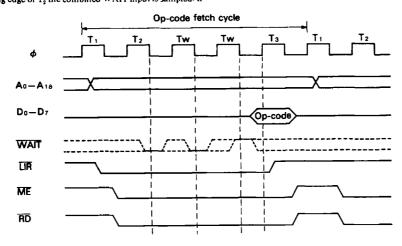


Figure 10 Op-Code Fetch Timing (with wait state)

. Operand and Data Read/Write Timing

The instruction operand and data read/write timing differs from op-code fetch timing in two ways. First, the LIR output is held inactive. Second, the read cycle timing is relaxed by one-half clock cycle since data is latched at the falling edge of T_a.

Instruction operands include immediate data, displacement and extended addresses and have the same timing as memory data reads.

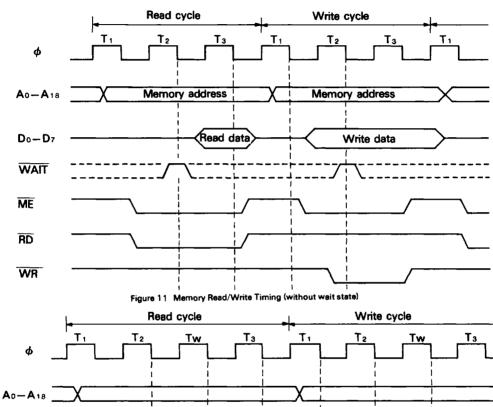
During memory write cycles the ME signal goes active in the

second half of T_1 . At the end of T_1 , the data bus is driven with the write data

At the start of $\underline{T_3}$, the \overline{WR} signal is asserted LOW enabling the memory. \overline{ME} and \overline{WR} go inactive in the second half of T_3 followed by deactivation of the write data on the data bus.

Wait states (Tw) are inserted as previously described for op-code fetch cycles.

Fig. 11 illustrates the read/write timing without wait states (Tw), while Fig. 12 illustrates read/write timing with wait states (Tw).



Do-D7 Read data Write data

WAIT

ME

RD

WR

Figure 12 Memory Read/Write Timing (with wait state)



4.3 I/O Read/Write Timing

I/O instructions cause data read/write transfer which differs from memory data transfer in the following three ways. The \overline{IOE} (I/O Enable) signal is asserted LOW instead of the \overline{ME} signal. The 16-bit I/O address is not translated by the MMU and A_{16} - A_{18} are held

LOW. At least one wait state (Tw) is always inserted for I/O read and write cycles (except internal I/O cycles).

Fig. 13 shows I/O read/write timing with the automatically inserted wait state (Tw).

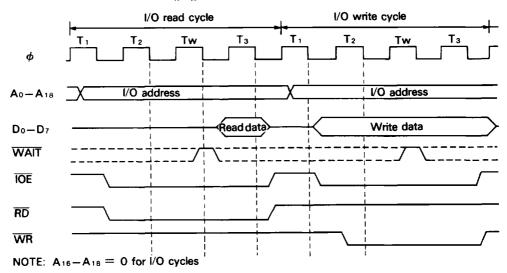


Figure 13 I/O Read/Write Timing

4.4 Basic Instruction Timing

An instruction may consist of a number of machine cycles including op-code fetch, operand fetch and data read/write cycles. An instruction may also include cycles for internal processing in which case the bus is idle.

The example in Fig. 14 illustrates the bus timing for the data transfer instruction LD (IX+d),g. This instruction moves the contents of a CPU register (g) to the memory location with address

computed by adding an signed 8-bit displacement (d) to the contents of an index register (IX).

The instruction cycle starts with the two machine cycles to read the two bytes instruction op-code as indicated by \overline{LIR} LOW. Next, the instruction operand (d) is fetched.

The external bus is idle while the CPU computes the effective address. Finally, the computed memory location is written with the contents of the CPU register (g).

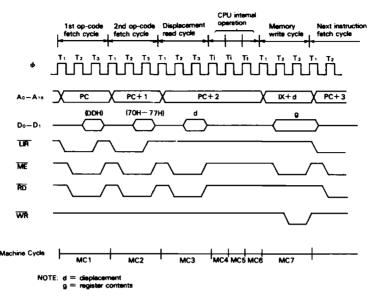


Figure 14 LD (IX+d), g Instruction Timing

4.5 RESET Timing

Fig. 15 shows the HD64180 hardware RESET timing. If the RE-SET pin is LOW for at least six clock cycles, processing is terminated and the HD64180 restarts execution from (logical and physical) address 00000H.

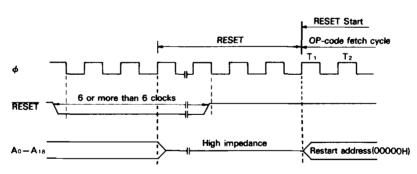


Figure 15 RESET Timing

4.6 BUSREQ/BUSACK Bus Exchange Timing

The HD64180 can coordinate the exchange of control, address and data bus ownership with another bus master. The alternate bus master can request the bus release by asserting the BUSREQ (Bus Request) input LOW. After the HD64180 releases the bus, it relinquishes control to the alternate bus master by asserting the BUSACK (Bus Acknowledge) output LOW.

The bus may be released by the HD64180 at the end of each machine cycle. In this context a machine cycle consists of a minimum of 3 clock cycles (more if wait states are inserted) for op-code fetch, memory read/write and I/O read/write cycles. Except for these cases, a machine cycle corresponds to one clock cycle.

When the bus is released, the address (A₀-A₁₈), data (D₀-D₇)

and control (\overline{ME} , \overline{IOE} , \overline{RD} , and \overline{WR}) signals are placed in the high impedance state.

Note that dynamic RAM refresh is not performed when the HD64180 has released the bus. The alternate bus master must provide dynamic memory refreshing if the bus is released for long periods of time.

Fig. 16 illustrates BUSREQ/BUSACK bus exchange during a memory read cycle. Fig. 17 illustrates bus exchange when the bus release is requested during an HD64180 CPU internal operation. BUSREQ is sampled at the falling edge of the system clock prior to T₃, Ti and Tx (BUS RELEASE state). If BUSREQ is asserted LOW at the falling edge of the clock state prior to Tx, another Tx is executed.

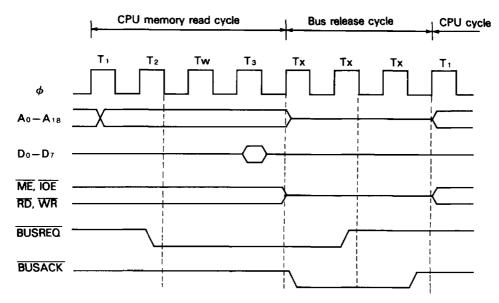


Figure 16 Bus Exchange Timing (1)

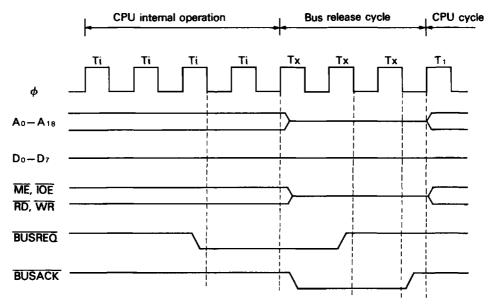


Figure 17 Bus Exchange Timing (2)

5 HALT AND LOW POWER OPERATION MODES

The HD64180 can operate in 4 different modes. HALT mode, IOSTOP mode and two low power operation modes — SLEEP and SYSTEM STOP. Note that in all operating modes, the basic CPU clock (XTAL, EXTAL) must remain active.

5.1 HALT Mode

HALT mode is entered by execution of the HALT instruction (op-code = 76H) and has the following characteristics.

- (1) The internal CPU clock remains active.
- (2) All internal and external interrupts can be received.
- (3) Bus exchange (BUSREQ and BUSACK) can occur.
- (4) Dynamic RAM refresh cycle (REF) insertion continues at the programmed interval.
- (5) I/O operations (ASCI, CSI/O and PRT) continue.
- (6) The DMAC can operate.
- (7) The HALT output pin is asserted LOW.
- (8) The external bus activity consists of repeated 'dummy' fetches of the op-code following the HALT instruction.

Essentially, the HD64180 operates normally in HALT mode, except that instruction execution is stopped.

HALT mode can be exited in the following two ways.

RESET Exit from HALT Mode

If the RESET input is asserted LOW for at least six clock cycles, HALT mode is exited and the normal RESET sequence (restart at address 00000H) is initiated.

Interrupt Exit from HALT Mode

When an internal or external interrupt is generated, HALT mode is exited and the normal interrupt response sequence is initiated.

If the interrupt source is masked (individually by enable bit, or globally by IEF, state), the HD64180 remains in HALT mode. However, NMI interrupt will initiate the normal NMI interrupt response sequence independent of the state of IEF₁.

HALT timing is shown in Fig. 18.

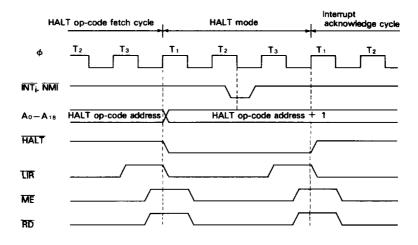


Figure 18 HALT Timing

5.2 SLEEP Mode

SLEEP mode is entered by execution of the 2 byte SLP instruction. SLEEP mode has the following characteristics.

- (1) The internal CPU clock stops, reducing power consumption.
- (2) The internal crystal oscillator does not stop.
- (3) Internal and external interrupt inputs can be received.
- (4) DRAM refresh cycles stop.
- (5) I/O operations using on-chip peripherals continue.
- (6) The internal DMAC stop.
- (7) BUSREQ can be received and acknowledged.
- (8) Address outputs go HIGH and all other control signal output become inactive HIGH.
- (9) Data Bus, 3-state.

SLEEP mode is exited in one of two ways as shown below.

RESET Exit from SLEEP Mode

If the RESET input is held LOW for at least six clock cycles, the HD64180 will exit SLEEP mode and begin the normal RESET sequence with execution starting at address (logical and physical) 00000H.

Interrupt Exit from SLEEP Mode

The SLEEP mode is exited by detection of an external (NMI, INT₀, INT₁, INT₂) or internal (ASCI, CSI/O, PRT) interrupt.

In the case of NMI, SLEEP Mode is exited and the CPU begins the normal NMI interrupt response sequence.

In the case of all other interrupts, the interrupt response depends on the state of the global interrupt enable flag (IEF₁) and the individual interrupt source enable bit.

If the individual interrupt condition is disabled by the corresponding enable bit, occurrence of that interrupt is ignored and the CPU remains in the SLEEP state.

Assuming the individual interrupt condition is enabled, the response to that interrupt depends on the global interrupt enable flag (IEF_1). If interrupts are globally enabled ($\mathrm{IEF}_1=1$) and an individually enabled interrupt occurs, SLEEP mode is exited and the appropriate normal interrupt response sequence is executed.

If interrupts are globally disabled (IEF₁=0) and an individually enabled interrupt occurs, SLEEP mode is exited and instruction execution begins with the instruction following the SLP instruction. Note that this provides a technique for synchronization with high speed external events without incurring the latency imposed by an interrupt response sequence.

Fig. 19 shows SLEEP timing.



5.3 IOSTOP Mode

IOSTOP mode is entered by setting the IOSTP bit of the I/O Control Register (ICR) to 1. In this case, on-chip I/O (ASCI, CSI/O, PRT) stops operating. However, the CPU continues to operate. Recovery from IOSTOP mode is by clearing the IOSTP bit in ICR to 0.

5.4 SYSTEM STOP Mode

SYSTEM STOP mode is the combination of SLEEP and IOSTOP modes. SYSTEM STOP mode is entered by setting the IOSTP bit in ICR to 1 followed by execution of the SLP instruction. In this mode, on-chip I/O and CPU stop operating, reducing power consumption. Recovery from SYSTEM STOP mode is the same as recovery from SLEEP mode, noting that internal I/O sources (disabled by IOSTOP) cannot generate a recovery interrupt.

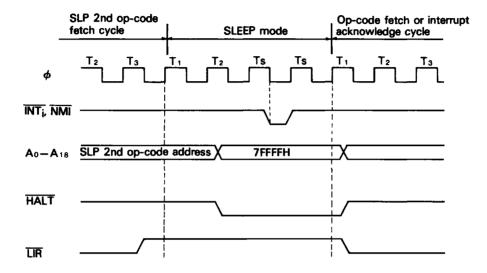


Figure 19 SLEEP Timing

6 INTERRUPTS

The HD64180 CPU has twelve interrupt sources, four external and eight internal, with fixed priority.

This section explains the CPU registers associated with interrupt

processing, the TRAP interrupt, interrupt response modes and the external interrupts. The detailed discussion of internal interrupt generation (except TRAP) is presented in the appropriate hardware section (i.e. PRT, DMAC, ASCI and CSI/O).

Prior	ity	Interrupt	
Higher	1	TRAP (Undefined Op-code Trap)	Internal Interrupt
Priority	2	NMI (Non Maskable Interrupt))
†	3	INTo (Maskable Interrupt Level 0)	External Interrupt
	4	INT (Maskable Interrupt Level 1)	
	5	INT2 (Maskable Interrupt Level 2)	, 1
	6	Timer 0	
	7	Timer 1	
	8	DMA channel 0	
	9	DMA channel 1	Internal Interrupt
į	10	Clocked Serial I/O Port	
Lower	11	Asynchronous SCI channel 0	
Priority	12	Asynchronous SCI channel 1	J

Figure 20 Interrupt Sources

6.1 Interrupt Control Registers and Flags

The HD64180 contains three registers and two flags which are associated with interrupt processing.

Register and Flag Name	Function	Access Method				
1	Contains upper 8-bit of interrupt vector	LD A, I and LD I, A instructions				
IL	Contains lower 8-bit of interrupt vector	I/O instruction (addr = 33H)				
ITC	Interrupt/Trap control	I/O instruction (addr = 34H)				
IEF , IEF 2	Enable/disable interrupt	EI, DI, LD A, I, and LD A, R instructions				

(1) Interrupt Vector Register (I)

Mode 2 for \overline{INT}_0 external interrupt, \overline{INT}_1 and \overline{INT}_2 external interrupts and all internal interrupts (except TRAP) use a programmable vectored technique to determine the address at which interrupt processing starts. In response to the interrupt a 16-bit address is generated. This address accesses a vector table in memory to obtain the address at which execution restarts.

While the method for generation of the least significant byte of the table address differs, all vectored interrupts use the contents of I as the most significant byte of the table address. By programming the contents of I, vector tables can be relocated on 256 bytes boundaries throughout the 64k bytes logical address space.

Note that I is read/written with the LD A, I and LD I, A instructions rather than I/O (IN, OUT) instructions.

I is initialized to 00H during RESET.

(2) Interrupt Vector Low Register (IL)

	Interrupt Vector Low Register (IL: I/O Address = 33H)								
bit	7	6	5	4	3	2	1	0	
	IL7	L6	L5	-	_	_	-	_	
	R/W	R/W	R/W						

rogrammable Interrupt Source Dependent Code

This register determines the most significant three bits of the low-order byte of the interrupt vector table address for external interrupts \overline{INT}_1 and \overline{INT}_2 and all internal interrupts (except TRAP). The five least significant bits are fixed for each specific interrupt source. By programming IL the vector table can be relocated on 32 bytes boundaries.

IL is initialized to 00H during RESET.

(3) INT/TRAP Control Register (ITC)

ITC is used to handle TRAP interrupts and to enable or disable the external maskable interrupt inputs $\overline{INT_0}$, $\overline{INT_1}$, and $\overline{INT_2}$.

TRAP (bit 7

This bit is set to 1 when an undefined op-code is fetched. TRAP can be reset under program control by writing it with 0, however it cannot be written with 1 under program control. TRAP is cleared to 0 during RESET.

UFO: Undefined Fetch Object (bit 6)

When a TRAP interrupt occurs (TRAP bit is set to 1), the contents of UFO allow determination of the starting address of the undefined instruction. This is necessary since the TRAP may occur on either the second or third byte of the op-code. UFO allows the stacked PC value (stacked in response to TRAP) to be correctly adjusted. If UFO = 0, the first op-code should be interpreted as the stacked PC-1. If UFO = 1, the first op-code address is stacked PC-2. UFO is read-only.

ITE2,1,0: Interrupt Enable 2,1,0 (bits 2-0)

ITE2, ITE1 and ITE0 enable and disable the external interrupt inputs INT2, INT1, and INT0 respectively. If cleared to 0, the interrupt is masked. During RESET, ITE0 is initialized to 1 while ITE1 and ITE2 are initialized to 0.

· Interrupt Enable Flag 1,2 (IEF₁, IEF₂)

IEF₁ controls the overall enabling and disabling of all internal and external maskable interrupts (i.e. all interrupts except NMI and

TRAP).

If $\mathrm{IEF_1}=0$, all maskable interrupts are disabled. $\mathrm{IEF_1}$ can be reset to 0 by the DI (Disable Interrupts) instruction and set to 1 by the EI (Enable Interrupts) instruction.

The purpose of IEF_e is to correctly manage the occurrence of \overline{NMI} . During \overline{NMI} , the prior interrupt reception state is saved and all maskable interrupts are automatically disabled (IEF, copied to

IEF₂ and then IEF₁ cleared to 0). At the end of the NMI interrupt service routine, execution of the RETN (Return from Non-maskable Interrupt) will automatically restore the interrupt receiving state (by copying IEF₂ to IEF₃) prior to the occurrence of NMI.

IEF₂ state can be reflected in the P/V bit of the CPU Status register by executing LD A, I or LD A, R instructions.

Table 2 shows the state of IEF, and IEF.

Table 2 State of IEF, and IEF,

CPU Operation	IEF ,	IEF ₂	REMARKS
RESET	0	0	Inhibits the interrupt except NMI and TRAP.
NMI	0	IEF,	Copies the contents of IEF, to IEF,
RETN	HEF ₂	not affected	Returns from the NMI service routine.
Interrupt except	0	0	Inhibits the interrupt except NMI and TRAP.
RETI	not affected	not affected	
TRAP	not affected	not affected	
El	1	1	
DI	0	0	
LD A, I	not affected	not affected	Transfers the contents of IEF ₂ to P/V flag.
LD A, R	not affected	not affected	Transfers the contents of IEF, to P/V flag.

6.2 TRAP Interrupt

The HD64180 generates a non-maskable (not affected by the state of IEF_i) TRAP interrupt when an undefined op-code fetch occurs. This feature can be used to increase software reliability, implement an 'extended' instruction set, or both. TRAP may occur during op-code fetch cycles and also if an undefined op-code is fetched during the interrupt acknowledge cycle for $\overline{\text{INT}_0}$ when Mode 0 is used.

When a TRAP interrupt occurs the HD64180 operates as follows.

- (1) The TRAP bit in the Interrupt TRAP/Control (ITC) register is set to 1.
- (2) The current PC (Program Counter) value, reflecting the location of the undefined op-code, is saved on the stack.
- (3) The HD64180 vectors to logical address 0. Note that if logical

address 0000H is mapped to physical address 00000H, the vector is the same as for RESET. In this case, testing the TRAP bit in ITC will reveal whether the restart at physical address 00000H was caused by RESET or TRAP.

The state of the UFO (Undefined Fetch Object) bit in ITC allows TRAP manipulation software to correctly 'adjust' the stacked PC depending on whether the second or third byte of the op-code generated the TRAP. If UFO = 0, the starting address of the invalid instruction is equal to the stacked PC-1. If UFO = 1, the starting address of the invalid instruction is equal to the stacked PC-2. Fig. 21 shows TRAP Timing.

Note that Bus Release cycle, Refresh cycle, DMA cycle and WAIT cycle can't be inserted just after T_{TP} state which is inserted for TRAP interrupt sequence.

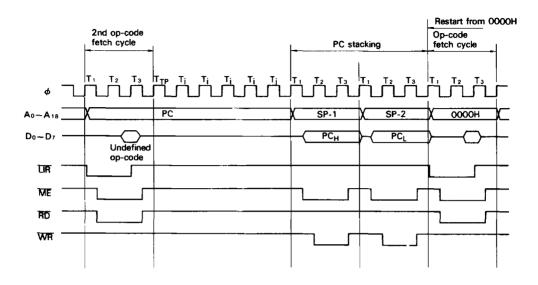


Figure 21 (a) TRAP Timing - 2nd Op-code Undefined

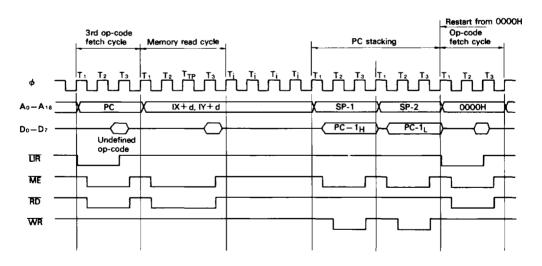


Figure 21 (b) TRAP Timing - 2nd Op-code Undefined

6.3 External interrupts

The HD64180 has four external hardware interrupt inputs.

- (1) NMI Non-maskable interrupt
- (2) INT Maskable Interrupt Level 0
- (3) INT, Maskable Interrupt Level 1 (4) INT. - Maskable Interrupt Level 2
- NMI, INT, and INT, have fixed interrupt response modes. INT, has three different software programmable interrupt response modes - Mode 0, Mode 1 and Mode 2.

6.4 NMI - Non-Maskable Interrupt

The NMI interrupt input is edge sensitive and cannot be masked by software. When NMI is detected, the HD64180 operates as fol-

- (1) DMAC operation is suspended by clearing the DME (DMA Main Enable) bit in DCNTL.
- The PC is pushed onto the stack.
- (3) The contents of IEF, are copied to IEF2. This saves the interrupt reception state that existed prior to NMI.
- (4) IEF, is cleared to 0. This disables all external and internal maskable interrupts (i.e. all interrupts except NMI and TRAP).

(5) Execution commences at logical address 0066H. The last instruction of an NMI service routine should be RETN (Return from Non-maskable Interrupt). This restores the stacked PC, allowing the interrupted program to continue. Furthermore, RETN causes IEF₂ to be copied to IEF₁, restoring the interrupt reception state that existed prior to the NMI.

Note that NMI, since it can be accepted during HD64180 onchip DMAC operation, can be used to externally interrupt DMA transfer. The NMI service routine can reactivate or abort the

DMAC operation as required by the application.

For NMI, special care must be taken to insure that interrupt inputs do not 'overrun' the NMI service routine. Unlimited NMI inputs without a corresponding number of RETN instructions will eventually cause stack overflow

Fig. 22 shows the use of NMI and RETN while Fig. 23 details NMI response timing. NMI is edge sensitive and the internally latched NMI falling edge is held until it is sampled. If the falling edge of NMI is latched before the falling edge of clock state prior to Ta or Ti in the last machine cycle, the internally latched NMI is sampled at the falling edge of the clock state prior to T, or Ti in the last machine cycle and NMI acknowledge cycle begins at the end of the current machine cycle.

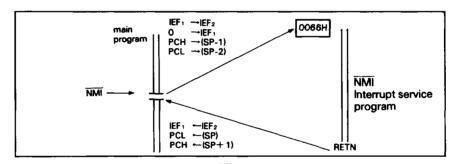
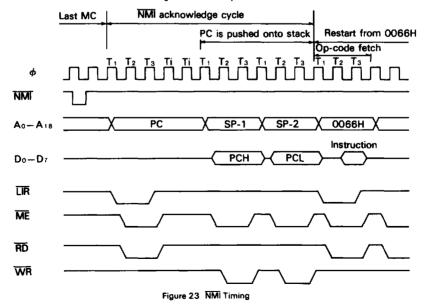


Figure 22 NMI Sequence



6.5 INTo - Maskable Interrupt Level 0

The next highest priority external interrupt after $\overline{NM1}$ is $\overline{INT_0}$. In $\overline{INT_0}$ is sampled at the falling edge of the clock state prior to T_3 or T_1 in the last machine cycle. If $\overline{INT_0}$ is asserted LOW at the falling edge of the clock state prior to T_3 or T_1 in the last machine cycle, $\overline{INT_0}$ is accepted. The interrupt is masked if either the IEF, flag or the ITEO (Interrupt Enable 0) bit in ITC are cleared to 0. Note that after RESET the state is as follows.

(1) IEF, is 0, so INT₀ is masked.

(2) ITEO is 1, so INT₀ is enabled by execution of the EI (Enable Interrupts) instruction.

The INT₀ interrupt is unique in that three programmable interrupt response modes are available — Mode 0, Mode 1, and Mode 2. The specific mode is selected with the IM 0, IM 1 and IM 2 (Set Interrupt Mode) instructions. During RESET, the HD64180 is initialized to use Mode 0 for INT₀.

The three interrupt response modes for INT are...

(1) Mode 0 - Instruction fetch from data bus.

(2) Mode 1 - Restart at logical address 0038H.

(3) Mode 2 - Low byte vector table address fetch from data bus.

INTo Mode 0

During the interrupt acknowledge cycle, an instruction is fetched from the data bus $(D_0 - D_7)$ at the rising edge of T_8 . Often, this instruction is one of the eight single byte RST (RESTART) instructions which stack the PC and restart execution at a fixed logical address. However, multibyte instructions can be processed if the interrupt acknowledging device can provide a multibyte response. Unlike all other interrupts, the PC is not automatically stacked.

Note that TRAP interrupt will occur if an invalid instruction is fetched during $\overline{INT_0}$ Mode 0 interrupt acknowledge.

Fig. 24 shows INT, Mode 0 Timing.

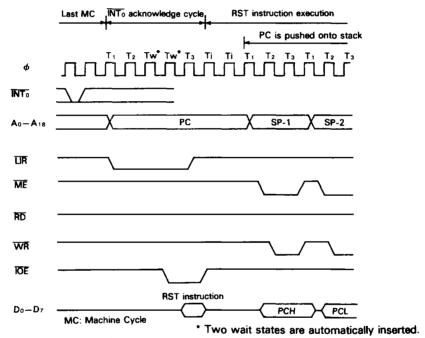


Figure 24 INT Mode 0 Timing (RST Instruction on the Data Bus)

When $\overline{INT_0}$ is received, the PC is stacked and instruction execution restarts at logical address 0038H. Both IEF, and IEF, flags are reset to 0, disabling all maskable interrupts. The interrupt service routine should normally terminate with the EI (Enable Interrupts) instruction followed by the RETI (Return from Interrupt) instruction, so that the interrupts are reenabled. Fig. 25 shows the use of INT, (Mode I) and RETI.

Fig. 26 shows INT₀ Mode 1 timing.

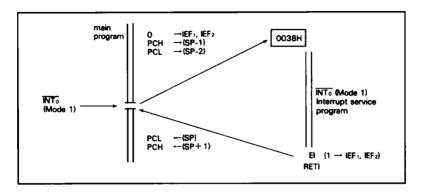


Figure 25 INT Mode 1 Interrupt Sequence

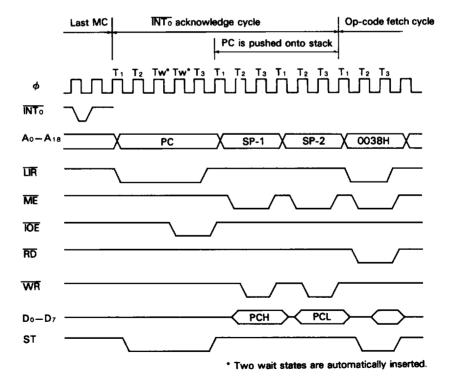


Figure 26 INT Mode 1 Timing

INT_o Mode 2

This method determines the restart address by reading the contents of a table residing in memory. The vector table consists of up to 128 two-byte restart addresses stored in low byte, high byte order.

The vector table address is located on 256 bytes boundaries in the 64k bytes logical address space as programmed in the 8-bit Interrupt Vector Register (I). Fig. 27 shows the INT₀ Mode 2 Vector acquisition.

During $\overline{INT_0}$ Mode 2 acknowledge cycle, first, the low-order 8 bits of vector is fetched from the data bus at the rising edge of T_3

and CPU acquires the 16-bit vector.

Next, the PC is stacked. Finally, the 16-bit restart address is fetched from the vector table and execution commences at that address.

Note that external vector acquisition is indicated by LIR and IOE both LOW. Two wait states (Tw) are automatically inserted for external vector fetch cycles.

During RESET the Interrupt Vector Register (I) is initialized to 00H and, if necessary, should be set to a different value prior to the occurrence of a $\overline{INT_0}$ Mode 2 interrupt. Fig. 28 shows $\overline{INT_0}$ Mode 2 interrupt Timing.

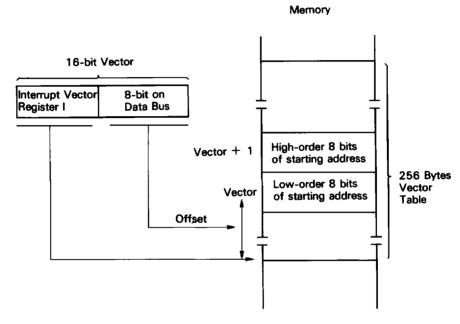
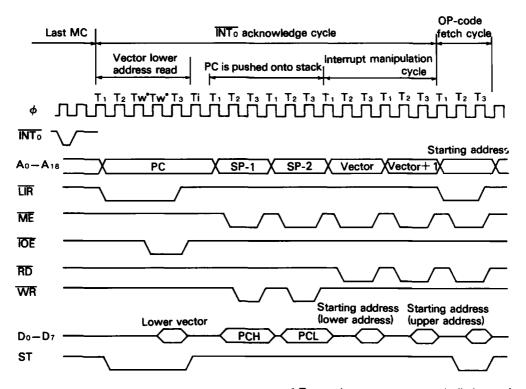


Figure 27 INT Mode 2 Vector Acquisition



Two wait states are automatically inserted.

Figure 28 INT Mode 2 Timing

6.6 INT, INT2

The operation of external interrupts $\overline{INT_1}$ and $\overline{INT_2}$ is a vector mode similar to $\overline{INT_0}$ Mode 2. The difference is that $\overline{INT_1}$ and $\overline{INT_2}$ generate the low-order byte of vector table address using the IL (Interrupt Vector Low) register rather than fetching it from the data bus. This is also the interrupt response sequence used for all internal interrupts (except TRAP).

As shown in Fig. 29 the low-order byte of vector table address is comprised of the most significant three bits of the software programmable IL register and the least significant five bits which are a unique fixed value for each interrupt ($\overline{INT_1}$, $\overline{INT_2}$ and internal) source.

 $\overline{INT_1}$ and $\overline{INT_2}$ are globally masked by IEF₁ = 0. Each is also individually maskable by respectively clearing the ITE1 and ITE2 (bits 1, 2) of the INT/TRAP control register to 0.

During RESET, IEF, ITE1 and ITE2 bits are initialized to 0.

6.7 Internal Interrupts

Internal interrupts (except TRAP) use the same vectored response mode as INT, and INT₂ (Fig. 29). Internal interrupts are globally masked by IEF₁ = 0. Individual internal interrupts are enabled/disabled by programming each individual I/O (PRT, DMAC, CSI/O, ASCI) control register. The lower vector of INT₁, INT₂, and internal interrupt are summarized in Table 3.

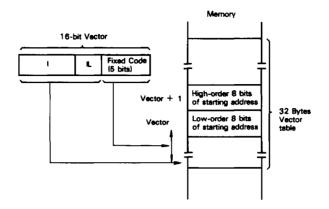


Figure 29 INT, INT, and Internal Interrupts Vector Acquisition

Table 3 Interrupt Source and Lower Vector

1.4-	D-1	IL.				Fixed Code				
Interrupt Source	Priority	b,	be	b ₆	b ₄	b ₃	b ₂	ь,	bo	
INT,	Highest			•	0	0	0	0	0	
INT ₂	─		•	•	0	0	0	1	0	
PRT channel 0		•	•	•	0	0	1	0	0	
PRT channel 1		•	•	•	0	0	1	1	0	
DMA channel 0		·	•	•	0	1	0	0	0	
DMA channel 1		$\overline{}$	•	•	0	1	0	1	0	
CSVO		•	•	•	0	1	1	0	٥	
ASCI channel 0	$\neg \mid \downarrow$	•	•	•	0	1	1	1	0	
ASCI channel 1	Lowest	•	•	•	1	0	0	0	0	

^{*} Programmable

Interrupt Acknowledge Cycle Timing

Fig. 30 shows interrupt acknowledge cycle timing for internal interrupts, $\overline{INT_1}$, and $\overline{INT_2}$. $\overline{INT_1}$ and $\overline{INT_2}$ are sampled at the falling

edge of clock state prior to T, or Ti in the last machine cycle. If INT, or INT, is asserted LOW at the falling edge of clock state prior to T, or Ti in the last machine cycle, the interrupt request is accepted.

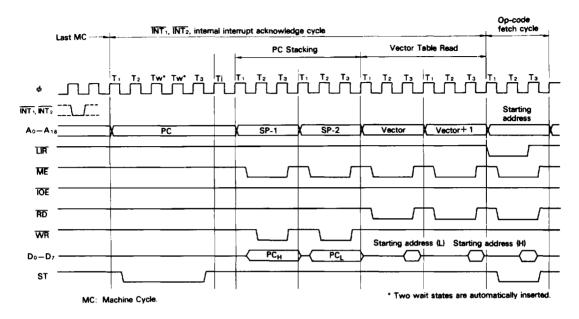


Figure 30 INT, INT, and Internal Interrupts Timing

6.8 Interrupt Sources and Reset

(1) Interrupt Vector Register (I)

All bits are reset to 0. Since I = 0 locates the vector tables starting at logical address 0000H, vectored interrupts (INT, Mode 2, INT, INT, and internal interrupts) will overlap with fixed restart interrupts like RESET (0), NMI (0066H), INT, Mode 1 (0038H) and RST (0000H - 0038H). The vector table(s) can be built elsewhere in memory and located on 256 bytes boundaries by reprogramming I with the LD I, A instruction

(2) IL Register

Bits 7 - 5 are reset to 0.

The IL Register can be programmed to locate the vector table for INT, INT, and internal interrupts on 32 bytes sub-boundaries within the 256 bytes area specified by I.

(3) IEF₁, IEF₂ Flags

Reset to 0.

Interrupts other than NMI and TRAP are disabled.

(4) ITC Register

ITEO are set to 1. ITE1 and ITE2 are reset to 0.

 \overline{INT}_0 can be enabled by the EI instruction, which sets IEF, = 1. To enable INT, and INT, also requires that the ITE1 and ITE2 bits be respectively set = 1 by writing to ITC.

(5) I/O Control Registers

Interrupt enable bits reset to 0.

All HD64180 on-chip I/O (PRT, DMAC, CSI/O, ASCI) interrupts are disabled and can be individually enabled by writing to each I/O control register interrupt enable bit.

8.9 Difference between INTo interrupt and the other interrupts (INT1, INT2 and internal interrupts) in the interrupt acknowledge cycles

As shown in Fig. 24, Fig. 26, Fig. 28 and Fig. 30, the interrupt acknowledge cycle of INT, is different from those of the other interrupts, that is, INT1, INT2 and internal interrupts concerning the state of control signals. The state of the control signals in each interrupt acknowledge cycle are shown below.

 \overline{INT}_0 interrupt acknowledge cycle: $\overline{LIR} = 0$, $\overline{IOE} = 0$, $\overline{ST} = 0$ \overline{INT}_1 , \overline{INT}_2 , and internal interrupt acknowledge cycle: $\overline{LIR} = 1$, $\overline{IOE} = 1$, $\overline{ST} = 0$

7 MEMORY MANAGEMENT UNIT (MMU)

The HD64180 contains an on-chip MMU which performs the translation of the CPU 64k bytes (16-bit addresses-0000H to FFFFH) logical memory address space into a 512k bytes (19-bit addresses-00000H to 7FFFFH) physical memory address space. Address translation occurs internally in parallel with other CPU operation.

7.1 Logical Address Spaces

The 64k bytes CPU logical address space is interpreted by the MMU as consisting of up to three separate logical address areas, Common Area 0, Bank Area and Common Area 1.

As shown in Fig. 31 a variety of logical memory configurations are possible. The boundaries between the Common and Bank Areas can be programmed with 4k bytes resolution.

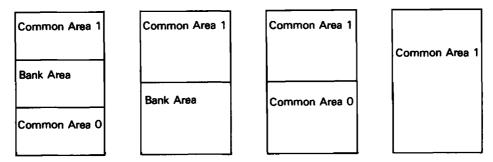


Figure 31 Logical Address Mapping Examples

7.2 Logical to Physical Address Translation

Fig. 32 shows an example in which the three logical address space portions are mapped into a 512k bytes physical address space. The important points to note are that Common and Bank Areas can

overlap and that Common Area 1 and Bank Area can be freely relocated (on 4k bytes physical address boundaries). Common Area 0 (if it exists) is always based at physical address 00000H.

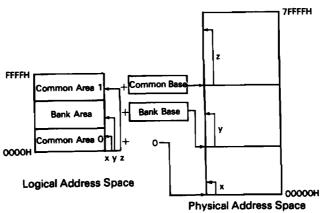


Figure 32 Logical → Physical Memory Mapping Example

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7.3 MMU Block Diagram

The MMU block diagram is shown in Fig. 33. The MMU translates internal 16-bit logical addresses to external 19-bit physical addresses.

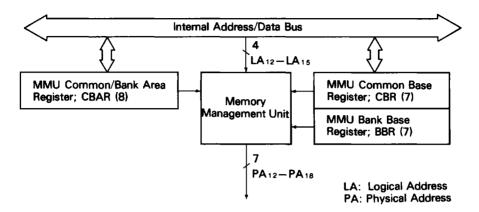


Figure 33 MMU Block Diagram

Whether address translation takes place depends on the type of CPU cycle as follows.

(1) Memory Cycles

Address Translation occurs for all memory access cycles including instruction and operand fetches, memory data reads and writes, hardware interrupt vector fetch and software interrupt restarts.

(2) I/O Cycles

The MMU is logically bypassed for I/O cycles. The 16-bit logical I/O address space corresponds directly with the 16-bit physical I/O address space. The upper three bits (A_{1n}, A_{1n}) of the physical address are always 0 during I/O cycles.

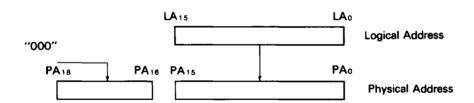


Figure 34 I/O Address Translation

(3) DMA Cycles

When the HD64180 on-chip DMAC is using the external bus, the MMU is physically bypassed. The 19-bit source and destination

registers in the DMAC are directly output on the physical address bus $(A_0 - A_{18})$.

7.4 MMU Registers

Three MMU registers are used to program a specific configuration of logical and physical memory.

- (1) MMU Common/Bank Area Register (CBAR)
- (2) MMU Common Base Register (CBR)
- (3) MMU Bank Base Register (BBR)

CBAR is used to define the logical memory organization, while CBR and BBR are used to relocate logical areas within the 512k bytes physical address space. The resolution for both setting boundaries within the logical space and relocation within the physical

space is 4k bytes.

The CAR field of CBAR determines the start address of Common Area 1 (Upper Common) and by default, the end address of the Bank Area. The BAR field determines the start address of the Bank Area and by default, the end address of Common Area 0 (Lower Common).

The CA and BA fields of CBAR may be freely programmed subject only to the restriction that CA may never be less than BA. Fig. 35 and Fig. 36 shows example of logical memory organizations associated with different values of CA and BA.

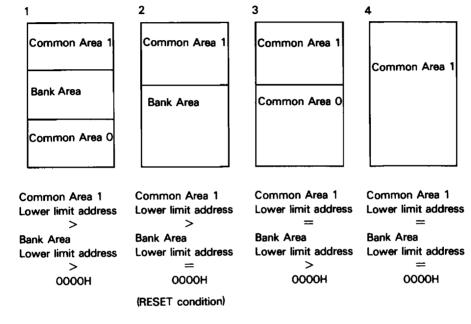


Figure 35 Logical Memory Organization

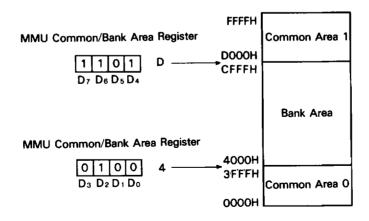


Figure 36 Logical Space Configuration (Example)



7.5 MMU Register Description

(1) MMU Common/Bank Area Register (CBAR)

CBAR specifies boundaries within the HD64180 64k bytes logical address space for up to three areas, Common Area 0, Bank Area, and Common Area 1.

MMU Common/Bank Area Register (CBAR : I/O Address = 3AH) BAO RA2 RA 1 CA2 CA1 CAD RAS R/W RAN R/M P.W R/W B/W R/M RAN

CA3-CA0: CA (bits 7-4)

CA specifies the start (low) address (on 4k bytes boundaries) for the Common Area 1. This also determines the last address of the Bank Area. All bits of CA are initialized to 1 during RESET.

BA3-BA0: BA (bits 3-0)

BA specifies the start (low) address (on 4k bytes boundaries) for the Bank Area. This also determines the last address of the Common Area 0. All bits of BA are initialized to 0 during RESET.

(2) MMU Common Base Register (CBR)

CBR specifies the base address (on 4k bytes boundaries) used to generate a 19-bit physical address for Common Area 1 accesses. All bits of CBR are initialized to 0 during RESET.

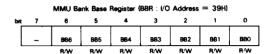
MMU Common Base Register (CBR : I/O Address = 38H) 6 5 4 3 2 1 0 - C86 C85 C84 C83 C82 C81 C80

R/W

R/W

(3) MMU Bank Base Register (BBR)

BBR specifies the base address (on 4k bytes boundaries) used to generate a 19-bit physical address for Bank Area accesses. All bits of BBR are initialized to 0 during RESET.



7.6 Physical Address Translation

Fig. 37 shows the way in which physical addresses are generated based on the contents of CBAR, CBR and BBR. MMU comparators classify an access by logical area as defined by CBAR. Depending on which of the three potential logical areas (Common Area 1, Bank Area or Common Area 0) is being accessed, the appropriate 7-bit base address is added to the upper 4 bits of the logical address, yielding a 19-bit physical address. CBR is associated with Common Area 1 accesses. Common Area 0 accesses use a (non-accessible, internal) base register which contains 0. Thus, Common Area 0, if defined, is always based at physical address 00000H.

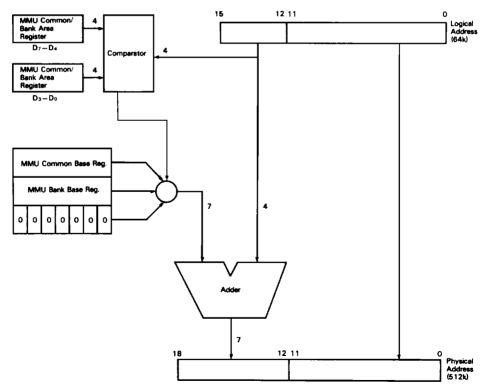


Figure 37 Physical Address Generation

7.7 MMU and RESET

During RESET, all bits of the CA field of CBAR are set to 1 while all bits of the BA field of CBAR, CBR, and BBR are cleared to 0. The logical 64k bytes address space corresponds directly with the first 64k bytes (0000H to FFFFH) of the 512k bytes (00000H to FFFFH) physical address space. Thus, after RESET, the HD64180 will begin execution at logical and physical address 0.

7.8 MMU Register Access Timing

When data is written into CBAR, CBR, or BBR, the value will be effective from the cycle immediately following the I/O write cycle which updates these registers.

Care must be taken during MMU programming to insure that CPU program execution is not disrupted. Observe that the next cycle following MMU register programming will normally be an opcode fetch from the newly translated address. One simple technique is to localize all MMU programming routines in a Common Area that is always enabled.

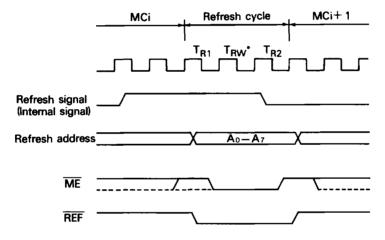
8 DYNAMIC RAM REFRESH CONTROL

The HD64180 incorporates a dynamic RAM refresh control circuit including 8-bit refresh address generation and programmable refresh timing. This circuit generates asynchronous refresh cycles inserted at the programmable interval independent of CPU program execution. For systems which don't use dynamic RAM, the refresh function can be disabled.

When the internal refresh controller determines that a refresh cycle should occur, the current instruction is interrupted at the first breakpoint between machine cycles. The refresh cycle is inserted by placing the refresh address on A_0 - A_7 and the REF output is driven LOW

Refresh cycles may be programmed to be either two or three clock cycles in duration by programming the REFW (Refresh Wait) bit in Refresh Control Register (RCR). Note that the external WAIT input and the internal wait state generator are not effective during refresh.

Fig. 38 shows the timing of a refresh cycle with a refresh wait (T_{RW}) cycle.



NOTE: * If three refresh cycles are specified, T_{RW}, is inserted. Otherwise, T_{RW} is not inserted.

MC: Machine Cycle

Figure 38 Refresh Timing

8.1 Refresh Control Register (RCR)

RCR specifies the interval and length of refresh cycles, as well as enabling or disabling the refresh function.

		Refresh	Control F	Register (I	RCR: I/O	Address	= 36H)	
oit	7	6	5	4	3	2	1	0
ſ	REFE	REFW	_		1	_	CYC1	CYCO
L	7427 2	1,4200					DAM.	

REFE: Refresh Enable (bit 7)

REFE = 0 disables the refresh controller while REFE = 1 enables refresh cycle insertion. REFE is set to 1 during RESET.

REFW: Refresh Wait (bit 6)

REFW = 0 causes the refresh cycle to be two clocks in duration. REFW = 1 causes the refresh cycle to be three clocks in duration by adding a refresh wait cycle (T_{RW}) . REFW is set to 1 during RE-SFT

CYC1, 0: Cycle Interval (bits 1-0)

CYC1 and CYC0 specify the interval (in clock cycles) between refresh cycles.

In the case of dynamic RAMs requiring 128 refresh cycles every 2 ms (or 256 cycles every 4 ms), the required refresh interval is less than or equal to $15.625 \,\mu s$. Thus, the underlined values indicate the best refresh interval depending on CPU clock frequency. CYC0 and CYC1 are cleared to 0 during RESET.

Table 4 Refresh Interval

CYC1	CYCO	Insertion	Time interval					
	0100	interval	φ: 10 MHz	8 MHz	6 MHz	4 MHz	2.5 MHz	
0	0	10 states	(1.0 μs)*	(1.25 μs)*	1.66 µs	2.5 μs	4.0 µs	
0	1	20 states	(2.0 μs)*	(2.5 µs)*	3.3 ús	5.0 µs	8.0 µs	
1	0	40 states	(4.0 μs)*	(5.0 μs)*	6.6 µs	10.0 μs	16.0 µs	
1	1	80 states	(<u>8.0 μs</u>)*	(<u>10.0 μs</u>)*	<u>13.3 μs</u>	20.0 μs	32.0 μs	

^{*} calculated interval

8.2 Refresh control and reset

After RESET, based on the initialized value of RCR, refresh cycles will occur with an interval of 10 clock cycles and be 3 clock cycles in duration.

8.3 Dynamic RAM refresh operation notes

- Refresh cycle insertion is stopped when the CPU is in the following states.
 - (a) During RESET
 - (b) When the bus is released in response to BUSREQ
 - (c) During SLEEP mode
 - (d) During WAIT states
- (2) Refresh cycles are suppressed when the bus is released in response to BUSREQ. However, the refresh timer continues to operate. Thus, the time at which the first refresh cycle occurs after the HD64180 re-acquires the bus depends on the refresh timer, and has no timing relationship with the bus exchange.
- (3) Refresh cycles are suppressed during SLEEP mode. If a refresh cycle is requested during SLEEP mode, the refresh cycle request is internally 'latched' (until replaced with the next refresh request). The 'latched' refresh cycle is inserted at the end of the first machine cycle after SLEEP mode is exited. After this initial cycle, the time at which the next refresh cycle will occur depending on the refresh time, and has no timing relationship with the exit from SLEEP mode.
- (4) Regarding (2) and (3), the refresh address is incremented by I for each successful refresh cycle, not for each refresh request. Thus, independent of the number of 'missed' refresh requests, each refresh bus cycle will use a refresh address incremented by I from that of the previous refresh bus cycles.

9 WAIT STATE GENERATOR

9.1 Wait State Timing

To ease interfacing with slow memory and I/O devices, the HD64180 uses wait states (Tw) to extend bus cycle timing. A wait state(s) is inserted based on the combined (logical OR) state of the external WAIT input and an internal programmable wait state (Tw) generator. Wait states (Tw) can be inserted in both CPU execution and DMA transfer cycles.

9.2 WAIT Input

When the external \overline{WAIT} input is asserted LOW, wait state (Tw) are inserted between T_2 and T_3 to extend the bus cycle duration. The \overline{WAIT} input is sampled at the falling edge of the system clock in T_2 or Tw. If the \overline{WAIT} input is asserted LOW at the falling edge of the system clock in Tw, another Tw is inserted into the bus cycle. Note that \overline{WAIT} input transitions must meet specified set-up and hold times. This can easily be accomplished by externally synchronizing \overline{WAIT} input transitions with the rising edge of the system clock.

Dynamic RAM refresh is not performed during wait states (Tw) and thus systems designs which uses the automatic refresh function must consider the affects of the occurrence and duration of wait states (Tw).

Fig. 39 shows WAIT timing.

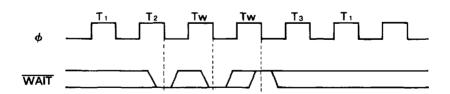


Figure 39 WAIT Timing

9.3 Programmable Wait State Insertion

In addition to the WAIT input, wait states (Tw) can also be programmably inserted using the HD64180 on-chip wait state generator. Wait state (Tw) timing applies for both CPU execution and on-chip DMAC cycles.

By programming the 4 significant bits of the DMA/WAIT Control Register (DCNTL), the number of wait states (Tw) automatically inserted in memory and I/O cycles can be separately specified. Bits 4-5 specify the number of wait states (Tw) inserted for I/O access and bits 6-7 specify the number of wait states (Tw) inserted for memory access.

DMA/WAIT Control Register (DCNTL : I/O Address = 32H) B/W R/W

The number of wait states (Tw) inserted in a specific cycle is the maximum of the number requested by the WAIT input, and the number automatically generated by the on-chip wait state gener-

MWI1, MWI0: Memory Wait Insertion (bits 7-6)
For CPU and DMAC cycles which access memory (including memory mapped I/O), 0 to 3 wait states may be automatically inserted depending on the programmed value in MWI1 and MWI0.

MWI1	MWIO	The number of wait states
0	0	0
0	1	1
1	0	2
1	1	3

IWI1, IWI0: I/O Wait Insertion (bits 5-4)

For CPU and DMA cycles which access external I/O (and interrupt acknowledge cycles), I to 6 wait states (Tw) may be automatically inserted depending on the programmed value in IWI1 and IWIO.

		The number of wait states							
!W I1	1WIO	For external I/O registers accesses	For internal I/O registers accesses	For INT ₀ interrupt acknowledge cy- cles when LIR is LOW	For INT ₁ , INT ₂ and internal interrupts acknowledge cycles (Note (2))	For NMI interrupt acknowledge cy- cles when LIR is LOW (Note (2))			
0	0	1		2					
0	1	2	7 o	4	┐ ,				
1	0	3	(Note (1))	5	7 4	0			
1	1	4	7	6					

NOTE: (1) For HD64180 internal I/O register access (I/O addresses 0000H-003FH), IWI1 and IWI0 do not determine wait state (Tw) timing. For ASCI, CSI/ O and PRT Data Register accesses, 0 to 4 wait states (Tw) will be generated. Wait states inserted during access to these registers is a function of internal synchronization requirements and CPU state.

All other on-chip I/O register accesses (i.e. MMU, DMAC, ASCI Control Registers, etc.) have 0 wait states inserted and thus require only three clock cycles.

(2) For interrupt acknowledge cycles in which LIR is HIGH, such as interrupt vector table read and PC stacking cycle, memory access timing applies.

9.4 WAIT Input and RESET

During RESET, MWII, MWIO, IWII and IWIO are all set to 1, selecting the maximum number of wait states (Tw) (3 for memory accesses, 4 for external I/O accesses).

Also, note that the WAIT input is ignored during RESET. For

example, if RESET is detected while the HD64180 is in a wait state (Tw), the wait stated cycle in progress will be aborted, and the RE-SET sequence initiated. Thus, RESET has higher priority than WAIT.

HD64180R/Z

10 DMA CONTROLLER (DMAC)

The HD64180 contains a two channel DMA (Direct Memory Access) controller which supports high speed data transfer. Both channels (channel 0 and channel 1) have the following capabilities.

Memory Address Space

Memory source and destination addresses can be directly specified anywhere within the 512k bytes physical address space using 19-bit source and destination memory addresses. In addition, memory transfers can arbitrarily cross 64k bytes physical address boundaries without CPU intervention.

I/O Address Space

I/O source and destination addresses can be directly specified anywhere within the 64k bytes I/O address space (16-bit source and destination I/O addresses).

Transfer Length

Up to 64k bytes can be transferred based on a 16-bit byte count register.

DREO Input

Level and edge sense DREQ input detection are selectable.

TEND Output

Used to indicate DMA completion to external devices.

Transfer Rate

Each byte transfer can occur every six clock cycles. Wait states can be inserted in DMA cycles for slow memory or I/O devices. At the system clock $(\phi) = 6$ MHz, the DMA transfer rate is as high as 1.0 megabytes/second (no wait states).

Additional feature disk for DMA interrupt request by DMA END.

Each channel has the following additional specific capabilities.

Channel 0

- Memory memory, memory I/O, memory memory mapped I/O transfers
- · Memory address increment, decrement, no-change
- · Burst or cycle steal memory <--> memory transfers
- · DMA to and from both ASCI channels
- Higher priority than DMAC channel 1

Channel 1

- · Memory ← → I/O transfer
- · Memory address increment, decrement

DMAC Registers

Each channel of the DMAC (channel 0, 1) has three registers specifically associated with that channel.

Channel 0

SAR0 - Source Address Register
DAR0 - Destination Address Register
BCR0 - Byte Count Register

Channel 1

MAR1 - Memory Address Register
IAR1 - I/O Address Register
BCR1 - Byte Count Register

The two channels share the following three additional registers in common.

DSTAT - DMA Status Register
DMODE - DMA Mode Register
DCNTL - DMA Control Register

10.1 DMAC Block Diagram

Fig. 40 shows the HD64180 DMAC Block Diagram.

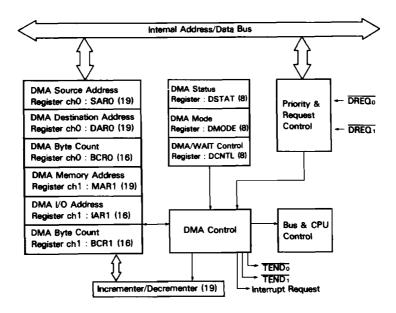


Figure 40 DMAC Block Diagram



10.2 DMAC Register Description

DMA Source Address Register Channel 0 (SAR0: I/O Address = 20H to 22H)

Specifies the physical source address for channel 0 transfers. The register contains 19 bits and may specify up to 512k bytes memory addresses or up to 64k bytes I/O addresses. Channel 0 source can be memory, I/O or memory mapped I/O.

(2) DMA Destination Address Register Channel 0 (DAR0: I/O Address = 23H to 25H)

Specifies the physical destination address for channel 0 transfers. The register contains 19 bits and may specify up to 512k bytes memory addresses or up to 64k bytes I/O addresses. Channel 0 destination can be memory, I/O or memory mapped I/O.

(3) DMA Byte Count Register Channel 0 (BCR0: I/O Address = 26H to 27H)

Specifies the number of bytes to be transferred. This register contains 16 bits and may specify up to 64k bytes transfers. When one byte is transferred, the register is decremented by one. If "n" bytes should be transferred, "n" must be stored before the DMA operation.

(4) DMA Memory Address Register Channel 1 (MAR1: I/O Address = 28H to 2AH)

Specifies the physical memory address for channel 1 transfers. This may be destination or source memory address.

This register contains 19 bits and may specify up to 512k bytes memory addresses.

(5) DMA I/O Address Register Channel 1 (IAR1: I/O Address = 2BH to 2CH)

Specifies the I/O address for channel 1 transfers. This may be destination or source I/O address. This register contains 16 bits and may specify up to 64k bytes I/O addresses.

(6) DMA Byte Count Register Channel 1 (BCR1: I/O Address = 2EH to 2FH)

Specifies the number of bytes to be transferred. This register contains 16 bits and may specify up to 64k bytes transfers. When one byte is transferred, the register is decremented by one.

(7) DMA Status Register (DSTAT)

DSTAT is used to enable and disable DMA transfer and DMA termination interrupts. DSTAT also allows determining the status of a DMA transfer i.e. completed or in progress.

	DMA Status Register (DSTAT : I/O Address = 30H) 6 5 4 3 2 1						
7	6	5	4	3	2	1	

DE1 DE0 DWE1 DWE0 DIE1 DIE0 - DME | R/W R/W W W R/W R/W R/W R

DE1: DMA Enable Channel 1 (bit 7)

When DE1 = 1 and DME = 1, channel 1 DMA is enabled. When a DMA transfer terminates (BCR1 = 0), DE1 is reset to 0 by the DMAC. When DE1 = 0 and the DMA interrupt is enabled (DIE1 = 1), a DMA interrupt request is made to the CPU.

To perform a software write to DE1, DWE1 should be written with 0 during the same register write access. Writing DE1 to 0 disables channel 1 DMA, but DMA is restartable. Writing DE1 to 1 enables channel 1 DMA and automatically sets DME (DMA Main Enable) to 1. DE1 is cleared to 0 during RESET.

DEO: DMA Enable Channel 0 (bit 6)

When DE0 = 1 and DME = 1, channel 0 DMA is enabled. When a DMA transfer terminates (BCR0 = 0), DE0 is cleared to 0 by the DMAC. When DE0 = 0 and the DMA interrupt is enabled

(DIE0 = 1), a DMA interrupt request is made to the CPU.

To perform a software write to DE0, $\overline{DWE0}$ should be written with 0 during the same register write access. Writing DE0 to 0 disables channel 0 DMA. Writing DE0 to 1 enables channel 0 DMA and automatically sets DME (DMA Main Enable) to 1. DE0 is cleared to 0 during RESET.

DWE1: DE1 Bit Write Enable (bit 5)

When performing any software write to DE1, $\overline{DWE1}$ should be written with 0 during the same access. $\overline{DWE1}$ write value of 0 is not held and $\overline{DWE1}$ is always read as 1.

DWEO: DEO Bit Write Enable (bit 4)

When performing any software write to DE0, $\overline{DWE0}$ should be written with 0 during the same access. $\overline{DWE0}$ write value of 0 is not held and $\overline{DWE0}$ is always read as 1.

DIE1: DMA Interrupt Enable Channel 1 (bit 3)

When DIE1 is set to 1, the termination of channel 1 DMA transfer (indicated when DE1 = 0) causes a CPU interrupt request to be generated. When DIE1 = 0, the channel 1 DMA termination interrupt is disabled. DIE1 is cleared to 0 during RESET.

DIEO: DMA Interrupt Enable Channel 0 (bit 2)

When DIE0 is set to 1, the termination channel 0 of DMA transfer (indicated when DE0 = 0) causes a CPU interrupt request to be generated. When DIE0 = 0, the channel 0 DMA termination interrupt is disabled. DIE0 is cleared to 0 during RESET.

DME: DMA Main Enable (bit 0)

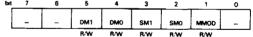
A DMA operation is only enabled when its DE bit (DE0 for channel 0, DE1 for channel 1) and the DME bit are set to 1.

When NMI occurs, DME is reset to 0, thus disabling DMA activity during the NMI interrupt service routine. To restart DMA, DE0 and/or DE1 should be written with 1 (even if the contents are already 1). This automatically sets DME to 1, allowing DMA operations to continue. Note that DME cannot be directly written. It is cleared to 0 by NMI or indirectly set to 1 by setting DE0 and/or DE1 to 1. DME is cleared to 0 during RESET.

(8) DMA Mode Register (DMODE)

DMODE is used to set the addressing and transfer mode for channel 0.

DMA Mode Register (DMODE : I/O Address = 31H)



DM1, DM0: Destination Mode Channel 0 (bits 5, 4)

Specifies whether the destination for channel 0 transfers is memory, I/O or memory mapped I/O and the corresponding address modifier. DM1 and DM0 are cleared to 0 during RESET.

Table 5 Destination

DM1	DMO	Memory/I/O	Address Increment/Decrement
0	0	Memory	+1
0	1	Memory	-1
1	0	Memory	fixed
1	1	I/O	fixed

SM1, SM0: Source Mode Channel 0 (bits 3, 2)

Specifies whether the source for channel 0 transfers is memory, I/O or memory mapped I/O and the corresponding address modifier. SM1 and SM0 are cleared to 0 during RESET.

Table 7 shows all DMA transfer mode combinations of DM0, DM1, SM0, SM1. Since I/O

1/O transfers are not implemented, twelve combinations are available.

Table 6 Source

SM1	SM0	Memory/I/O	Address Increment/Decrement
0	0	Memory	+1
0	1	Memory	-1
1	0	Memory	fixed
1	1	I/O	fixed

Table 7 Combination of Transfer Mode

DM1	DMO	SM1	sмо	Transfer Mode	Address Increment/Decrement
0	0	0	0	Memory→Memory	SAR0+1, DAR0+1
0	0	0	1	Memory→Memory	SARO-1, DARO+1
0	0	1	0	Memory*→Memory	SAR0 fixed, DAR0+1
0	0	1	1	I/O→Memory	SAR0 fixed, DAR0+1
0	1	0	0	Memory→Memory	SAR0+1, DAR0-1
0	1	0	1	Memory→Memory	SARO-1, DARO-1
0	1	1	0	Memory*Memory	SAR0 fixed, DAR0-1
0	1	1	1	I/O→Memory	SAR0 fixed, DAR0-1
1	0	0	0	Memory→Memory*	SARO+1, DARO fixed
1	0	0	1	Memory→Memory*	SARO-1, DARO fixed
1	0	1	0	reserved	
1	0	1	1	reserved	
1	1	0	0	Memory→I/O	SARO+ 1, DARO fixed
1	1	0	1	Memory→I/O	SARO-1, DARO fixed
1	1	1	0	reserved	
1	1	1	1	reserved	

^{.:} includes memory mapped I/O

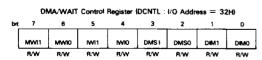
MMOD: Memory Mode Channel 0 (bit 1)

When channel 0 is configured for memory \iff memory transfers, the external $\overline{DREQ_o}$ input is not used to control the transfer timing. Instead, two automatic transfer timing modes are selectable – burst (MMOD = 1) and cycle steal (MMOD = 0). For burst memory \iff memory transfers, the DMAC will sieze control of the bus continuously until the DMA transfer completes (as shown by the byte count register = 0). In cycle steal mode, the CPU is given a cycle for each DMA byte transfer cycle until the transfer is completed.

For channel 0 DMA with I/O source or destination, the $\overline{DREQ_0}$ input times the transfer and thus MMOD is ignored. MMOD is cleared to 0 during RESET.

DMA/WAIT Control Register (DCNTL)

DCNTL controls the insertion of wait states into DMAC (and CPU) accesses of memory or I/O. Also, the DMA request mode for each DREQ (DREQ₀ and DREQ₁) input is defined as level or edge sense. DCNTL also sets the DMA transfer mode for channel 1, which is limited to memory \longleftrightarrow I/O transfers.



MWI1, MWI0: Memory Wait Insertion (bits 7-6)

Specifies the number of wait states introduced into CPU or DMAC memory access cycles. MWII and MWI0 are set to 1 during RESET. See section of Wait State Control for details.

IWI1, IWI0: I/O Wait Insertion (bits 5-4)

Specifies the number of wait states introduced into CPU or DMAC I/O access cycles. IWII and IWI0 are set to 1 during RE-SET. See section of Wait State Control for details.

DMS1, DMS0: DMA Request Sense (bits 3-2)

 $\overline{DMS1}$ and DMS0 specify the DMA request sense for channel 0 ($\overline{DREQ_0}$) and channel 1 ($\overline{DREQ_1}$) respectively. When reset to 0, the input is level sense. When set to 1, the input is edge sense. DMS1 and DMS0 are cleared to 0 during RESET.

DIM1, DIM0: DMA Channel 1 I/O and Memory Mode (bits 1-0)

Specifies the source/destination and address modifier for channel 1 memory \iff I/O transfer modes. IM1 and IM0 are cleared to 0 during RESET.

Table 8 Channel 1 Transfer Mode

DIM1	DIMO	Transfer Mode	Address Increment/Decrement
0	0	Memory→I/O	MAR1+1, IAR1 fixed
0	1	Memory→I/O	MAR1 - 1, IAR1 fixed
1	0	I/O→Memory	IAR1 fixed, MAR1 + 1
1	1	I/O→Memory	IAR1 fixed, MAR1 — 1

10.3 DMA Operation

This section discusses the three DMA operation modes for channel 0, memory \longleftrightarrow memory, memory \longleftrightarrow 1/O and memory \longleftrightarrow memory mapped I/O. In addition, the operation of channel 0 DMA with the on-chip ASCI (Asynchronous Serial Communication Interface) as well as Channel 1 DMA are described.

(1) Memory ← → Memory - Channel 0

For memory \iff memory transfers, the external $\overline{DREQ_0}$ input is not used for DMA transfer timing. Rather, the DMA operation is timed in one of two programmable modes — burst or cycle steal. In both modes, the DMA operation will automatically proceed until termination as shown by byte count (BCR0) = 0.

In burst mode, the DMA operation will proceed until termination. In this case, the CPU cannot perform any program execution until the DMA operation is completed.

In cycle steal mode, the DMA and CPU operation are alternated after each DMA byte transfer until the DMA is completed. The sequence ...

1 CPU Machine Cycle DMA Byte Transfer

 \dots is repeated until DMA is completed. Fig. 41 shows cycle steal mode DMA timing.

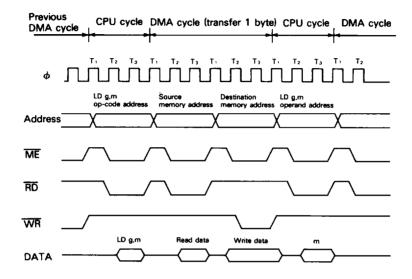


Figure 41 Cycle Steal Mode DMA Timing

To initiate memory \iff memory DMA transfer for channel 0, perform the following operations.

- Load the memory source and destination addresses into SAR0 and DAR0.
- 3 Load the number of bytes to transfer in BCR0.
- Specify burst or cycle steal mode in the MMOD bit of DCNTL.
- Program DE0 = 1 (with DWE0 = 0 in the same access) in DSTAT and the DMA operation will start 1 machine cycle later. If interrupt occurs at the same time, the DIE0 bit should be set to 1.

(2) Memory ←→ I/O (Memory Mapped I/O) - Channel 0 For memory ←→ I/O (and memory ←→ memory mapped I/O) the DREQ_d input is used to time the DMA transfers. In addi-

tion, the $\overline{\text{TEND}}_0$ (Transfer End) output is used to indicate the last (byte count register BCR0 = 00H) transfer.

The $\overline{DREQ_0}$ input can be programmed as level or edge sensitive. When level sense is programmed, the DMA operation begins when $\overline{DREQ_0}$ is sampled LOW If $\overline{DREQ_0}$ is sampled HIGH, after the next DMA byte transfer, control is relinquished to the HD64180 CPU. As shown in Fig. 42. $\overline{DREQ_0}$ is sampled at the rising edge of the clock cycle prior to T_3 i.e. either T_2 or T_w .

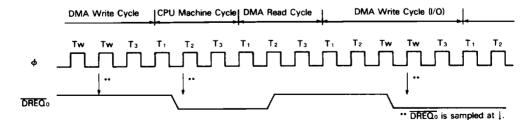


Figure 42 CPU Operation and DMA Operation (DREQ o is programmed for level sense)



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When edge sense is programmed, DMA operation begins at the falling edge of $DREQ_0$. If another falling edge is detected before the rising edge of the clock prior to T_3 during DMA write cycle (i.e. T_2 or TW), the DMAC continues operating. If an edge is not detected, the CPU is given control after the current byte DMA transfer com-

pletes. The CPU will continue operating until a \overline{DREQ}_0 falling edge is detected before the rising edge of the clock prior to T_a at which time the DMA operation will (re)start. Fig. 43 shows the edge sense DMA timing.

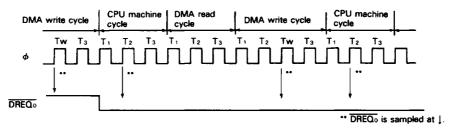


Figure 43 CPU Operation and DMA Operation (DREQ of sprogrammed for edge sense)

During the transfers for channel 0, the \overline{TEND}_0 output will go LOW synchronous with the write cycle of the last (BCR0 = 00H)

DMA transfer as shown in Fig. 44.

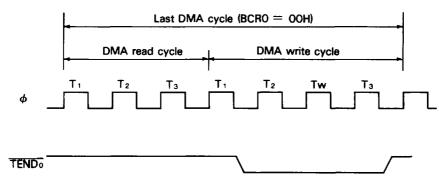


Figure 44 TEND Output Timing

The \overline{DREQ}_0 and \overline{TEND}_0 pins are programmably multiplexed with the CKA0 and CKA1 ASCI clock input/outputs. However, when DMA channel 0 is programmed for memory \longleftrightarrow I/O (and memory \longleftrightarrow memory mapped I/O) transfers, the CKA0/ \overline{DREQ}_0 pin automatically functions as input pin even if it has been programmed as output pin for CKA0. And the CKA1/ \overline{TEND}_0 pin functions as output pin for \overline{TEND}_0 by setting CKA1D to 1 in CNTLA1.

To initiate memory \longleftrightarrow > 1/O (and memory \longleftrightarrow memory mapped 1/O) DMA transfer for channel 0, perform the following operations.

- Load the memory and I/O or memory mapped I/O source and destination addresses into SAR0 and DAR0. Note that I/O addresses (not memory mapped I/O) are limited to 16 bits (A₀-A₁.). Make sure that bits A₁₀ and A₁₇ are 0 (A₁₆ is a don't care) to correctly enable the external DREQ₀ input.
- Load the number of bytes to transfer in BCR0.
- Specify whether DREQ₀ is edge or level sense by programming the DMS0 bit of DCNTL.
- ⑤ Enable or disable DMA termination interrupt with the DIE0 bit in DSTAT.
- 6 Program DE0 = 1 (with $\overline{DWE0} = 0$ in the same access) in

 $DSTA\underline{T}$ and the DMA operation will begin under the control of the \overline{DREQ}_0 input.

(3) Memory ←→ ASCI - Channel 0

Channel 0 has extra capability to support DMA transfer to and from the on-chip two channel ASCI. In this case the external \overline{DRE} , input is not used for DMA timing. Rather, the ASCI status bits are used to generate an internal \overline{DREQ}_0 . The TDRE (Transmit Data Register Empty) bit and the RDRF (Receive Data Register Full) bit are used to generate an internal \overline{DREQ}_0 for ASCI transmission and reception respectively.

To initiate memory \iff ASCI DMA transfer, perform the following operations.

- Load the source and destination addresses into SAR0 and DAR0. Specify the I/O (ASCI) address as follows.
 - Bits A_0 - A_7 should be contain the address of the ASCI channel transmitter or receiver (I/O addresses 06H-09H).
 - Bits A₈-A₁₅ should equal 0.
 - Bits A_{17} - A_{16} should be set according to the following table to enable use of the appropriate ASCI status bit as an internal DMA request.



Table 9 DMA Request

SAR18	SAR17	SAR16	DMA Transfer Request
х	0	0	DREQ
×	0	1	RDRF (ASCI channel 0)
×	1	0	RDRF (ASCI channel 1)
Х	1	1	reserved

X: Don't care

DAR18	DAR17	DAR16	DMA Transfer Request
Х	0	0	DREQ
Х	0	1	TDRE (ASCI channel 0)
×	1	0	TDRE (ASCI channel 1)
×	1	1	reserved

X: Don't care

- 3: Load the number of bytes to transfer in BCR0.
- The DMA request sense mode (DMS0 bit in DCNTL) MUST be specified as 'edge sense'.
- Enable or disable DMA termination interrupt with the DIE0 bit in DSTAT.
- Program DE0 = 1 (with DWE0 = 0 in the same access) in DSTAT and the DMA operation with the ASCI will begin under control of the ASCI generated internal DMA request.

The ASCI receiver or transmitter being used for DMA must be initialized to allow the first DMA transfer to begin.

The ASCI receiver must be 'empty' as shown by RDRF = 0. The ASCI transmitter must be 'full' as shown by TDRE = 0. Thus, the first byte should be written to the ASCI Transmit Data Register under program control. The remaining bytes will be transferred using DMA.

(4) Channel 1 DMA

DMAC Channel 1 can perform memory \longleftrightarrow 1/0 transfers. Except for different registers and status/control bits, operation is exactly the same as described for channel 0 memory \longleftrightarrow 1/0 DMA.

To initiate DMA channel 1 memory \iff I/O transfer perform the following operations.

- 1 Load the memory address (19 bits) into MAR1.
- 2. Load the I/O address (16 bits) into IARI.
- Program the source/destination and address increment/decrement mode using the DIM1 and DIM0 bits in DCNTL.
- Specify whether DREQ, is level or edge sense in the DMS1 bit

- in DCNTL.
- 5 Enable or disable DMA termination interrupt with the DIE1 bit in DSTAT.
- Program DE1 = 1 (with DWE1 = 0 in the same access) in DSTAT and the DMA operation with the external I/O device will begin using the external DREQ₁ input and TEND₁, output.

10.4 DMA Bus Timing

When memory (and memory mapped I/O) is specified as a source or destination, ME goes LOW during the memory access. When I/O is specified as a source or destination, IOE goes LOW during the I/O access.

When I/O (and memory mapped I/O) is specified as a source or destination, the DMA timing is controlled by the external DREQ input and the TEND output indicates DMA termination. Note that external I/O devices may not overlap addresses with internal I/O and control registers, even using DMA.

For I/O accesses, 1 wait state is automatically inserted. Additional wait states can be inserted by programming the on-chip wait state generator or using the external WAIT input. Note that for memory mapped I/O accesses, this automatic I/O wait state is not inserted.

 $\frac{For}{DREQ_0}$ input is ignored. Automatic DMA timing is programmed as either burst or cycle steal.

When a DMA memory address carry/borrow between bits A₁₅ and A₁₆ of the address bus occurs (when crossing 64k bytes boundaries), the minimum bus cycle is extended to four clocks by automatic insertion of one internal Ti state.

10.5 DMAC Channel Priority

For simultaneous $\overline{DREQ_0}$ and $\overline{DREQ_1}$ requests, channel 0 has priority over channel 1. When channel 0 is performing a memory \longrightarrow memory transfer, channel 1 cannot operate until the channel 0 operation has terminated. If channel 1 is operating, channel 0 cannot operate until channel 1 releases control of the bus.

10.6 DMAC and BUSREQ, BUSACK

The BUSREQ and BUSACK inputs allow another bus master to take control of the HD64180 bus. BUSREQ and BUSACK have priority over the on-chip DMAC and will suspend DMAC operation. The DMAC releases the bus to the external bus master at the breakpoint of the DMAC memory or I/O access. Since a single byte DMAC transfer requires a read and a write cycle, it is possible for the DMAC to be suspended after the DMAC read, but before the DMAC write. Even in this case, when the external master releases the HD64180 bus (BUSREQ HIGH), the on-chip DMAC will correctly continue the suspended DMA operation.

10.7 DMAC Internal Interrupts

Fig. 45 illustrates the internal DMA interrupt request generation circuit.

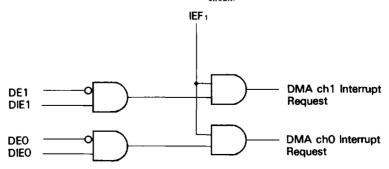


Figure 45 DMAC Interrupt Request Circuit Diagram

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DE0 and DE1 are automatically cleared to 0 by the HD64180 at the completion (byte count = 0) of a DMA operation for channel 0 and channel 1 respectively. They remain 0 until a 1 is written. Since DE0 and DE1 use level sense, an interrupt will occur if the CPU IEF, flag is set to 1. Therefore, the DMA termination interrupt service routine should disable further DMA interrupts (by programming the channel DIE bit = 0) before enabling CPU interrupts (i.e. IEF, is set to 1). After reloading the DMAC address and count registers, the DIE bit can be set to 1 to reenable the channel interrupt, and at the same time DMA can resume by programming the channel DE bit = 1.

10.8 DMAC and NMI

NMI, unlike all other interrupts, automatically disables DMAC operation by clearing the DME bit of DSTAT. Thus, the NMI interrupt service routine may respond to time critical events without delay due to DMAC bus usage. Also, NMI can be effectively used as an external DMA abort input, recognizing that both channels are suspended by the clearing of DME.

If the falling edge of \overline{NMI} occurs before the falling clock of the state prior to T_3 (T_2 or Tw) of the DMA write cycle, the DMAC will be suspended and the CPU will start the \overline{NMI} response at the end of the current cycle.

By setting a channels DE bit to 1, that channels operation can be restarted, and DMA will correctly resume from the point at which it was suspended by \overline{NMI} . See Fig. 46 for details.

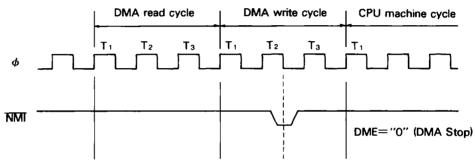


Figure 46 NMI and DMA Operation

10.9 DMAC and RESET

During RESET the bits in DSTAT, DMODE, and DCNTL are initialized as stated in their individual register descriptions. Any DMA operation in progress is stopped allowing the CPU to use the

bus to perform the RESET sequence. However, the address register (SAR0, DAR0, MAR1, IAR1) and byte count register (BCR0, BCR1) contents are not changed during RESET.

11 ASYNCHRONOUS SERIAL COMMUNICATION INTER-FACE (ASCI)

The HD64180 on-chip ASCI has two independent full duplex channels. Based on full programmability of the following functions, the ASCI can directly communicate with a wide variety of standard UARTs (Universal Asynchronous Receiver/Transmitter) including the HD6350 CMOS ACIA and the Serial Communication Interface (SCI) contained on the HD6301 series CMOS single chip controllers

The key functions for ASCI are shown below. Each channel is independently programmable.

- · Full duplex communication
- · 7- or 8-bit data length
- · Program controlled 9th data bit for multiprocessor communica-

- tion
- · 1 or 2 stop bits
- · Odd, even, no parity
- · Parity, overrun, framing error detection
- Programmable baud rate generator, /16 and /64 modes
 Speed to 38.4k bits per second (CPU f_C = 6.144 MHz)
- Modem control signals Channel 0 has \overline{DCD}_0 , \overline{CTS}_0 and \overline{RTS}_0 Channel 1 has \overline{CTS}_1 ,
- · Programmable interrupt condition enable and disable
- · Operation with on-chip DMAC

11.1 ASCI Block Diagram

Fig. 47 shows the ASCI Block Diagram.

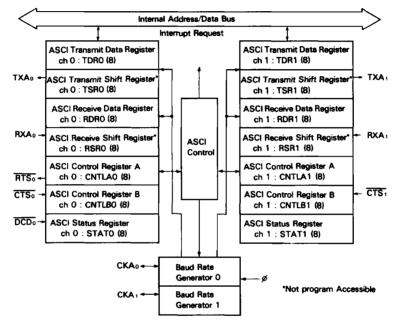


Figure 47 ASCI Block Diagram

11.2 ASCI Register Description

(1) ASC! Transmit Shift Register 0, 1 (TSR0, 1)

When the ASCI Transmit Shift Register receives data from the ASCI Transmit Data Register (TDR), the data is shifted out to the TXA pin. When transmission is completed, the next byte (if available) is automatically loaded from TDR into TSR and the next transmission starts. If no data is available for transmission, TSR idles by outputting a continuous HIGH level. This register is not program accessible.

(2) ASCI Transmit Data Register 0, 1 (TDR0, 1: I/O Address = 06H, 07H)

Data written to the ASCI Transmit Data Register is transferred to the TSR as soon as TSR is empty. Data can be written to while TSR is shifting out the previous byte of data. Thus, the ASCI transmitter is double bufferred.

Data can be written into and read from the ASCI Transmit Data Register.

If data is read from the ASCI Transmit Data Register, the ASCI

data transmit operation won't be affected by this read operation.

(3) ASCI Receive Shift Register 0, 1 (RSR0, 1)

This register receives data shifted in on the RXA pin. When full, data is automatically transferred to the ASCI Receive Data Register (RDR) if it is empty. If RSR is not empty when the next incoming data byte is shifted in, an overrun error occurs. This register is not program accessible.

(4) ASCI Receive Data Register 0, 1 (RDR0, 1: I/O Address = ORH, O9H)

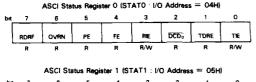
When a complete incoming data byte is assembled in RSR, it is automatically transferred to the RDR if RDR is empty. The next incoming data byte can be shifted into RSR while RDR contains the previous received data byte. Thus, the ASCI receiver is double buffered.

The ASCI Receive Data Register is read-only-register.

However, if RDRF = 0, data can be written into the ASCI Receive Data Register, and the data can be read.

(5) ASCI Status Register 0, 1 (STATO, 1)

Each channel status register allows interrogation of ASCI communication, error and modem control signal status as well as enabling and disabling of ASCI interrupts.



	ASCI Status Register 1 (STAT1 : I/O Address = 05H)										
bit	7	. 6	5	4	3	2	1	0			
	RORF	OVRN	PE	FE	RIE	CTS1E	TORE	TÆ			
	R	R	R	R	R/W	R/W	R	R/W			

RDRF: Receive Data Register Full (bit 7)

RDRF is set to 1 when an incoming data byte is loaded into RDR. Note that if a framing or parity error occurs, RDRF is still set and the receive data (which generated the error) is still loaded into RDR, RDRF is cleared to 0 by reading RDR, when the $\overline{DCD_0}$ input is HIGH, in IOSTOP mode and during RESET.

OVRN: Overrun Error (bit 6)

OVRN is set to 1 when RDR is full and RSR becomes full. OVRN is cleared to 0 when the EFR bit (Error Flag Reset) of CNTLA is written to 0, when $\overrightarrow{DCD_0}$ is HIGH, in IOSTOP mode and during RESET.

PE: Parity Error (bit 5)

PE is set to 1 when a parity error is detected on an incoming data byte and ASC1 parity detection is enabled (the MOD1 bit of CNTLA is set to 1). PE is cleared to 0 when the EFR bit (Error Flag Reset) of CNTLA is written to 0, when $\overline{DCD_0}$ is HIGH, in IOSTOP mode and during RESET.

FE: Framing Error (bit 4)

If a receive data byte frame is delimited by an invalid stop bit (i.e. 0, should be 1), FE is set to 1. FE is cleared to 0 when the EFR bit (Error Flag Reset) of CNTLA is written to 0, when $\overline{DCD_0}$ is HIGH, in IOSTOP mode and during RESET.

RIE: Receive Interrupt Enable (bit 3)

RIE should be set to 1 to enable ASCI receive interrupt requests. When RIE to 1, if any of the flags RDRF, OVRN, PE, FE become set to 1 an interrupt request is generated. For channel 0, an interrupt will also be generated by the transition of the external \overline{DCD}_0 input from LOW to HIGH. RIE is cleared to 0 during RESET.

DCD₀: Data Carrier Detect (bit 2 STATO)

Channel 0 has an external $\overline{DCD_0}$ input pin. The $\overline{DCD_0}$ bit is set to 1 when the $\overline{DCD_0}$ input is HIGH. It is cleared to 0 on the first read of STAT0 following the HIGH to LOW transition of $\overline{DCD_0}$ input and during RESET. When $\overline{DCD_0} = 1$, receiver unit is reset and receiver operation is inhibited.

CTS1E: Channel 1 CTS Enable (bit 2 STAT1)

Channel I has an external $\overline{\text{CTS}}_1$ input which is multiplexed with the receive data pin (RXS) for the CSI/O (Clocked Serial I/O Port). Setting CTS1E to I selects the $\overline{\text{CTS}}_1$ function and clearing CTS1E to 0 selects the RXS function.

TDRE: Transmit Data Register Empty (bit 1)

TDRE = 1 indicates that the TDR is empty and the next transmit data byte can be written to TDR. After the byte is written to TDR, TDRE is cleared to 0 until the ASCI transfers the byte from the TDR to the TSR, at which time TDRE is again set to 1. TDRE

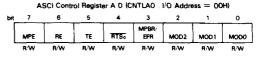
is set to 1 in IOSTOP mode and during RESET. When the external \overline{CTS} input is HIGH, TDRE is reset to 0.

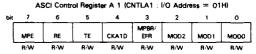
TIE: Transmit Interrupt Enable (bit 0)

TIE should be set to 1 to enable ASCI transmit interrupt requests. If TIE = 1, an interrupt will be requested when TDRE = 1. TIE is cleared to 0 during RESET.

· ASCI Control Register A0, 1 (CNTLA0, 1)

Each ASCI channel Control Register A configures the major operating modes such as receiver/transmitter enable and disable, data format, and multiprocessor communication mode.





MPE: Multi Processor Mode Enable (bit 7)

The ASCI has a multiprocessor communication mode which utilizes an extra data bit for selective communication when a number of processors share a common serial bus. Multiprocessor data format is selected when the MP bit in CNTLB is set to 1. If multiprocessor mode is not selected (MP bit in CNTLB = 0), MPE has no effect. If multiprocessor mode is selected, MPE enables or disables the 'wake-up' feature as follows. If MPE is set to 1, only received bytes in which the MPB (multiprocessor bit) = 1 can affect the RDRF and error flags. Effectively, other bytes (with MPB = 0) are 'ignored' by the ASCI. If MPE is reset to 0, all bytes, regardless of the state of the MPB data bit, affect the RDRF and error flags. MPE is cleared to 0 during RESET.

RE: Receiver Enable (bit 6)

When RE is set to 1, the ASCI receiver is enabled. When RE is cleared to 0, the receiver is disabled and any receive operation in progress is interrupted. However, the RDRF and error flags are not reset and the previous contents of RDRF and error flags are held. RE is cleared to 0 in IOSTOP mode and during RESET.

TE: Transmitter Enable (bit 5)

When TE is set to 1, the ASCI transmitter is enabled. When TE is cleared to 0, the transmitter is disabled and any transmit operation in progress is interrupted. However, the TDRE flag is not reset and the previous contents of TDRE are held. TE is cleared to 0 in IOSTOP mode and during RESET.

RTS₀ — Request to Send Channel 0 (bit 4 in CNTLA0)

When RTS₀ is cleared to 0, the RTS₀ output pin will go LOW. When RTS₀ is set to 1, the RTS₀ output immediately goes HIGH. RTS₀ is set to 1 during RESET.

CKA1D: CKA1 Clock Disable (bit 4 in CNTLA1)

When CKA1D is set to 1, the multiplexed CKA1/ $\overline{TEND_0}$ pin is used for the $\overline{TEND_0}$ function. When CKA1D = 0, the pin is used as CKA1, an external data clock input/output for channel 1. CKA1D is cleared to 0 during RESET.

MPBR/EFR: Multiprocessor Bit Receive/Error Flag Reset (bit 3)

When multiprocessor mode is enabled (MP in CNTLB = 1), MPBR, when read, contains the value of the MPB bit for the last re-

ceive operation. When written to 0, the EFR function is selected to reset all error flags (OVRN, FE and PE) to 0. MPBR/EFR is undefined during RESET.

MOD2, 1, 0: ASCI Data Format Mode 2, 1, 0 (bits 2-0)

These bits program the ASCI data format as follows. MOD2

= 0 → 7 bit data

= 1 → 8 bit data

MODI

= 0 → No parity

= 1 → Parity enabled

MOD0

 $= 0 \rightarrow 1$ stop bit

 $= 1 \rightarrow 2$ stop bits

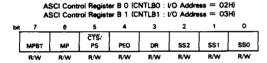
The data formats available based on all combinations of MOD2, MOD1 and MOD0 are shown in Table 10.

Table 10 Combination of Data Format

ı	MOD2	MOD1	MODO	Data Format
	0	0	0	Start + 7 bit data + 1 stop
	0	0	1	Start + 7 bit data + 2 stop
	0	1	0	Start + 7 bit data + parity + 1 stop
	0	1	1	Start + 7 bit data + parity + 2 stop
	1	0	0	Start+8 bit data+1 stop
	1	0	1	Start + 8 bit data + 2 stop
	1	1	0	Start + 8 bit data + parity + 1 stop
	1	1	1	Start+8 bit data+parity+2 stop

(6) ASCI Control Register B0, 1 (CNTLB0, 1)

Each ASCI channel control register B configures multiprocessor mode, parity and baud rate selection.



MPBT: Multiprocessor Bit Transmit (bit 7)

When multiprocessor communication format is selected (MP bit = 1), MPBT is used to specify the MPB data bit for transmission. If MPBT = 1, then MPB = 1 is transmitted. If MPBT = 0, then MPB = 0 is transmitted. MPBT state is undefined during and after RESET.

MP: Multiprocessor Mode (bit 6)

When MP is set to 1, the data format is configured for multiprocessor mode based on the MOD2 (number of data bits) and MOD0 (number of stop bits) bits in CNTLA. The format is as follows.

Start bit + 7 or 8 data bits + MPB bit + 1 or 2 stop bits

Note that multiprocessor (MP = 1) format has no provision for parity. If MP = 0, the data format is based on MOD0, MOD1 and MOD2 and may include parity. The MP bit is cleared to 0 during RESET.

CTS/PS: Clear to Send/Prescale (bit 5)

When read, CTS/PS reflects the state of the external CTS input. If the CTS input pin is HIGH, CTS/PS will be read as 1. Note that when the CTS input pin is HIGH, the TDRE bit is inhibited (i.e. held at 0). For channel 1, the CTS, input is multiplexed with RXS pin (Clocked Serial Receive Data). Thus, CTS/PS is only valid when read if the channel 1 CTS1E bit = 1 and the CTS, input pin function is selected. The read data of CTS/PS is not affected by RE-SFT

When written, CTS/PS specifies the baud rate generator prescale factor. If CTS/PS is set to 1, the system clock (\$\phi\$) is prescaled by 30 while if CTS/PS is cleared to 0, the system clock is prescaled by 10. CTS/PS is cleared to 0 during RESET.

PEO: Parity Even Odd (bit 4)

PEO selects even or odd parity. PEO does not affect the enabling/disabling of parity (MOD1 bit of CNTLA). If PEO is cleared to 0, even parity is selected. If PEO is set to 1, odd parity is selected. PEO is cleared to 0 during RESET.

DR: Divide Ratio (bit 3)

DR specifies the divider used to obtain baud rate from the data sampling clock. If DR is cleared to 0, divide by 16 is used while if DR is set to 1, divide by 64 is used. DR is cleared to 0 during RE-SET.

SS2, 1, 0: Source/Speed Select 2, 1, 0 (bits 2-0)

Specify the data clock source (internal or external) and baud rate prescale factor. SS2, SS1, and SS0 are all set to 1 during RESET. Table 11 shows the divide ratio corresponding to SS2, SS1, and SS0.

Table 11 Divide Ratio

SS2	SS1	\$ S 0	Divide Ratio
0	0	0	+1
0	0	1	+2
0	1	0	+4
0	1	1	+ 8
1	0	0	÷16
1	0	1	÷ 32
1	1	0	+64
1	1	1	external clock

The external ASCI channel 0 data clock pins are multiplexed with DMA control lines ($CKA_0/\overline{DREQ_0}$ and $CKA_1/\overline{TEND_0}$). During RESET, these pins are initialized as ASCI data clock inputs. If SS2, SS1, and SS0 are reprogrammed (any other value than SS2, SS1, SS0 = 1) these pins become ASCI data clock outputs. However, if DMAC channel 0 is configured to perform memory \longleftrightarrow I/O (and memory mapped I/O) transfers the $CKA_0/\overline{DREQ_0}$ pin revert to DMA control signals regardless of SS2, SS1, and SS0 programming. Also, if the $CKA_1/\overline{DENQ_0}$ reverts to the DMA Control output function regardless of SS2, SS1, and SS0 programming.

Final data clock rates are based on CTS/PS (prescale), DR, SS2, SS1, SS0, and the HD64180 system clock (φ) frequency as shown in Table 12.

Table 12 Baud Rate List

Pres	scaler		npling ate		Bau	d Rate		General Divide	Bau	d Rate (Exam (BPS)	ple)		CKA
PS	Divide Ratio	DR	Rate	SS2	SS1	SS0	Divide Ratio	Ratio	φ=6.144 MHz	φ=4.608 MHz	φ=3.072 MHz	1/0	Clock Frequency
				0	0	0	÷1	φ÷160	38400		19200		φ÷10
l				0	0	1	2	320	19200		9600		20
				0	1	0	4	640	9600		4800		40
Ī		0	16	0	1	1 1	8	1280	4800		2400	0	80
ł				1	0	0	16	2560	2400		1200		160
1				1	0	1	32	5120	1200		600		320
1				1	1	0_	64	10240	600		300		640
٥	φ÷ 10			1	1	1		fc÷16				ı	fc
1				0	0	0	÷ 1	φ÷640	9600		4800		φ÷10
1	1			0	0	1 1	2	1280	4800		2400		20
1				0	1	0	4	2560	2400		1200		40
1		1	64	0	1	1	8	5120	1200		600	0	80
1				1	0	0	16	10240	600		300		160
1				1	0	1 1	32	20480	300		150		320
l .	l			1	1	0	64	40960	150		75		640
				1	1	1	_	fc + 64	-	_	-	ł	fc
				0	0	0	÷ 1	φ÷480		9600			φ÷30
				0	0	1	2	960		4800			60
				0	1	0	4	1920		2400			120
		0	16	0	1	1	8	3840		1200		0	240
				1	0	0	16	7680		600			480
	i I			1	0	1	32	15360		300			960
				1	1	0	64	30720		150			1920
1	φ÷30			11	1	1		fc÷16				<u> </u>	fc
				0	0	0	÷ 1	φ÷1920		2400			φ÷30
				0	0	1	2	3840		1200			60
				0	1	0	4	7680		600			120
		1	64	0	1	1	8	15360		300		0	240
				1	0	0	16	30720		150			480
				1	0	1	32	61440		75			960
				1	1	0	64	122880		37.5			1920
				1	1	1		fc ÷ 64				ı	fc

11,3 MODEM Control Signals

ASCI channel 0 has CTS₀, DCD₀, and RTS₀ external modem control signals. ASCI channel 1 has a CTS₁ modem control signal which is multiplexed with RXS pin (Clocked Serial Receive Data).

(1) ČTS₀: Clear to Send 0 (input)

The CTS₀ input allows external control (start/stop) of ASCI channel 0 transmit operations. When CTS₀ is HIGH, channel 0 TDRE bit is held at 0 regardless of whether the TDR0 (Transmit Data Register) is full or empty. When CTS₀ is LOW, TDRE will reflect the state of TDR0. Note that the actual transmit operation is not disabled by CTS₀ HIGH, only TDRE is inhibited.

(2) DCD₀: Data Carrier Detect 0 (input)

The $\overline{DCD_0}$ input allows external control (start/stop) of ASCI channel 0 receive operations. When $\overline{DCD_0}$ is HIGH, channel 0 RDRF bit is held at 0 regardless of whether the RDR0 (Receive Data Register) is full or empty. The error flags (PE. FE and OVRN bits) are also held at 0. Even after the $\overline{DCD_0}$ input goes LOW, these

bits will not resume normal operation until the status register (STAT0) is read. Note that this first read of $\overline{STAT0}$, while enabling \overline{normal} operation, will still indicate the $\overline{DCD_0}$ input is HIGH ($\overline{DCD0}$ bit = 1) even though it has gone LOW. Thus, the STAT0 register should be read twice to insure the $\overline{DCD0}$ bit is cleared to 0.

(3) RTSo: Request to Send 0 (output)

RTS₀ allows the ASCI to control (start/stop) another communication devices transmission (for example, by connection to that devices CTS input). RTS₀ is essentially a 1 bit output port, having no side effects on other ASCI registers or flags.

(4) CTS1: Clear to Send 1 (input)

Channel 1 CTS₁ input is multiplexed with the RXS pin (Clocked Serial Receive Data). The $\overline{CTS_1}$ function is selected when the CTS1E bit in STAT1 is set to 1. When enabled, the $\overline{CTS_1}$ operation is equivalent to $\overline{CTS_0}$.

Modem control signal timing is shown in Fig. 48(a) and Fig. 48(b).

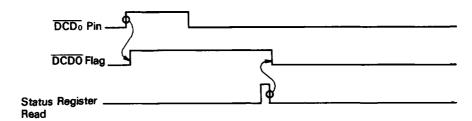


Figure 48 (a) DCD Timing

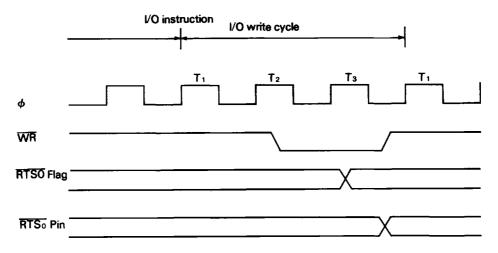


Figure 48 (b) RTS Timing

11.4 ASCI Interrupts

Fig. 49 shows the ASCI interrupt request generation circuit.

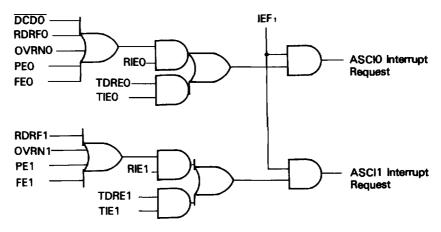


Figure 49 ASCI Interrupt Request Circuit Diagram

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11.5 ASCI ← > DMAC operation

Operation of the ASCI with the on-chip DMAC channel 0 requires the DMAC be correctly configured to utilize the ASCI flags as DMA request signals.

11.6 ASCI and RESET

During RESET, the ASCI status and control registers are initialized as defined in the individual register descriptions.

Receive and Transmit operations are stopped during RESET. However, the contents of the transmit and receive data registers (TDR and RDR) are not changed by RESET.

11.7 ASCI Clock

In external clock input mode, the external clock is directly input to the sampling rate (+16/+64) as shown in Fig. 50.

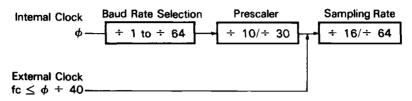


Figure 50 ASCI Clock Block Diagram

12 CLOCKED SERIAL I/O PORT (CSI/O)

The HD64180 includes a simple, high speed clock synchronous serial I/O port. The CSI/O includes transmit/receive (half duplex), fixed 8-bit data and internal or external data clock selection. High speed operation (baud rate as high as 200k bits/second at $f_{\rm C}=4$ MHz) is provided. The CSI/O is ideal for implementing a multiprocessor communication link between the HD64180 and the HMCS400 series (4-bit) and the HD6301 series (8-bit) single chip

controllers as well as additional HD64180s. These secondary devices may typically perform a portion of the system I/O processing such as keyboard scan/decode, LDC interface etc.

12.1 CSI/O Block Diagram

The CSI/O block diagram is shown in Fig. 51. The CSI/O consists of two registers — the Transmit/Receive Data Register (TRDR) and Control Register (CNTR).

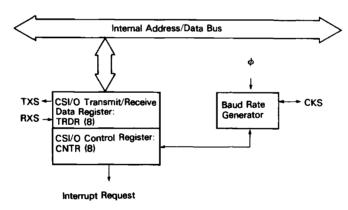


Figure 51 CSI/O Block Diagram

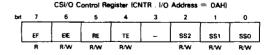
12.2 CSI/O Register Description

(1) CSI/O Transmit/Receive Data Register (TRDR: I/O Address = OBH)

TRDR is used for both CSI/O transmission and reception. Thus, the system design must insure that the constraints of half-duplex operation are met (Transmit and receive operation can't occur simultaneously). For example, if a CSI/O transmission is attempted at the same time that the CSI/O is receiving data, a CSI/O will not work. Also note that TRDR is not buffered. Therefore, attempting to perform a CSI/O transmit while the previous transmit data is still being shifted out causes the shift data to be immediately updated, thereby corrupting the transmit operation in progress. Similarly, reading TRDR while a transmit or receive is in progress should be avoided.

(2) CSI/O Control/Status Register (CNTR: I/O Address = OAH)

CNTR is used to monitor CSI/O status, enable and disable the CSI/O, enable and disable interrupt generation and select the data clock speed and source.



EF: End Flag (bit 7)

EF is set to 1 by the CSI/O to indicate completion of an 8-bit data transmit or receive operation. If EIE (End Interrupt Enable)

bit = 1 during the time EF = 1, a CPU interrupt request will be generated. Program access of TRDR should only occur if EF = 1. The CSI/O clears EF to 0 when TRDR is read or written. EF is cleared to 0 during RESET and IOSTOP mode.

EIE: End Interrupt Enable (bit 6)

EIE should be set to 1 to enable EF = 1 to generate a CPU interrupt request. The interrupt request is inhibited if EIE is cleared to 0. EIE is cleared to 0 during RESET.

RE: Receive Enable (bit 5)

A CSI/O receive operation is started by setting RE to 1. When RE is set to 1, the data clock is enabled. In internal clock mode, the data clock is output from the CKS pin. In external clock mode, the clock is input on the CKS pin. In either case, data is shifted in on the RXS pin in synchronization with the (internal or external) data clock. After receiving 8 bits of data, the CSI/O automatically clears RE to 0. EF is set to 1 and an interrupt (if enabled by EIE = 1) will be generated. Note that RE and TE should never both be set to 1 at the same time. RE is cleared to 0 during RESET and IOSTOP mode.

Note that the RXS pin (pin 52) is multiplexed with CTS, modem control input of ASCI channel 1. In order to enable the RXS function, the CTS1E bit in CNTA1 should be reset to 0.

TE: Transmit Enable (bit 4)

A CSI/O transmit operation is started by setting TE to 1. When TE is set to 1, the data clock is enabled. In internal clock mode, the data clock is output from the CKS pin. In external clock mode, the clock is input on the CKS pin. In either case, data is shifted out on the TXS pin synchronous with the (internal or external) data clock. After transmitting 8 bits of data, the CSI/O automatically clears TE to 0, EF is set to 1 and an interrupt (if enabled by EIE = 1) will be generated. Note that TE and RE should never both be set to 1 at the same time. TE is cleared to 0 during RESET and IOSTOP mode.

SS2, 1, 0: Speed Select 2, 1, 0 (bits 2-0)

SS2, SS1 and SS0 select the CSI/O transmit/receive clock source and speed. SS2, SS1 and SS0 are all set to 1 during RESET. Table 13 shows CSI/O Baud Rate Selection.

Table 13 CSI/O Baud Rate Selection

SS2	SS1	sso	Divide Ratio	Baud Rate
0	0	0	÷ 20	(200000)
0	0	1	÷40	(100000)
0	1	0	+80	(50000)
0	1	1	÷160	(25000)
1	0	0	÷ 320	(12500)
1	0	1	÷ 640	(6250)
1	1	0	÷1280	(3125)
1	1	1	external Clock input (less than ÷ 20)	

() shows the baud rate (BPS) at $\phi = 4$ MHz.

After RESET, the CKS pin is configured as an external clock input (SS2, SS1, SS0 = 1). Changing these values causes CKS to become an output pin and the selected clock will be output when transmit or receive operations are enabled.

12.3 CSI/O Interrupts

The CSI/O interrupt request circuit is shown in Fig. 52.

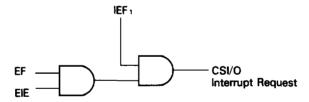


Figure 52 CSI/O Interrupt Circuit Diagram

12.4 CSI/O Operation

The CSI/O can be operated using status polling or interrupt driven algorithms.

(1) Transmit - Polling

- 1) Poll the TE bit in CNTR until TE = 0.
- Write the transmit data into TRDR.
- Write the transmit data into ISet the TE bit in CNTR to 1.
- 4 Repeat 1 to 3 for each transmit data byte.

(2) Transmit - Interrupts

- ① Poll the TE bit in CNTR until TE = 0.
- Write the first transmit data byte into TRDR.
- 3 Set the TE and EIE bits in CNTR to 1.
- When the transmit interrupt occurs, write the next transmit data byte into TRDR.
- Set the TE bit in CNTR to 1.
- 6 Repeat 4 to 5 for each transmit data byte.

(3) Receive - Polling

- (1) Poll the RE bit in CNTR until RE = 0.
- Set the RE bit in CNTR to 1.
- (3) Poll the RE bit in CNTR until RE = 0.

- (4) Read the receive data from TRDR.
- Repeat 2 to 4 for each receive data byte.

(4) Receive - Interrupts

- Poll the RE bit in CNTR until RE = 0.
- Set the RE and EIE bits in CNTR to 1.
- When the receive interrupt occurs read the receive data from TRDR
- Set the RE bit in CNTR to 1.
- (5) Repeat 3 to 4 for each receive data byte.

12.5 CSI/O Operation Timing Notes

- (1) Note that transmitter clocking and receiver sampling timings are different from internal and external clocking modes. Fig. 53 to Fig. 54 shows CSI/O Transmit/Receive Timing.
- (2) The transmitter and receiver should be disabled (TE and RE = 0) when initializing or changing the baud rate.

12.6 CSI/O Operation Notes

(1) Disable the transmitter and receiver (TE and RE = 0) before initializing or changing the baud rate. When changing the baud rate after completion of transmission or reception, a delay of at least one bit time is required before baud rate modification.

- (2) When RE or TE is cleared to 0 by software, a corresponding receive or transmit operation is immediately terminated. Normally, TE or RE should only be cleared to 0 when EF = 1.
- (3) Simultaneous transmission and reception is not possible. Thus, TE and RE should not both be 1 at the same time.

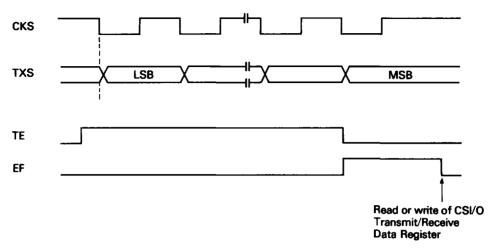


Figure 53 Transmit Timing — Internal Clock

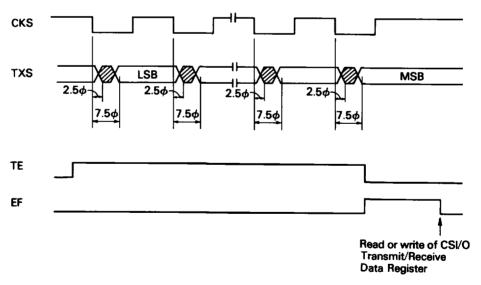


Figure 54 Transmit Timing - External Clock

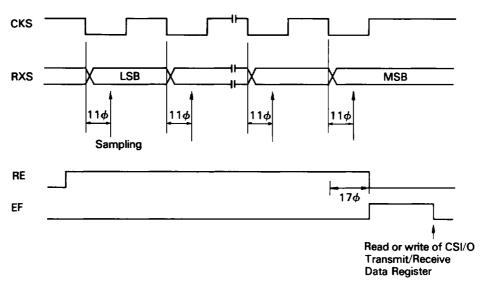


Figure 55 Receive Timing — Internal Clock

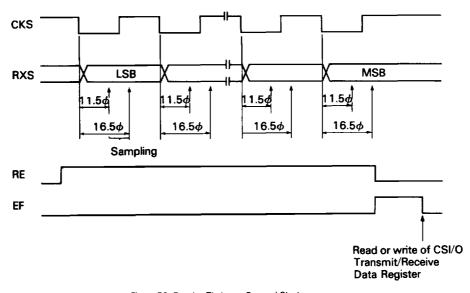


Figure 56 Receive Timing — External Clock

12.7 CSI/O and RESET

During RESET each bit in the CNTR is initialized as defined in the CNTR register description.

CSI/O transmit and receive operations in progress are aborted during RESET. However, the contents of TRDR are not changed.

13 PROGRAMMABLE RELOAD TIMER (PRT)

The HD64180 contains a two channel 16-bit Programmable Reload Timer. Each PRT channel contains a 16-bit down counter and a 16-bit reload register. The down counter can be directly read and written and a down counter overflow interrupt can be programmably enabled or disabled. In addition, PRT channel 1 has a TOUT output pin (multiplexed with A₁₀) which can be set HIGH, LOW, or toggled. Thus PRT1 can perform programmable output waveform

generation.

13.1 PRT Block Diagram

The PRT block diagram is shown in Fig. 57. The two channels have separate timer data and reload registers and a common status/control register. The PRT input clock for both channels is equal to the system clock (6) divided by 20.

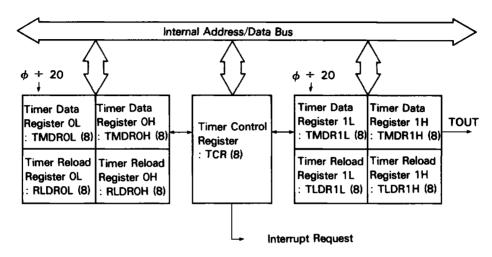


Figure 57 PRT Block Diagram

13.2 PRT Register Description

(1) Timer Data Register (TMDR: I/O Address = CH0: ODH, OCH CH1: 15H, 14H)

PRTO and PRT1 each have 16-bit Timer Data Registers (TMDR). TMDR0 and TMDR1 are each accessed as low and high byte registers (TMDR0H, TMDR0L and TMDR1H, TMDR1L). During RESET, TMDR0 and TMDR1 are set to FFFFH.

TMDR is decremented once every twenty ϕ clocks. When TMDR counts down to 0, it is automatically reloaded with the value contained in the Reload Register (RLDR).

TMDR can be read and written by software using the following procedures. The read procedure uses a PRT internal temporary storage register to return accurate data without requiring the timer to be stopped. The write procedure requires the PRT to be stopped.

For reading (without stopping the timer), TMDR must be read in the order of lower byte — higher byte (TMDRnL, TMDRnH). The lower byte read (TMDRnL) will store the higher byte value in an internal register. The following higher byte read (TMDRnH) will access this internal register. This procedure insures timer data validity by eliminating the problem of potential 16-bit timer updating between each 8-bit read. Specifically, reading TMDR in higher byte — lower byte order may result in invalid data. Note the implications of TMDR higher byte internal storage for applications which may read only the lower and/or higher bytes. In normal operation all TMDR read routines should access both the lower and higher bytes, in that order.

For writing, the TMDR down counting must be inhibited using the TDE (Timer Down Count Enable) bits in the TCR (Timer Control Register), following which any or both higher and lower bytes of TMDR can be freely written (and read) in any order.

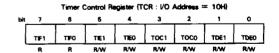
(2) Timer Reload Register (RLDR: I/O Address = CH0: OEH, OFH CH1: 16H, 17H)

PRTO and PRT1 each have 16-bit Timer Reload Registers (RLDR). RLDR0 and RLDR1 are each accessed as low and high byte registers (RLDR0H, RLDR0L and RLDR1H, RLDR1L). During RESET RLDR0 and RLDR1 are set to FFFFH.

When the TMDR counts down to 0, it is automatically reloaded with the contents of RLDR.

(3) Timer Control Register (TCR)

TCR monitors both channels (PRT0, PRT1) TMDR status and controls enabling and disabling of down counting and interrupts as well as controlling the output pin (A_{1e}/TOUT) for PRT 1.



TiF1: Timer Interrupt Flag 1 (bit 7)

When TMDR1 decrements to 0, TIF1 is set to 1. This can generate an interrupt request if enabled by TIE1 = 1. TIF1 is reset to 0 when TCR is read and the higher or lower byte of TMDR1 are read. During RESET, TIF1 is cleared to 0.

TIFO: Timer Interrupt Flag 0 (bit 6)

When TMDR0 decrements to 0, TIF0 is set to 1. This can generate an interrupt request if enabled by TIE0 = 1. TIF0 is reset to 0 when TCR is read and the higher or lower byte of TMDR0 are read. During RESET, TIF0 is cleared to 0.

TIE1: Timer Interrupt Enable 1 (bit 5)

When TIE1 is set to 1, TIF1 = 1 will generate a CPU interrupt request. When TIE1 is reset to 0, the interrupt request is inhibited. During RESET, TIE1 is cleared to 0.

TIEO: Timer Interrupt Enable 0 (bit 4)

When TIE0 is set to 1, TIF0 = 1 will generate a CPU interrupt request. When TIE0 is reset to 0, the interrupt request is inhibited. During RESET, TIE0 is cleared to 0.

TOC1, 0: Timer Output Control (bits 3, 2)

TOC1 and TOC0 control the output of PRT1 using the multip-lexed A₁,/TOUT pin as shown below. During RESET, TOC1 and TOC0 are cleared to 0. This selects the address function for A₁,/TOUT. By programming TOC1 and TOC0, the A₁,/TOUT pin can be forced HIGH, LOW or toggled when TMDR1 decrements to 0.

TOC1	тосо	ОИТРИТ
0	0	Inhibited (A 18/TOUT pin is selected as an address output function.)
0	1	toggled*
1	0	0 (A ₁₈ /TOUT pin is selected as a PRT1 output function.)
1	1	1 J ss s i i i i output function.

 When TMDR1 decrements to 0, TOUT level is reversed. This can provide square wave with 50% duty to external devices without any software support.

TDE1, 0: Timer Down Count Enable (bits 1, 0)

TDE1 and TDE0 enable and disable down counting for TMDR1 and TMDR0 respectively. When TDEn (n = 0, 1) is set to 1, down counting is executed for TMDRn. When TDEn is reset to 0, down counting is stopped and TMDRn can be freely read or written. TDE1 and TDE0 are cleared to 0 during RESET and TMDRn will not decrement until TDEn is set to 1.

Fig. 58 shows timer initialization, count down and reload timing. Fig. 59 shows timer output (A_{1,e}/TOUT) timing.

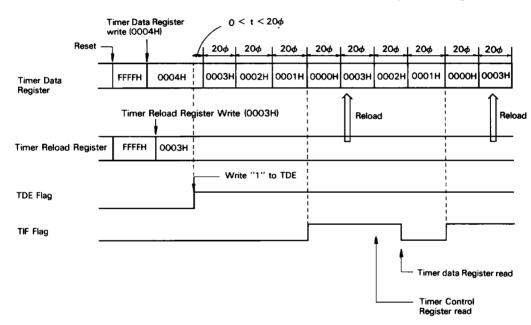


Figure 58 PRT Operation Timing

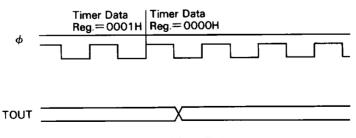


Figure 59 PRT Output Timing



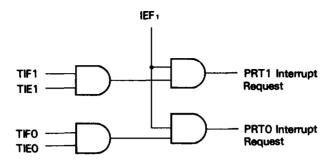


Figure 60 PRT Interrupt Request Circuit Diagram

13.3 PRT Interrupts

The PRT interrupt request circuit is shown in Fig. 60.

13.4 PRT and RESET

During RESET the bits in TCR are initialized as defined in the TCR register description. Down counting is stopped and the TMDR and RLDR registers are initialized to FFFFH. The A₁₈/TOUT pin reverts to the address output function.

13.5 PRT Operation Notes

- (1) TMDR data can be accurately read without stopping down counting by reading the lower (TMDRnL*) and higher (TMDRnH*) bytes in that order. Or, TMDR can be freely read or written by stopping the down counting.
- (2) Care should be taken to insure that a timer reload does not occur during or between lower (RLDRnL*) and higher (RLDRnH*) byte writes. This may be guaranteed by system design/timing or by stopping down counting (with TMDR containing a non-zero value) during the RLDR updating. Similarly, in applications in which TMDR is written at each TMDR overflow, the system/software design should guarantee that RLDR can be updated before the next overflow occurs. Otherwise, time base inaccuracy will occur. NOTE: * n = 0, 1
- (3) During RESET, the multiplexed A₁₀/TOUT pin reverts to the address output.
 - By reprogramming the TOC1 and TOC0 bits, the timer output

function for PRT channel 1 can be selected. The following shows the initial state of the TOUT pin after TOC1 and TOC0 are programmed to select the PRT channel 1 timer output function.

(i) PRT (channel 1) has not counted down to 0.

If the PRT has not counted down to 0 (timed out), the initial state of TOUT depends on the programmed value in TOC1 and TOC0.

TOC1	тосо	TOUT State After Programming TOC1/TOC0	TOUT State After Next Timeout
0	1	HIGH (1)	LOW (0)
1	0	HIGH (1)	LOW (0)
1	1	HIGH (1)	HIGH (1)

(ii)PRT (channel 1) has counted down to 0 at least once. If the PRT has counted down to 0 (timed out) at least once, the initial state of TOUT depends on the number of time outs (even or odd) that have occurred.

Numbers of Timeouts (even or odd)	TOUT State After Programming TOC1/TOC0
Even (2, 4, 6)	HIGH (1)
Odd (1, 3, 5)	LOW (0)

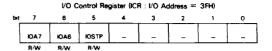
14 INTERNAL I/O REGISTERS

The HD64180 internal I/O Registers occupy 64 I/O addresses (including reserved addresses). These registers access the internal I/O modules (ASCI, CSI/O, PRT) and control functions (DMAC, DRAM refresh, interrupts, wait state generator, MMU and I/O relocation).

To avoid address conflicts with external I/O, the HD64180 internal I/O addresses can be relocated on 64 bytes boundaries within the bottom 256 bytes of the 64k bytes I/O address space.

14.1 I/O Control Register (ICR)

ICR allows relocating of the internal I/O addresses. ICR also controls enabling/disabling of the IOSTOP mode.



IOA7,6: I/O Address Relocation (bits 7-6)

IOA7 and IOA6 relocate internal I/O as shown in Fig. 61. Note that the high-order 8 bits of 16-bit internal I/O addresses are always 0. IOA7 and IOA6 are cleared to 0 during RESET.

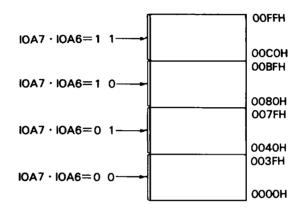


Figure 61 Internal I/O Address Relocation

IOSTP: IOSTOP Mode (bit 5)

IOSTOP mode is enabled when IOSTP is set to 1. Normal I/O operation resumes when IOSTP is reset to 0. IOSTP is cleared to 0 during RESET.

14.2 Internal I/O Registers Address Map

The internal I/O register addresses are shown in Table 14. These addresses are relative to the 64 bytes boundary base address specified in ICR.

Table 14 Internal I/O Register Address Map (1)

	Register	Mnemonic	Add	Address		
	negister	Minemonic	Binary	Hexadecima		
-	ASCI Control Register A Ch 0	CNTLAO	XX000000	00Н		
	ASCI Control Register A Ch 1	CNTLA1	XX000001	01H		
	ASCI Control Register B Ch O	CNTLBO	XX000010	02H		
	ASCI Control Register B Ch 1	CNTLB1	XX000011	озн		
ASCI	ASCI Status Register Ch 0	STAT0	XX000100	04H		
ASCI	ASCI Status Register Ch 1	STAT1	XX000101	05H		
	ASCI Transmit Data Register Ch 0	TDRO	XX000110	06Н		
	ASCI Transmit Data Register Ch 1	TDR1	XX000111	07H		
	ASCI Receive Data Register Ch 0	RDRO	XX001000	08H		
	ASCI Receive Data Register Ch 1	RDR1	XX001001	09Н		
CSI/O	CSI/O Control Register	CNTR	XX001010	OAH		
C31/O	CSI/O Transmit/Receive Data Register	TRDR	XX001011	ОВН		
	Timer Data Register Ch OL	TMDROL	XX001100	осн		
	Timer Data Register Ch OH	TMDROH	XX001101	ODH		
	Reload Register Ch OL	RLDROL	XX001110	OEH		
	Reload Register Ch OH	RLDROH	XX001111	OFH		
	Timer Control Register	TCR	XX010000	10H		
Timer	Reserved		XX010001	11H		
ımer	Į.		5	\		
			XX010011	13H		
	Timer Data Register Ch 1L	TMDR1L	XX010100	14H		
	Timer Data Register Ch 1H	TMDR1H	XX010101	15H		
	Reload Register Ch 1L	RLDR1L	XX010110	16H		
	Reload Register Ch 1H	RLDR1H	XX010111	17H		
	Free Running Counter	FRC	XX011000	18H		
Others	Reserved		XX011001	19H		
Others			<u> </u>	1 5		
			XX011111	1FH		

Table 14 Internal I/O Register Address Map (2)

	Register	Mnemonic	Address		
	register	- Wilelione	Binary	Hexadecimal	
	DMA Source Address Register Ch OL	SAROL	XX100000	20H	
	DMA Source Address Register Ch 0H	SAROH	XX100001	21H	
	DMA Source Address Register Ch 0B	SAROB	XX100010	22H	
	DMA Destination Address Register Ch OL	DAROL	XX100011	23H	
	DMA Destination Address Register Ch OH	DAROH	XX100100	24H	
	DMA Destination Address Register Ch 0B	DAROB	XX100101	25H	
	DMA Byte Count Register Ch OL	BCROL	XX100110	26H	
	DMA Byte Count Register Ch OH	ВСВОН	XX100111	27H	
	DMA Memory Address Register Ch 1L	MAR1L	XX101000	28H	
DMA	DMA Memory Address Register Ch 1H	MAR1H	XX101001	29Н	
	DMA Memory Address Register Ch 18	MAR1B	XX101010	2AH	
	DMA I/O Address Register Ch 1L	IAR1L	XX101011	2BH	
	DMA I/O Address Register Ch 1H	IAR1H	XX101100	2CH	
	Reserved		XX101101	2DH	
	DMA Byte Count Register Ch 1L	BCR1L	XX101110	2EH	
	DMA Byte Count Register Ch 1H	BCR1H	XX101111	2FH	
	DMA Status Register	DSTAT	XX110000	зон	
	DMA Mode Register	DMODE	XX110001	31H	
	DMA/WAIT Control Register	DCNTL	XX110010	32H	
	IL Register (Interrupt Vector Low Register)	IL	XX110011	33Н	
INT	INT/TRAP Control Register	ITC	XX110100	34H	
	Reserved		XX110101	35H	
Defeat	Refresh Control Register	RCR	XX110110	36H	
Refresh	Reserved		XX110111	37H	
	MMU Common Base Register	CBR	XX111000	38H	
MMU	MMU Bank Base Register	BBR	XX111001	39н	
	MMU Common/Bank Area Register	CBAR	XX111010	ЗАН	
	Reserved		XX11,1011	3ВН	
110			}	}	
I/O			XX111110	3ÉH	
	I/O Control Register	ICR	XX111111	3FH	

14.3 I/O Addressing Notes

The internal I/O register addresses are located in the I/O address space from 0000H to 00FFH (16-bit I/O addresses). Thus, to access the internal I/O registers (using I/O instructions), the high-order 8 bits of the 16-bit I/O address must be 0.

The conventional I/O instructions (OUT (m),A/ IN A,(m) / OUTI / INI/ etc.) place the contents of a CPU register on the high-order 8 bits of the address bus, and thus may be difficult to use for accessing internal I/O registers.

For efficient internal I/O register access, a number of new instructions have been added, which force the high-order 8 bits of the 16-bit I/O address to 0. These instructions are INO, OUTO, OTIM,

OTIMR, OTDM, OTDMR and TSTIO (See section 19 Instruction Set).

Note that when writing to an internal I/O register, the same I/O write occurs on the external bus. However, the duplicate external I/O write cycle will exhibit internal I/O write cycle timing. For example, the WAIT input and programmable wait state generator are ignored. Similarly, internal I/O read cycles also cause a duplicate external I/O read cycle — however, the external read data is ignored by the HD64180.

Normally, external I/O addresses should be chosen to avoid overlap with internal I/O addresses to avoid duplicate I/O accesses.

15 E CLOCK OUTPUT TIMING - 6800 TYPE BUS INTER-FACE

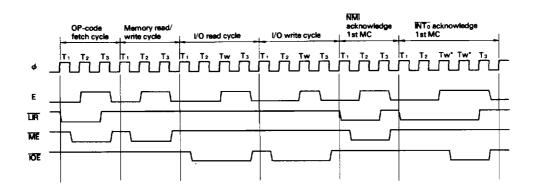
A large selection of 6800 type peripheral devices can be connected to the HD64180, including the Hitachi 6300 CMOS series (6321 PIA, 6350 ACIA, etc.) as well as 6500 family devices.

These devices require connection with the HD64180 synchronous E clock output. The speed (access time) required for the peripheral device are determined by the HD64180 clock rate. Table 15, Fig. 62 and Fig. 63 define E clock output timing.

Table 15 E Clock Timing in Each Condition

Condition	Duration of E	Clock Output "High"
Op-code Fetch Cycle Memory Read/Write Cycle	T2T - T3I	$(1.5\phi + n_w \cdot \phi)$
I/O read Cycle	1st Tw† Tal	$(0.5\phi + n_w \cdot \phi)$
I/O Write Cycle	1st Tw† - Ta†	(n _w · φ)
NMI Acknowledge 1st MC	$T_2 \uparrow - T_3 \downarrow$	(1.5φ)
INTo Acknowledge 1st MC	1st Tw† - Tal	(0.5φ + n _w · φ)
BUS RELEASE mode SLEEP mode SYSTEM STOP mode	φl φl	(2φ or 1φ)

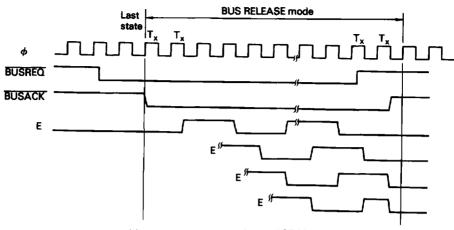
NOTE) n_w : the number _ MC : Machine Cycle : the number of wait states



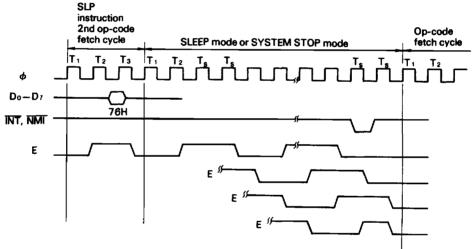
* Two wait states are automatically inserted.

NOTE MC: Machine Cycle

Figure 62 E Clock Timing (During Read/Write Cycle and Interrupt Acknowledge Cycle)



(a) E Clock Timing in BUS RELEASE Mode



(b) E Clock Timing in SLEEP Mode and SYSTEM STOP Mode

Figure 63 E Clock Timing (in BUS RELEASE mode, SLEEP mode, SYSTEM STOP mode)

Wait states inserted in op-code fetch, memory read/write and I/O read/write cycles extend the duration of E clock output HIGH. Note that during I/O read/write cycles with no wait states (only occurs during on-chip I/O register accesses), E will not go HIGH.

The correspondence between the duration of E clock output HIGH and standard peripheral device speed selections is as follows.

Device Speed Selection	Required duration of E clock output HIGH
1.0 MHz (ex: HD6321P)	500 ns min.
1.5 MHz (ex: HD63A21P)	333 ns min.
2.0 MHz (ex: HD63B21P)	230 ns min.

15.1 6800 Type Bus Interfacing Note

When the HD64180 is connected to 6800 type peripheral LSIs with E clock, the 6800 type peripheral LSIs should be located in I/O address space.

If the 6800 type peripheral LSIs are located in memory address space, WR set-up time and WR hold time for E clock won't be guaranteed during memory read/write cycles and 6800 type peripheral LSIs can't be connected correctly.

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16 ON-CHIP CLOCK GENERATOR

The HD64180 contains a crystal oscillator and system clock (ϕ) generator. A crystal can be directly connected or an external clock input can be provided. In either case, the system clock (ϕ) is equal to one-half the input clock. For example, a crystal or external clock

input of 8 MHz corresponds with a system clock rate of $\phi = 4$ MHz

The following table shows the AT cut crystal characteristics (Co, Rs) and the load capacitance (CL1, CL2) required for various frequencies of HD64180 operation.

Table 16 Crystal Characteristics	Table	16	Crystal	Characteristics
----------------------------------	-------	----	---------	-----------------

Clock Frequency	4MHz	4MHz < f ≤ 12MHz	12MHz < f ≤ 16MHz
Co	< 7 pF	< 7 pF	< 7 pF
Rs	<60Ω	<60Ω	<60Ω
CL ₁ , CL ₂	10 to 22 pF ± 10%	10 to 22 pF ± 10%	10 to 22 pF ± 10%

If an external clock input is used instead of a crystal, the waveform (twice the ϕ clock rate) should exhibit a 50% \pm 5% duty cycle. Note that the minimum clock input HIGH voltage level is $V_{CC}-0.6V.$ The external clock input is connected to the EXTAL pin, while the XTAL pin is left open. Fig. 64 shows external clock interface.

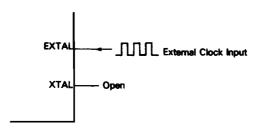


Figure 64 External Clock Interface

Fig. 65 shows the HD64180 clock generator circuit while Fig. 66 and Fig. 67 specify circuit board design rules.

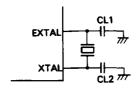


Figure 65 Crystal Interface

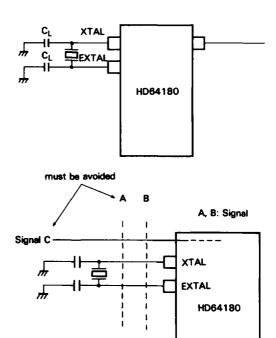


Figure 66 Note for Board Design of the Oscillation Circuit

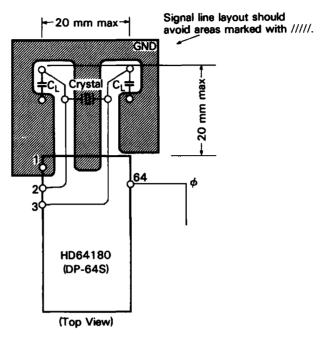


Figure 67 Example of Board Design

Circuit Board design should observe the followings.

- To prevent induced noise, the crystal and load capacitors should be physically located as close to the LSI as possible.
- (2) Signal lines should not run parallel to the clock oscillator inputs. In particular, the clock input circuitry and the system clock φ output should be separated as much as possible.
- (3) Similar to (2), V_{CC} power lines should be separated from the clock oscillator input circuitry.
- (4) Resistivity between XTAL or EXTAL and the other pins should be greater than 10M ohms. Signal line layout should avoid areas marked with ////.

HD64180R/Z

17 MISCELLANEOUS

Free Running Counter (I/O Address = 18H)

Read only 8-bit free running counter without control registers and status registers. The contents of the 8-bit free running counter is counted down by 1 with an interval of 10 ϕ clock cycles. The free running counter continues counting down without being affected by the read operation.

If data is written into the free running counter, we can't guarantee the interval of DRAM refresh cycle and baud rates of ASCI and CSI/O.

In IOSTOP mode, the free running counter continues counting down. It is initialized to FFH during RESET.

18 OPERATION NOTES

18.1 Precaution on Interfacing the Z80° Family Peripheral LSIs to the HD64180

(1) Problem

In daisy chain, the Z80* family peripheral LSI (PIO, DMA, CTC, SIO, or DART) resets interrupt circuit (i.e. IEO changes from LOW to HIGH) by fetching the RETI op-code on the data bus concurrently during the CPU fetches the RETI. Therefore, the followings should be noted for the RETI op-code (EDH, 4DH) fetch timing in the Z80* peripheral LSI.

When the peripheral LSI fetches the first op-code of RET1 (EDH), \overline{LIR} should be negated HIGH at the rising edge of system clock ϕ as shown in Fig. 71, A. (This isn't referred in the manuals for the Z80* peripheral LSI.) So, \overline{LIR} hold time (\overline{LIR} = HIGH) should be required as shown in Fig. 71.

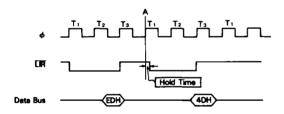


Figure 71 TR Hold Time

Because \overline{LIR} changes synchronously with the rising edge of system clock ϕ , \overline{LIR} delay time is equal to \overline{LIR} hold time of the Z80* peripheral LSI. However, this \overline{LIR} hold time may not be sufficient for the Z80* peripheral LSI in some case and IEO line may not be reset.

(2) An example of countermeasure

Fig. 72 shows an example of circuit, while Fig. 73 shows the LIR and LIR' timing in the circuit.

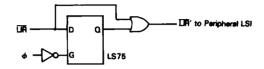


Figure 72 Circuit Example

* Z80 is a registered trademark of Zilog, Inc.

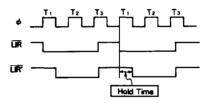


Figure 73 LIR and LIR' Timing in the Circuit

 \overline{LIR} ', which is synchronized with the falling edge of system clock ϕ , is provided to the peripheral LSI. In this case, one-half clock cycle duration is confirmed as the hold time.

Please carefully examine the circuit before you use it on your application.

18.5 Precaution on Interfacing HD64180 with Z80° CTC (1) Problem

The following problem may happen when interfacing HD64180 with Z80° CTC (Z8430). Therefore, countermeasure shown in section 2 should be taken. Fig. 81 illustrates Z80° CTC write timing specified in Z80° CTC Data Sheet. Fig. 82 and Fig. 83 show Z80° 1/O write timing and HD64180 I/O write timing respectively.

As shown above, $\overline{10E}$ in HD64180 goes LOW by a half ϕ clock cycle faster than $\overline{10RQ}$ in Z80. When interfacing Z80 with Z80° CTC, data is written into Z80° CTC at the rising edge of Tw. By contrast, when interfacing HD64180 with Z80° CTC, data is written into Z80° CTC at the rising edge of T_z . In the latter case, data may not be written into Z80° CTC if $\overline{10E}$ set-up time for the rising edge of T_z is less than the set-up time specified in Z80° CTC.

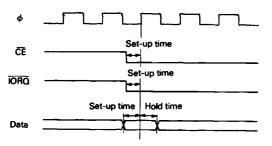


Figure 81 Z80° CTC Write Timing"

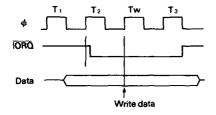


Figure 82 Z80° I/O Write Timing

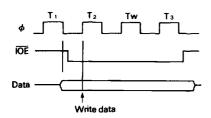
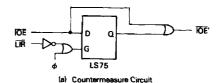


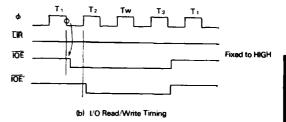
Figure 83 HD64180 I/O Write Timing

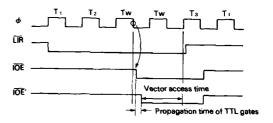
(2) Countermeasure

To Avoid the problem, \overline{IOE} in HD64180 should be asserted LOW at the rising edge of T_z to assure the set-up time specified in Z80° CTC. Fig. 84 (a) shows a circuit for delaying \overline{IOE} by a half ϕ clock cycle

If this circuit is externally connected between HD64180 and Z80° CTC, $\overline{\text{IOE}}$ will be pulled LOW at the rising edge of T_2 only in I/O read/write cycle as shown in Fig. 84 (b). While in $\overline{\text{INT}}_0$ acknowledge cycle, $\overline{\text{IOE}}$ and $\overline{\text{IOE}}$ are asserted LOW at the timing shown in Fig. 84 (c). In $\overline{\text{INT}}_0$ acknowledge cycle, $\overline{\text{IOE}}$ delays because of propagation time of TTL gates of the countermeasure circuit and the vector access time is shortened. If vector access time for HD64180 is not assured during $\overline{\text{INT}}_0$ acknowledge cycle, wait states should be inserted by programming IW10 and IW11 bits of DMA/WAIT Control Register. However, note that wait states insertion by software should be inhibited during Z80° CTC read/write cycles, because more than one wait state can not be allowed in the case of Z80° CTC. (Please see Z80° CTC Data Sheet. One wait state is automatically inserted during the cycles.) Refer to "Fig. 85 Z80° CTC Access Flow" for details.







(c) INTo Acknowledge Cycle Timing

Figure 84 Countermeasure Circuit and Timings in the Circuit

^{*} Z80 is a registered trademark of Zilog, Inc.

^{**} Copied from Z80* CTC Data Sheet (April, 1985)

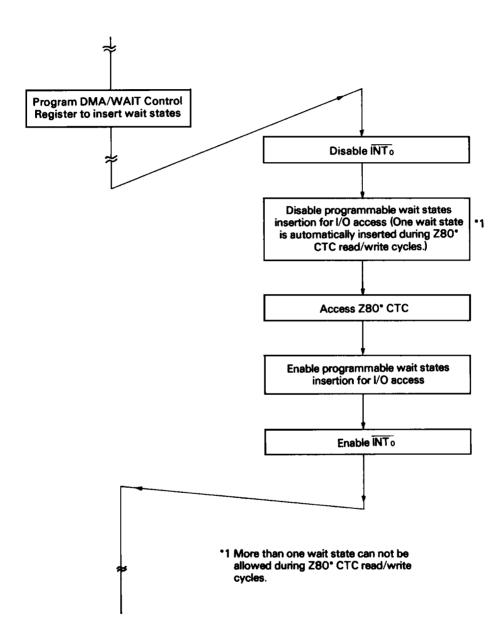


Figure 85 Z80° CTC Access Flow



18.6 Notes on HD64180 INT₀ Mode 0 (1) Problem

In INT₀ Mode 0, the CPU executes an instruction which is placed on the data bus during the interrupt acknowledge cycle. Usually, RST (1-byte instruction) or CALL (3-byte instruction) is placed on the data bus. Then, the CPU pushes the Program Counter (PC) onto the stack and jumps to the interrupt service routine. In the case of RST instruction, the correct return address is pushed onto the stack. However, in the case of CALL instruction, the pushed return address is equal to the correct return address + 2.

(2) Explanation of operation

During the 1st op-code fetch cycle in the interrupt acknowledge

cycle, the CPU stops incrementing the PC. At this time, the PC contains the return address. After the 1st op-code is fetched, the CPU restarts incrementing the PC. Therefore, is RST (1-byte instruction) is executed in the interrupt acknowledge cycle, the correct return address is pushed onto the stack and the CPU can return from the interrupt service routine correctly. While, if CALL (3-byte instruction) is executed in the interrupt acknowledge cycle, the PC is incremented twice during the operand read cycle of the 2 bytes after the 1st op-code is fetched. Therefore, the return address + 2 in the PC is pushed onto the stack. So, when RETI is executed at the end of the interrupt service routine, the CPU can not return from the interrupt correctly.

Fig. 86 shows the CALL execution timing in INT. Mode 0.

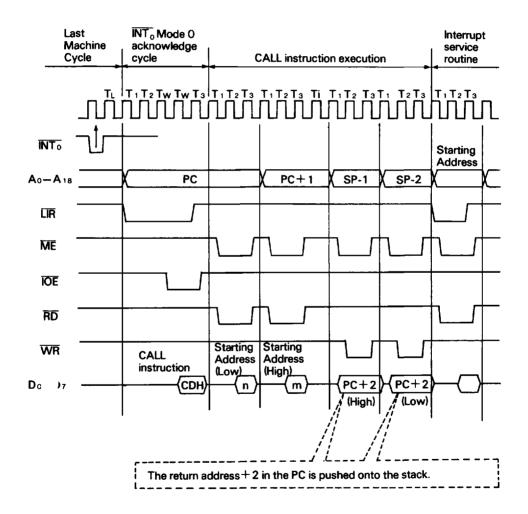


Figure 86 The CALL Execution Timing in INT Mode 0

(3) Countermeasure

The following explains the countermeasure of the problem in $\overline{INT_{\alpha}}$ Mode 0.

(I) RST

When RST is executed, the correct return address in the PC is pushed onto the stack.

(2) CALL

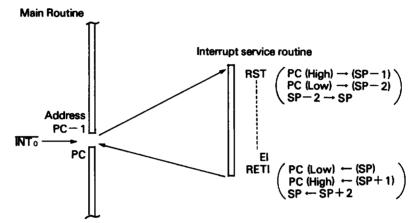
When CALL is executed, the stack contents must be decremented by two in the interrupt service routine to return from the interrupt correctly.

Table 18 summarizes how to adjust the stack contents depending on the instruction to be executed.

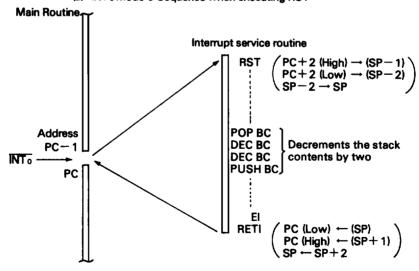
Table 18 Stack Contents Adjustment

Instruction	Stack Contents Adjustment
RST	No
CALL	Decrement the stack contents by two
Other instructions	No (The PC is not stacked.)

The $\overline{INT_0}$ Mode 0 sequences when executing RST and CALL are shown in Fig. 87.



(a) INTo Mode O Sequence when executing RST



(b) INTo Mode O Sequence when executing CALL

NOTE) PC: PC indicates the return address

Figure 87 INT o Mode O Sequence



19 INSTRUCTION SET

19.1 Instruction set overview

The HD64180 is object code compatible with standard 8-bit operating system and application software. The instruction set also contains a number of new instructions to improve system and software performance, reliability and efficiency.

New Instructions	Operation
SLP	Enter SLEEP mode
MLT	8-bit multiply with 16-bit result
IN0 g, (m)	Input contents of immediate I/O address into register
OUTO (m), g	Output register contents to immediate I/O address
OTIM	Block output - increment
OTIMR	Block output - increment and repeat
OTDM	Block output - decrement
OTDMR	Block output - decrement and repeat
TSTIO m	Non-destructive AND, I/O port and accumula- tor
TST g	Non-destructive AND, register and accumula- tor
TST m	Non-destructive AND, immediate data and accumulator
TST (HL)	Non-destructive AND, memory data and accumulator

(1) SLP - Sleep

The SLP instruction causes the HD64180 to enter SLEEP low power consumption mode. See section 5 for a complete description of the SLEEP state.

(2) MLT - Multiply

The MLT performs unsigned multiplication on two 8 bit numbers yielding a 16 bit result. MLT may specify BC, DE, HL or SP

registers. In all cases, the 8-bit operands are loaded into each half of the 16-bit register and the 16-bit result is returned in that register.

(3) INO g, (m) — Input, Immediate I/O address

The contents of immediately specified 8-bit I/O address are input into the specified register. When I/O is accessed, 00H is output in high-order bits of address automatically.

(4) OUTO (m), g - Output, immediate I/O address

The contents of the specified register are output to the immediately specified 8-bit I/O address. When I/O is accessed, 00H is output in high-order bits of address automatically.

(5) OTIM, OTIMR, OTDM, OTDMR - Block I/O

The contents of memory pointed to by HL is output to the I/O address in (C). The memory address (HL) and I/O address (C) are incremented in OTIM and OTIMR and decremented in OTDM and OTDMR respectively. B register is decremented. The OTIMR and OTDMR variants repeat the above sequence until register B is decremented to 0. Since the I/O address (C) is automatically incremented or decremented, these instructions are useful for block I/O (such as HD64180 on-chip I/O) initialization. When I/O is accessed, 00H is output in high-order bits of address automatically.

(6) TSTIO m - Test I/O Port

The contents of the I/O port addressed by C are ANDed with 8-bit immediate data and the status flags are updated. The I/O port contents are not written (non-destructive AND). When I/O is accessed, 00H is output in higher bits of address automatically.

(7) TST g - Test Register

The contents of the specified register are ANDed with the accumulator (A) and the status flags are updated. The accumulator and specified register are not changed (non-destructive AND).

HD64180R/Z

(8) TST m - Test Immediate

The 8-bit immediate data is ANDed with the accumulator (A) and the status flags are updated. The accumulator is not changed (non-destructive AND).

(9) TST (HL) - Test Memory

The contents of memory pointed to by HL are ANDed with the accumulator (A) and the status flags are updated. The memory contents and accumulator are not changed (non-destructive AND).

19.2 Instruction set summary

The followings explain the symbols in instruction set, and the following tables summarize the operation of each instruction.

(1) Register

g, g', ww, xx, yy, and zz specify a register to be used. g and g' specify an 8-bit register. ww, xx, yy, and zz specify a pair of 16-bit registers. The following tables show the correspondence between symbols and registers.

g,g'	Reg.	ww	Reg.	ХX	Reg.	уу	Reg.	ZZ	Reg.
000	В	00	BC	00	BC	00	BC	00	BC
001	С	01	DE	01	DE	01	DE	01	DE
010	D	10	HL	10	IX	10	ΙΥ	10	HL
011	E	11	SP	11	SP	11	SP	11	AF
100	Н	-							
101	L								
111	Α								

NOTE: Suffixed H and L to ww,xx,yy,zz (ex.wwH,IXL) indicate upper and lower 8-bit of the 16-bit register respectively.

(2) Bit

b specifies a bit to be manipulated in the bit manipulation instruction. The following table shows the correspondence between b and bits.

ь	Bit
000	0
001	1
010	2
011	3
100	4
101	5
110	6
111	7

(3) Condition

f specifies the condition in program control instructions. The following shows the correspondence between f and conditions.

ſ	Condition
000	NZ non zero
001	Z zero
010	NC non carry
011	С саггу
100	PO parity odd
101	PE parity even
110	P sign plus
111	M sign minus

(4) Restart Address

v specifies a restart address. The following table shows the correspondence between v and restart addresses.

v	Address
000	00H
001	08H
010	10H
011	18H
100	20H
101	28H
110	30H
111	38H

(6) Flag

The following symbols show the flag conditions.

inot affected
in affected
in affected
in undefined
in set to 1
in the set to 0

(6) Miscellaneous

(

)м data in the memory address data in the I/O address)լ m or n 8-bit data mn 16-bit data 8-bit register 16-bit register b-(a content of bit b in the memory address b-gr a content of bit b in the register gr d or j 8-bit signed displacement source addressing mode D destination addressing mode AND operation OR operation

EXCLUSIVE OR operation

Data Manipulation Instructions

Arithmetic and Logical Instructions (8-bit)

						ddresen									F	leg		
Operation	MINEMONICS	OP-code				UU				Bytes	States	Operation	7	6	4	2	1	0
			MAMED	EXT	NO	REG	REG	IMP	REL				s	Z	н	PΛ	/ N	c
ADO	ADD Ag	10 000 g				s		D		1	4	Ar+gr⊸Ar	1	ī	-	v	R	1
	ADD A. HU	10 000 110					s	D		1	6	Ar+ HUu-A	i	1	ı	٧	A	ı
	ADD A,m	11 000 110	s					D		2	6	Ar+ m⊶Ar	1	1	t	٧	R	t
		< m >																
	ADD A. (DX+d)	11 011 101			s			D		3	14	Ar+ 8X+ dhuAr	ı	1	ī	٧	R	1
		10 000 110	1	,		1	\	}	l			1	ł					
		< a >																
	ADD A 9Y+d	11 111 101		i	S			٥	ı	3	14	Ar + BY + dlm Ar	1	1	1	٧	A	ı
		10 000 110		1				l	1	1			1					
		< d >																
ADC	ADC Ag	10 001 g	Γ			s		٥		1	4	Ar+ gr+ cAr	1	ī	1	~	A	-1
	ADC A. HU	10 001 110					s	0		١ ١	6	Ar+ HLIM+c-A	1	1	1	٧	R	1
	ADC A.m	11 001 110	s					P		2	6	Ar+m+c→Ar	ı	1	1	٧	R	I
		< m >			ļ													
	ADC A (X+d)	11 011 101		l	S	l		٥		3	14	Ar+ BX+ dlu+cAr	1	ı	1	٧	A	1
		10 001 110						1		1								
	ļ	< 0 >		l .				1		(ļ					
	ADC A. (Y+d)	11 111 101		1	s	l	1	D		3	14	Ar+ BY + dlm + c-Ar	1	ī	1	٧	R	į
		10 001 110	1							1			l					
		< d >											┖					
AND	AND g	10 100 g				S		P		١,	•	Ar gr⊶Ar	1	-				
	AND HL)	10 100 110		1			s	P		י ו	6	Ar - (HL) _M Ar	ı					
	AND m	11 100 110	S		i			D		2	6	Ar · mAr	1	1	S	P	R	R
		< m >	ŀ		١.			١.		١.			L.					
	AND EX+d)	11 011 101	ľ	1	s			D		3	14	Ar · IX+dl _M Ar	1	ı	s	P	A	R
		10 100 110		1									l					
		< d >		1									l					
	AND ITY+dl	11 111 101		1	s			D		3	14	Ar IY+dw-Ar	lı.	ı	s	P	A	R
		10 100 110						1					l					
		< d >	1	l				L_	l									
Compere	CP g	10 111 g				s		D		1	4	Ar gr	ī	1		٧	s	1
	CP (HL)	10 111 110					\$	D	ļ	1	6	Ar - OHL)M	1	1	1	٧	s	1
	CP m	11 111 110	s					D	1	2	6	Ar-m	1	1	1	٧	s	1
		< m >								l			l					
	CP (D(+d)	11 011 101		l	s		l	D	l	3	14	Ar ex+ dl _M	1	1	ı	٧	5	I
		10 111 110																
		< d >																
	CP (Y+d)	11 111 101			S			D		3	14	Ar- BY + dly	1	I	1	٧	S	I
	Į.	10 111 110		Į .	l		Į .		i				l			_		
		< d >	_										L	_	_			
COMPLEMENT	CPL	00 101 111						S/D		1	3	Ā ─ A	٠	٠	s	•	S	
DEC	DEC g	00 g 101				\$/0				1	4	gr~ 1—gr	1	1	1	٧	s	
	DEC HU	00 110 101		1	1	l	\$/0		1	ן	10	BALINA - 1-0ALIM	1	ı	1			٠
	DEC 8X+dl	11 011 101		1	S/D	l	1		1	3	18	(EX + dh _M − 1 −	1	ı	1	٧	5	٠
	!	00 110 101								l		®X + d) _M						
	1	< d >		1	1.	l	1		1	l	1	1	1					
	DEC IY+d)	11 111 101		1	\$/D	l	1		1	3	18	0Y+dbu-1~	1	I	1	٧	5	٠
	1	00 110 101		1	1	l	1		1	l	1	fr+dh _u	1					
	ļ	< d >	 	<u> </u>	<u> </u>	⊢	_			—		<u> </u>	L				_	
INC	₽NC g	00 g 100				\$/0		l		1	4	gr+1⊶gr	ı	ı	1	٧	R	٠
	NC HU	00 110 100	1	1	1	l	S/D		1	1	10	OHLI _M +1→BILI _M	1	1		٧		٠
	INC BX+d8	11 011 101	1	1	S/D	l	I	1	1	3	18	ex+di _M +1→	+	1	ı	٧	R	٠
		00 110 100	1			l	I					ex + db _M						
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BIC	INC BY+di	< d >		i .	S/D		İ		1	3	18	8Y + db _m + 1	١.			.,	A	
		00 110 100	ŀ	-	""	l						IV + dl _m	١,	٠	٠	•	_	
		< d >																
MULT	MLT ww	11 101 101 01 ww1 100				S/D				2	17	wwitz x mw/rmwk		•		•		-
MEGATE	NEG	11 101 101	 	-	<u> </u>		├─	S/D	 	2	e	0- AA	+		_		s	_
14.0		01 000 100										U N-N	ľ	ı	•	_	_	•
OR	OR g	10 110 g	١.			s		٥		1	4	Ar+grAr					A	
	OR HL) OR m	10 110 110	s				\$	0		1 2	6	Ar+HU _M Ar				P		
	UM m	< m >	"					"			6	Ar+mAr	l I	ı	н	P	R	R
	OR EX+al	11 011 101			s			٥		١,	14	Ar+EX+dlm-Ar	1	1	R	P	R	R
		10 110 110					ĺ	1					1					
		< d >										Ar+BY+dhuAr	١.				_	A
	OR BY+di	11 111 101			S			D		3	14	N. + H. + OMW.	١'	١	_	•	-	-
		< d >						1										
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	SUB HIL)	10 010 110	1				s	ь		١ ،	6	Ar- BILIM-Ar	1	1	1	٧	s	1
	SUB m	11 010 110	s					D		2	•	Ar-m-Ar	١.	1	I	٧	s	t
	SUBLIX+d1	< m >			s		l			3	14	Ar− (0X ± d) _M -→Ar	١.	1	,	v	s	ı
		10 010 110			,	1		-					ľ	•	٠		Ī	•
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	SUB EY+d	11 111 101	'		s	ŀ		P		3	14	Ar-EY+dim-Ar	ı	t	1	٧	s	1
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SUBC	SBC Ag	10 011 g		 	<u> </u>	5	 	В	\vdash	1	4	Ar-gr-c-Ar	١.	-	-	_	s	_
	SBC A MU	10 011 110	l			-	s	D		1	6	Ar- HUM-c-Ar					S	
	SBC Am	11 011 110	s		[D	[2	6	Ar-m-c-Ar						ı
	SBC A, EX+dl	< m >			s			٥		3	14		١.		_			
	Sac A B G	10 011 110			ľ			١		3	,-	Ar~ 6X + dl _M − c → Ar	1	I	I	٧	S	1
		< d >	l									1						
	SBC A, BY+dl	11 111 101			s			▫		3	14	Ar- fy + dh _M - c - Ar	1	1	ı	٧	s	1
		10 011 110 < d >			ŀ													
TEST	TST g	11 101 101		-		s		\vdash	\vdash	2	7	Ar · gr	ŀ.		_	_	R	_
	-	00 g 100				_					·	~ *	١,	٠	•	•	_	-
	TST (HL)	11 101 101			· '		s			2	10	Ar : BILI _M	ı	1	s	P	A	R
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		< m >						l										
XOR	XOR g	10 101 g				\$		0		1	4	Ar∂igr—Ar	1	ı	R	P	A	A
	XOR HLI XOR m	10 101 110	ا ۱				s	D		1	6	A-B HU _M -A-	ı		R			
	AUF IT	11 101 110 < m >	s					0		2	6	Ar⊕ m⊶Ar	1	1	R	P	R	R
	XOR BX+dl	11 011 101			5			D		3	14	Ar & BX + dlm — Ar	1	ı	R	P	R	R
		10 101 110											ľ	-				
	XOR BY+di	< d >			s			D		9	14	Ar @ 6Y+dbg—Ar	١.			_	_	
		10 101 110									,•	~ an at an ton to w.	۱ ا	1	R	P	R	R
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Rotate and Shift Instructions

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Rotete	RLA	00 010 111						\$/0		1	3	السسب			R		R
and	FL g	11 001 011				S.10				2	7	: 57	1	t	A	P	A
Shift		00 010 g											ı				
Deta	RL HU	11 001 011					S/O			2	13		1	I	R	P	A
	I	00 010 110	!										١.		_	_	_
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		< d >											ı				
		00 010 110											l				
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		00 010 110															
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	RLC g	11 001 011				S/D				2	7	C Property	1	I	R	P	A
		00 000 9															
	RLC HU	11 001 011		1			\$/D	1		2	13		1	I	R	P	R
		00 000 110			١				1		19		١.		_	_	_
	RLC EX+dI	11 011 101			S/D					^	19		וי	1	R	•	R
		< d >															
	i	00 000 110					i										
	ALC BY+d)	11 111 101			 5/D					4	19		١.	1	R	P	R
	1,200	11 001 011			""		1						١.	•			
		< d >															
		00 000 110										·					
	RLD	11 101 101						S/0		2	16		1	1	R	P	A
		01 101 111										7 € 1 7 7 **					
	RRA	00 011 111						S/D		,	3		١.		R		
	RA g	11 001 011				S/D		3,0		2	7	dimin 6		1		P	R
		00 011 g				**				`			١.	١	"	•	**
	RR (HL)	11 001 011					S/D			2	13	ļ	١,	ı	R	P	R
		00 011 110											ľ	•			
	RIP (DX + d)	11 011 101			S/D					4	19		1	1	R	P	R
		11 001 011			ļ		İ	l									
		< d >															
		00 011 110															
	RIR (gY+d)	11 111 101			S/D			1		4	19		1	ı	R	P	R
		11 001 011								1							
		< d >						l									
	RRCA	00 011 110						S./D		١,	3				_		_
	RRC g	11 001 011				S./D		5.0		2	7	o Carrer of	l:		A	P	R
	ranc g	00 001 g				5.0				1	'		1	ı	н	۲	R
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	14.0 2.0	00 001 110		ľ					ŀ	•			١,	٠		ſ	"
	RAC (X+d)	11 011 101			S-D					4	19		١,	ŧ	R	₽	R
		11 001 011											Ι΄.	•			
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0						ddressr	10								F	-		
Operation	MINEMONICS	OP-code					•			Bytee	States	Operation	7	6	4	2		0
			MMED	EXT	ND.	REG	REGI	MP	REL		1		s	Z	н	P	v N	v C
Rotate	RRD	11 101 101						S/D		2	16	;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;	1	ī	P	P	F	1
end	1	01 100 111										TITTE HUM						
Shift	SLA g	11 001 011				S-10				2	,		1	1	A	P	F	9 [
Deta		00 100 g					İ					û-üı <u>ııı</u> ııı						
	SLA OHLI	11 001 011			ļ		\$.1D	ļ	ĺ	2	13	ļ	1	1	A	P	F	۹ ۱
	l	00 100 110		ĺ	ŀ		1					1						
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	SRA g	11 001 011				S/D				2	7	dininiñ-o	ı	1	A	P	R	1
		00 101 g										9,111,112,2						
	SRA HL)	11 001 011		ļ	ļ		SD			2	13		:	1	R	P	P	1
		00 101 110																
	SRA (X+d)	11 011 101			S/D	1				4	19		ı	1	R	P	A	1
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	SRA (TY+d)	11 117 101	1		S/O					4	19		i	1	R	P	R	1
	i	11 001 011																
	ł	< 0 >	l	ĺ														
	l	00 101 110				١						المييسيت			_	_	_	
	SRLg	11 001 011				S/D				2	7	·-timmil-ti	ı	ı	R	P	ĸ	1
		00 111 0				l												
	SAL PLU	11 001 011					S/D			2	13	•-timmfi-6		1				,
	ì	00 111 110								_	,,,	!	•	,	"	٠		
	SRL EX+d)	11 011 101			s.ro					۱ ،	19			,				
		11 001 011											٠	٠		•	^	,
		< d >																
		00 111 110		İ														
	SAL (Y+d)	11 111 101			S/D					4	19		,	1	R	Р		1
		11 001 011											•	•	.,	•	^	•
		< d >																
		00 111 110		li														

Bit Manipulation Instructions

Description (Name of Processing Contents of the process of the p																R	bg.		
Bet Set Set Day 11 001 011 11 001 011 11 010 101 11 010 101 1 01	I	MINEMONICS	OP-code			^	ddresen	9			Bytes	States	Operation	7	6	4	2	1	0
SET by 1100 011 110	neme			IMMED	EXT	NO	REG	REGI	MP	REL				5	Z	н	PΛ	N	С
SET b. M-L	Bet Set	SET b.g	11 001 011				5/D				2	,	1—b · gr			-		-	
SET b, BX+ds	Ì		116 9									1							
SET b, BX+d		SET b, MLI	11 001 011					S/D			2	13	1 b - #KJu	ŀ	•	•	•		
Set 11 (00 011	ŀ		11 6 110			1					·	1							
SET b. BY+d 11 101 110		SET b, IDX+dl	11 011 101			S/D					4	19	1b-¢X+dN _u	ŀ	•		٠		•
SET b. BY+dl			11 001 011		l	İ													
SET b, BY+dl	l		< d >																
11 001 011			11 в 110											1					
Solution Solution	1	SET b. BY+dI	11 111 101	1	١	S/D	١ ١	١ ١	۱ ۱	1	١ ٠	19	1 → b · 8Y + de _M	1	•	•	•	•	•
Bit Reset	Į.					l				l	l								
Bit Peest RES b, Bit 11 001 011 10 b 0 0 0 0 0 0 0 0 0	1		< d >	1		l				l	l								
Bit Resp.	l .	L	11 6 110	<u></u>										L	_	_		_	
ReS b, MLJ	Bit Peset	RES b.g	11 001 013				5/D				2	,	O—b∵gr	1	٠	٠	•		
10 b 110 110			10 b g			ł					l								
RES b, 8X+d		RES b. HL)	11 001 011					S/D			2	13	O	1	٠	•	٠	•	•
Bit Test Bit Dig 11 001 011	L		10 b 110	i i	l						i			1					
RES b, 8Y+d 11 111 101		RES b, (DX + d)	11 011 101	1	1	\$/D					4	19	0b·liX+di _M	1.		•			•
NeS b, 8Y+d 11 111 101 11 100 011			11 001 011	l	1									1					
RES b, 8Y+d 11 111 101	h h		< d >		1									1					
11 001 011			10 Ь 110	Į.	1	l l	l	Į.	Į.	l	l	ļ	ļ	1					
C d S 10 b 110 S 2 6 b · g · z X S X R S X S X R S X S X R S X S X S X S X R S X		PRES b, (IV+d)	11 111 101			\$/0			1		4	19	0b·lY+dM	.	•	•			•
Bit Teat		1	11 001 011			1			l l										
Bit Test Bit Dig 11 001 011 01 D D D D D D D D D D D D D			< d >	ł			1	l		ŀ	1	1							
01b g 8ff b, Ma) 11 001 011 01b 110 01b 110 01f b, EX+ad 11 011 101 11 001 011 <		ì	10 ь 110				ļ	ļ	Į	١.	L	l							
8ff b. MAJ 11 001 011 01	Brt Test	BIT b.g	11 001 011	1	T	1	S			1	2	6	6 g-1	×	ı	8	,		
01 b 110 S 4 16		Ì	01 в р									1	1						
8fT b, 8X+dd 11 011 101		BIT IS. BHL)	11 001 011	Ì				s			2	9	b MLm-z	×	t	S	,		٠.
11 001 011 < d > 01 b 110 BIT b, BY+dd 11 111 101 11 001 011 < d > 4 15 b⋅BY+dd = x 1 S X R ·		1	01 6 110	1															
		BIT b. EX+dI	11 011 101	1	}	S		1			4	15	0 0X+06z	×	t	s)		·
BRT b. 8Y+dd 11 111 101 S 4 15 5-4V+dQz X 1 S X R · 1 100 1011 < d >	1	1	11 001 011	ì	1		1	1	ì	l	1	1	1	1					
BIT b, BY+dd 11 111 101 S 4 15 5 4 4 15 5 4 4 4 5 5 4 5 4 5 6 5 4 5 6 5 4 5 6 5 6		1	< d >			1	1	1		1	1								
11 001 011 < d >	1		01 Б 110	1	1		1	1	1	1	1	1	1	1					
< d >	1	BIT b. EY+dl	11 111 101	1		s			1	1	4	15	P - \$4 + 90 1	×	1	S	•		
			11 001 011	1					1		1								
1 01 6 710		i	< d >	1		1			i		1								
			01 6 110	1		1					1								

Arithmetic Instructions (16-bit)

												1			FI	•9		
Operation	MINEMONICS	OP-code			•	ddrass	*9			Bytes	States	Operation	7	6	4	2	1	٥
neme			MMED	EXT	ND	REG	REGI	MP	REL	1			5	z	н	P/V	N	С
A00	ADD HLww	00 ww1 001				s		0		1	,	HLg+wwg-HLg	[-		x		R	╗
	ADD IX.xx	11 011 101				s		D		2	10	DC _R +xx _R DC _R	١.		x		R	1
		00 xk1 001				ł						ł						
	ADD IY.YY	11 111 101			1	s		D		2	10	IYR+vyn-IYR	·		X	٠	R	t
		00 yy1 001																
ADC	ADC HLww	11 101 101				s		D		2	10	HLa+ wwa+ c-HLa	ı	ı	x	٧	R	1
		01 ww 1 010							l									
DEC	DEC ww	00 ww1 011				S/D				1	4	wwn-1-ww						
	DEC 0X	11 011 101						S/D		2	7	IX _R -1-IX _R					٠	
		00 101 011			İ							Ï						
	DEC IY	11 111 101						S./D		2	7	fY _R − 1 → fY _R				٠	٠	-
		00 101 011																
NC	INC ww	00 ww0 011				S/D				1	4	wwx+1-wwx				-		
	INC IX	11 011 101		l		ŀ		S/D	l	2	7	DCR+1-DCR	-					-
		00 100 011																
	INC IY	11 111 101						\$70		2	,	IYR+1-IYR	·		٠		•	٠
		00 100 011	L															
SBC	SBC HLww	11 101 101	_			S		D		2	10	Hin-wwn-c-Hin	1	1	X	٧	5	1
	1	01 ww0 010		•		l			l	ì	ļ		1					

Data Transfer Instructions

8-Bit Load

						ddresen										Re	0		
Operation	MHEMONICS	OP-code								Dyna.	States	Operation	⊢	_	-	_			0
	<u> </u>	<u> </u>	MMED	EXT	140	REG	REGI	MP	REL				8	Z		H	PN	N	С
Load	LO AJ	11 101 101					ļ	S/O	i	2	6	tAr	1	ı		R	EF:	R	٠
8-bit		01 010 111			1	ļ	1		l				- 1						
Dets	LD A.R	11 101 101		ŀ				\$/0	1	2	6	RrAr	ı	ì		R	EF;	R	٠
		01 011 111	Į.					ļ					1						
	LD A, BC	00 001 010	į	ļ]		s	٥	•	1	6	(BC) _U Ar	1.	•		•	•	•	٠
	LD A, EDE)	00 011 010			1	1	S	٥		1	6	(DE) _M —Ar	·	•		•	•	-	•
	LD A, Immi	00 111 010		s	l	l		P		3	12	imni _M Ar	١.	•		•	•	•	•
	ł	< n >	ŀ	1		l	l	l			1	-							
		< m >				l	Į .	\	ļ	١. ا			- 1						
	ID IA	11 101 101	l	1	1	1	1	S/D	1	2	6	A	Ι.			•	•	•	٠
		01 000 111	1		1	l		١		١. ا	_								
	LD R.A	11 101 101		•		l		S/D	i	2	6	Aı→Rı	١.	•		•		•	•
		01 001 111							l										
	LD (BC),A	00 000 010	1			1	٥	S	1	١ '	7	Ar (BC) _M	1.	•		•	•	•	•
	A,(90) (J.)	00 010 010		ļ			٥	s		1.	7	Ar(DE) _M	1.	•		•	•		
	LD (mn).A	00 110 010		D				s		3	13	Ar Imniu	Ι.	•		•	•	•	•
		< n >	l		1	1	1	1		1									
		< m >		į	1	١				١.									
	ரு தே	01 g g'	1			S/D	Ι.			1	4	9r'9r	1.	•		•	٠		•
	முச் அர	01 g 110	Į		ì	٥	s		l	1	6	HU _M →gr	Ι.	•		•	•		•
	LD 9vm	00 g 110	s	1		٩		i	l	2	6	m—gr	١.	•		•	•	•	•
		< m >	l	l	l .	١.	i .	l		1 .	١	l	ı						
	⊓D g. BX+dl	11 011 101	1	l	s	٥	Į.	l	1	3	14	ex+d _M gr	- [•			
	Į.	01 g 110		l	1	l		1		1	l								
	Į.	< d >		1	Ι.	١.	ļ			1 -	l	i							
	LDg. ¶Y+di	11 111 101	ļ		s	٥	1			3	14	lY+dN—gr	Ι.		•	•	•	•	•
ļ		01 g 110		1	1	1					1	1							
		< 0 >	١.			Ì	١.			1.	l .								
ĺ	LD ML),m	00 110 110 < m >	s	1		ľ	P		1	2	•	m-MM	- 1		•	•	•	•	
		1	١.	Ì		l			1	1.	١								
	LD (DX+d),m	00 110 110	5		١٣			Į.	1	١ ٠	15	m—EX+dbu	- 1.		•	•	•		
l	1	< d >			i		l				l.								
l		\	1			1				!			-						
	LD (1Y+d),m	11 111 101	١.		٦		ļ	1		1.	16								
	W IV+dl,m	00 110 110	S	ļ .	I۳		1	1		*	'*	m → 6Y + cl) _m	- 1 -		•	•	•	•	
		< 4 >		1	1						1								
I		\ \ m >		1	ı					1	1	1							
]	10 ML	01 110 g		1	1	s	١.			١,	,	g-14),							
	TO 6K+d/d	11 011 101		1	١,	5	"			'3	15	gr—tetu	Ι.			•	•		•
l	- W- a.a.	01 110 9		l	"	*				"	'"	B-SY-OW	Ι.		•	•	•		•
	1	< d >		1			1	1		1									
ļ	LD 8Y+d0.g	11 111 101		1		s	1			,	15	p-17+a.							
	1.50 W. T GAR	01 110 9		1	1	"	l	1		*	'"	B-11-000	Ι.		•	•	•	•	•
		< d >		1	1	1	1	1	ĺ		1								
		1 " -		1		1					l						_		

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16-Bit Load

		ì				ddressin	_						L			Jag		_
Operation	MHEMONICS	OP-code	IMMED	EXT	IND	REG	REGI	IMP	REL	Bytes	States	Operation	-	e z	_			
	 	+		- E	 ~	-			762.2	3	9		Ť.	-	_		_	
ed	LD www.mm	00 ww0 001	s			P					,	Ultward	1	•	·			
8-bit		< n >																
ata		< m >	_					ь		۱ ، ا	12	~	١.					
	LD IX. min	11 011 101	s					ן י		*	12	mnDQ	Ι΄.	•	•	•		
	1	00 100 001								l i								
		< n >					l						ı					
		< m >																
	LD-IY, min	11 111 101	S				ı	D		4	12	mn—IYe	1.	•				
	1	00 100 001					1	1		li		\						
	1	< n >	ļ	ļ	l				l									
	1	< m >																
	LD SP, HL	11 111 001						S/0		1	4	HL _R -SP _R	1.	•	٠			•
	LD SP. IX	11 011 101					1	S/D		2	7	iX ₄ →5P ₄	-		٠	-		
	1	11 111 001	ļ	ļ		l	l		l				L					
	LD SP. IY	11 111 101		ļ				S/D		2	7	IY _R →SP _R	1.					
	1	11 111 001	1	ļ									ı					
	LD www. (mm)	11 101 101	1	s		0				4	18	lmn+1l _M →wwttr	- [-					
		01 ww1 011		1		1	1	١		\ '		(mnl _M wwLr	1					
		< n >		ļ				l										
		< m >						Ì										
	LD HL imni	00 101 010		s			l	ь	١	3	15	(mn+1lm-Hr	1.					
		< n >	ì i	1]	1	1	ì	1)		(mnler-Lr						
		< m >			i			İ		1		_ _						
	LD PC (mn)	11 011 101		s				l	l	4	18	(mn+1) _M →D(Hr	- [.					
	LD 50, MINE	00 101 010		ľ				-		'	_	(mni _{be} →tXLr						
	1	< n >	1	1	ì			ì	1	ì '		, .						
		< m >							ĺ	l								
		` " ′					l		Į	l								
	LD IV. (mn)	11 111 101	1	s	l	l		0	1] 4	18	(mn+1) _M →fYHr	1.					
		00 101 010			ĺ	ĺ						Imni _M IYLr						
		< n >				Ī						1 -	ł					
		< m >			1					1		1						
	LD (mn),ww	11 101 101	1	ь	}	5	1	1	1	۱ ۵	19	wwwtrimn+1he	1.					
		01 ww0 011						i		1		water-trong						
		< n >			1			ı	ĺ									
		< m >			1	i												
	LD Imri.HL	00 100 010	1	0	1	1		s		3	16	Hr	١.					
		< 0.2		-				"		"	"	j						
	1	< m >			1		1	1				Lr (mnhu						
	1,5,5,3,8	1		۵				s		١.	19	l	l					
	LD (mn), IX	11 011 101		1 "	1	1	1	"	1	•	\	IXHImn+1) _M		•				•
		00 100 010		1				1				XLr→ lmnl _M						
	1	< n >		1		1		1	1		İ							
	l	< m >		1	l	1		Ι.		1	Ι.		- [
	LD (mn), IY	11 111 101	1	P	1			s	1	4	19	MHr—Imn+1) _M	1.					•
		00 100 010	1		1				1	1		IYL, imni _{lu}						
		< n >		1	1	1	1	i		1		1	- [
	1	< m >	1	1	1	1	1	1	1	1	1		- 1					

Block Transfer

			i			ddressin	_						L		١	Flag		
Operation	MNEMONICS	OP-code					•			Bytes	States	Operation	7	6	4	2		1
			IMMED	EXT	ND	REG	REGI	MP	REL				8	Z	н	P/	٠ :	N
Block					l									2		0		
Transfer	CPD	11 101 101					s	s		2	12	Ar (HL) _M	11	1	1	1		5
Search		10 101 001										8C _R - 1 BC _R	1	_		_		
Data							_	_		1.1		HLR-1-HLR	1.	2		G		_
	CPDR	10 111 001					s	5		2	14 12	BCn≠0 Ar≠HLlu	Ιı	1	1	1		5
		10 111 001									12	BCa=0 or Ar=(HL) _M						
												Q BCa - 1-BCa						
												LHIR-1-HIR						
	ì		l		l	1		ì	1	l '		Repeat Q until	١.					
					ı							Ar=94U _{br} or BCa=0	ı	@		G		
	CPI	11 101 101			1		s	s		2	12	Ar- HUL	١.	1		_		
	Cn	10 100 001								'	'4	BCa-1-BCa	Ι,	٠	•	'		3
		10 100 001		1								HLa+1HLa	ı	•		c	`	
	CPIR	11 101 101			l		s	s	l	, ,	14	BCa+0 A/FHLM	1	9	1	١ ١		5
	1	10 110 001	ì	i	1	l	ľ		1	1 1	12	BC _R =0 or Ar≠ PLl _M	1					
		1011001				ļ					' <u>-</u>	A-HL	1					
	1											Q 8C _R -18C _R	1					
								ļ			İ	LHER+1→HER	1					
											İ	Repeat Q until	1					
	1											Ar≖ HLi _M or BC _R = 0	1			0	0	
	100	11 101 101	l	l		L	S/D	ļ	l	2	12	HLM-DEM	ŀ	٠	8	۱ ۱		R
		10 101 000		1	ļ		1	l	ļ.			BC _R 1BC _R	l					
	\		1	l					i i			DE _R 1DE _R	1					
		1		l	l		ŀ		l			HLa-1-HLa	1					
	LDDR	11 101 101	1	l			S/D	1		2	14(BC _R #0)	FHU _M →DEl _M	ŀ	٠	•	•	•	R
		10 111 000	1	l				1			12(BC _R =0)	Q 9Cg 18Cg	1					
				1				ł				06 _R 106 _R	1					
	1	1	1	ļ	l	l	l l	1	Į.			LHLe-1→HLe	1					
							l					Repeat Ct until						
						1						BC _R =0					D	
	LON	11 101 101					S/O			2	12	HUM-DOM	1.	•	•	•	ı	R
		10 100 000		1		l						BC _R -1→BC _R	1					
				ŀ		l						D6 _R +1O6 _R	1					
					i .	l			Ì	ł		Hig+1—Hig	Н					
	LDE	11 101 101	1	į.	١	١	S/D	1	1	2	14(BC _R #0)	HU _M DE _M	1.	•	,	•	•	R
	1	10 110 000					1				12@C _R =0)	0 BC _R -1-BC _R	ı					
	1	1		1]		1	1				DE _R +1→DE _R	ı					
	1	1		l				1				LHLa+1→Hta						
		1	1	1	1	1	1	l		1	l	Repeat Q until	1					

① P/V=0 BCR-1=0 P/V=1 BCR-1≠0 ② Z=1: Ar=#UM Z=0 . Ar##UM

HD64180R/Z

Stack and Exchange

						ddressr	_						-		F	,ee		
Operation	MINEMONICS	OP-code				CONTRACT	•			Bytes	States	Operation	7	6	4	2	1	
			MMED	EXT	MD	REG	REG	MP	REL				s	z	н	PΛ	N	
rush	PUSH zz	11 zzO 101				s		D		1	11	zzLr→(SP – 2l _{bd}	T					
												zzHr(SP 1) _M						
												SPR-2-SPR						
	PUSH IX	11 011 101						S/0		2	14	IXLr→ISP - 2) _M	1.				٠	
		11 100 101										IXHr(SP-1) _M						
												SPa 2SPa						
	PUSH IY	11 111 101						S/D		2	14	IYU ISP ~ 2lm	- -		٠			
		11 100 101				l						IYHr (SP - 1)M						
	1	L							L			SPn-2-SPn	- 1					
POP	POP zz	11 zz0 001				В		s		1	9	(SP+1) _M -zz++	7.			_	_	_
		1										(SP) _M →zzLr						
												SPR+2→SPR						
	POP IX	11 011 101						S/D	ľ	2	12	(SP+1) _M -D(Hr	- -					
	1	11 100 001										(SP) _M DKLr						
	1	1										SPa+2-SPa						
	POP IY	11 111 101					1	5/0		2	12	ISP + 1) HI IYHr	-					
		11 100 001				1	1					ISP) _M →fYLr						
		1										SPR+2→SPR	- 1					
xchange	EX AF,AF	00 001 000						\$/0		1	4	AFRAFR'	1.				-	_
	EX DE,HL	11 101 011	l					S/D	Į.	1	3	DER-HLR	- [-					
	EXX	11 011 001						5/0		1	3	BC4-BC4	- 1 -					
												DERDEA						
							l					HLA-HLA						
	EX (SP),HL	11 100 011					[S/D		1	16	Hr(SP+1ha	- [-					
										ļ l		U-SPIM						
	EX (SP),IX	11 011 101					1	\$/0	l	2	19	IXHr (SP+ 1lm	- [-					
		11 100 011							ĺ			IXL/ ISPIN	-1					
	EX (SPIJY	11 111 101					ĺ	S/D	•	2	19	M+ (SP+1)M	.			,		
	1	11 100 011	1			l						IYLr (SP)	- 1					

Program Control Instructions

					_		_						L		A	9		
Operation	MNEMONICS	GP-code	L.		^	ddressin	•			Syles.	States	Operation	7	6	4	2	,	
		ì	IMMED	£ΧΤ	MD.	REG	REGI	MP	MEL				s	Z	н	PΛ		
Cell	CALL mn	11 001 101		D						3	16	PCHr→(SP-1) _M						
		< n >										PCLr—(SP - 2l _M						
		< m >	1									mnPC ₆	ı					
		l										SPR-2-SP _R	1					
	CALL f, mn	11 / 100		D	1					3	G(f : false)	continue:f is teles	-		•	٠		
		< n >									18# · trust	CALL mnf is line	İ					
		< m >																
				L									L					
tump .	DJNZ j	00 010 000							D	2	9 (Br#0)		T			-		_
		< j-2 >								2	7 Bar=0							
												8r- 1-8r	1					
		1		ĺ				1				continue:8r=0	1					
		1					ĺ	1				PC _R +jPC _R #r≠0	1					
	JP t, mn	11 / 010	ł	١,			l] 3	6 (f fates)		1.	٠	٠	٠		
	,	< n >		-			1		ı	3	9 (f true)							
		< m >			•				1			mm→PC _R :f is true						
		1						1	1			continue:f is false						
		1				l							1					
		1				1												
	JP mn	11 000 011		0		1			1	3	9	mn—PC _R	1.					
		< n >				1						1						
		< m >																
	JP #4D	11 101 001		.		1	D		•	1	3	HLa-PCa	١.					
	JP (DC)	11 011 101	1	l		1	D	Ì		2	6	DC _R —PC _R	- 1					
		11 101 001	1	1		1				ļ	1		1					
	JP IM	11 111 101	1	1		l	0	ł		2		MRPCR	-					
		11 101 001	1	ĺ		İ	ĺ	ĺ	1		ĺ							
	JR j	00 011 000	1	l	l	1			P	2	8	PCR+ jPCR	ŀ	٠	٠	٠	•	
		< +2 >	1	1		1		l l					1					
	JR C ₄	00 111 000	1	1		1	ļ	l	P	2		continue: C=0	1.	•	•	٠	•	
		< +2 >				l		ı		2	8	PC _R +j→PC _R . C=1	ŀ					
	1							1	١,	١.			ı					
	JR NC _d	00 110 000			l		l	1	١٣	2 2	6 8	continue: C≠1	1		•	٠	•	
		< j-2 >	1		1	1	ŀ	1		'		PCa+jPCa C=0	1					
	JR Z ₄	00 101 000	1							2		continue: Z≈0	١.					
	***	< +2 >							ľ	2	•	PCn+r-PCn. Z=1						
		" -						1	l	•	•	rogry rog. z=1						
	JR NZ ₄	00 100 000						1	٥	2	ه ا	continue. Z≈ 1	١.					
		< r2 >			ļ				1	2	•	PCn+j-PCn: Z=0						
		· .			<u> </u>				└			.,			_			
Resum	RET	11 001 001	1					١,		,		ISPN _M PCLr	١.					
PROPERTY	[~]	1	1		1			-		,	•	(SP+1) _{kt} →PCHr						
			1									SPa+2-SPa						
	REY f	11 / 000			1			0		1	5ff fairei	continue:f is false	١.					
	l '			1	1	ŀ		1	I	1	10(f true)	RET: f is true						
	1			1	1	l	[1	I	l	1	ŀ						
	RETI	11 101 101					1	D	l	2	12	(SP) _M PCLr		,				
	1	01 001 101		1	1	l	l	1	1	1		(SP+ 1) _M →PCHr						
	l	1	1	1	1	1	l	1	1	1		SPR+2-SPR	1					
	RETN	11 101 101		1	1	l	l	0	1	2	12	(SPI _M —PCLr	[.					
	"~"	01 000 101	1					1		1		(SP+ 1) _M PCHr	-					
					1			1		1								
	1			l	1		I	į.				SPn+2-SPn						
	ļ											SPn+2→SPn IEF2→IEF1						



HD64180R/Z

Operation	MNEMONICS	OP-code			,	ddresein	9			Bytes	States	Operation	,	6	_	2	,	0
néme			IMMED	EXT	ND	REG	REGI	MP	REL.				s	z	н	P/V	N	С
Restart	RST v	11 v 111						D		1	11	PCHr-ISP-1h _M PCLr-ISP-2h _M 0-PCHr v-PCLr SP _R -2-SP _R		•	-	•	-	

I/O Instructions

Operation	MNEMONICS	OP-code		-	,	ddressir	•									Fleg		
neme	MINEMONICS	UP-0000	MANED	EXT	ND.	REG	REGI	BMP	10	Bytes	States	Operation	⊢	-		_		0 1 C
INPUT	IN A.(m)	11 011 011						D	s	2	9	(Am);—Ar	⊢	_	_	_		
		< m >										m-A ₀ -A ₁						
	N g.(C)	11 101 101				.			s	2	_	A-As~As	١.		_			
	e g.c.	01 0 000				ן "			,	2	9	(BC),⊷gr g=110 Only the	١'	1	R	•		•
												Regs will						
												change.						
		Į.							1			Cr→Ao ~A?	ĺ					
												BAs~As						
	INO g.(m)	11 101 101				P			\$	3	12	100mi _r ⊶gr	1	1	R	P	R	
	}	00 g 000										g=110 Only the						
		< m >	1 1									flegs will	ŀ					
									1			change. m—A₀~A₂						
								i				M→A0~A7 00→A6~A13		3			•	,
	IND	11 101 101	l i				0		s	2	12	(BCI _I —BHL) _M		_		¥	_	, ×
		10 101 010										HLa-1-HLa	_	•			•	•
1	1											Br- 1-Br						
1												Cr An A1						
												Br—Az~Aı,					(
l	NOR	11 101 101					D	١.,	S	2	1466r≠0}	FBC); €4L) _M	×	s	×	Х	t	×
		10 111 010	:			1					12 0 r=0	Q Han-1→Han						
i I			1									_Br−1Br Repect Quest						ı
						ı						Neperture Br=0						ļ
												Cr-Ao-Ar						ļ
l i						- 1						Br-A4~A15						
						- 1	i							3			•	,
[PA .	11 101 101			' I		D		5	2	12	@Cl—HUM		_		×		×
()		10 100 010				J		ļ		J		HLa+1→HLa						ļ
]								Br — 1 → Br						ļ
	ľ					ı						Cr→Ao~Ar					_	
	NA.	11 101 101			ľ		۰	l	s	2	14 8 r≠0	BAsAss		_			•	
		10 110 010					۱		•	-	14(8r=0)	GCh→HLbs Ci HLs+1—HLs	×	\$	X	X	1	X
												Gr-1→Br						
												Repeat Q until						ļ
					J	J		J				Br=0						J
ˈ <u> </u>				- 1			- 1		ļ			Cr-A ₀ A ₇						ŀ
L					i	[Br-As-Ais						

(to be continued)

3 Z=1:8-1=0 Z=0:8-1#0

N=0 MSB of Data=0

Operation	MINEMONICS	OP-code			,	ddresse	9			Bytes	States	Operation	7 6		9 2	<u> </u>	٥
neme			IMMED	EXT	1ND	REG	REGI	MP	10				S 2	н	PN	N	С
OUTPUT	OUT IMI.A	11 010 011 < m >						S	٥	2	10	Ar(Am) ₁ mAoAr ArAsAs			•		
	OUT ICI.g	11 101 101 01 g 001				s			D	2	10	gr—(BC) ₁ Cr—A ₀ ~A ₇		-			
	OUTO (m).g	11 101 101 00 g 001				s			D	3	13	Br—Ae—Ars gr—100mh m—Ao—Ar	ļ	•			
	ОТОМ	< m > 11 101 101 10 001 011					s		٥	2	14	00AsA-s 04UM400Ch High1High Cr1Cr	1 1		P	④	ı
	OTDMR	11 101 101 1001 10 011					s		D	2	1886r≠04 1486r=01	Br − 1 → Br Cr→Ao ~ Ar 00 → Ae ~ Ars D → Hum → 100Ch Hum → 1 → Hum Cr ← 1 → Cr Br − 1 → Br Repeat Q until Br=0	R S	R	s	④ 1	A
	OTD#	11 101 101 10 111 011					s		0	2	1486r≠01 1286r=01	CC—A ₀ —A ₁ OO—A ₄ —A ₁ D—BCl ₃ BL ₃₀ —BCl ₃ B ₁ —1—Br Repeat Q until B=O	x :	; x	x	⊕ I	×
	оит	11 101 101 10 100 011					s		٥	2	12	Cr—Ao~Ar Br—Ae~A·s HLhir—BCh HLn + 1 —HLn Br— 1 —Br	× 6	×	x	@	x
	отя	11 101 101 10 110 011					s		0	2	14(Br≠0) 12(Br=0)	Cr-A ₀ ~Ar Br-A ₄ ~Ars PhU _M -BCh HL _A +1-HL _A Br-1-Br Repect Q until B=0	x :	s x	x	(a) 	
	T\$TIQ m	11 101 101 01 110 100 < m >	s						s	3	12	Cr-Ao-Ar Br-As-Ars 100Ch m Cr-Ao-Ar 00-As-Ars	1	S	•	R	R

^{3 2=1:}Br-1=0 2=0 Br-1≠0 4 N=1:MSB of Data=1 N=0:MSB of Data=0

Operation Landbachecs	OP-code		·		ddressin	•			Bytes	States	Operation	7	6		2	1	0
neme		BARAED	ÐЛ	ND	REG	MEGI	MP	Ю				s	Z	н	PΛ	N	С
OUTPUT OTEM	11 101 101 10 000 011					s		0	2	14	HLha~100Ch HLa+1-HLa	t	3			@	1
OTIMA	11 101 101 10 010 011					s		0	2	16@er≠0) 14@er≖0†	Cr+1Cr Br-1Br CrA ₀ A ₁ 00A ₀ A ₁₀ 00-A	R	5	R	s	④ ≀	
оитр	11 101 101 10 101 011					s		D	2	12	Report Q und Br=0 Cr-Ao-Ar OO-As-Ar OO-As-Ar HR-1-HR Br-1-HR Br-1-HR Br-As-Ar	×	③		×	④ i	

Special Control Instructions

·						ddreser						1	L		F	-0		
Operation	MINEMONICS	OP-code	1		-		•			Bytes	States	Operation	7	6	4	2	1	0
neme	1		MMED	EXT	ND	REG	REGI	MP	REL				s	Z	н	PΛ	N	С
Special	DAA	00 100 111						S/0		1	4	Decimal	1	ı	ı	P		1
Function		ŀ					١	1	1	l	Ì	Adjust]					
	1	l				_				<u> </u>		Accumulator	L					
Cerry	CCF	00 111 111				П				1	3	ē≟c	-		R		R	ı
Control	SCF	00 110 111			l		1	1	1	1	3	1—c	Ŀ		R	٠	R	S
CPU	DI	11 110 011								1	3	016F₁, 016F₂ (§)						
Control	-	11 111 011			l	l				1	3	1EF1, 1EF2 (6)	ŀ				٠	
-	HALT	01 110 110		l	l	l		ļ		1	3	CPU helted	ŀ					
	M O	11 101 101		•	i	l	ł			2		Interrupt	ŀ		٠	٠	٠	
		01 000 110	1			ļ			1			mode 0	1					
	SM 1	11 101 101								2	6	Interrupt	ŀ	٠	٠	•	٠	•
		01 010 110		ļ	1					1		mode 1	1					
	M 2	11 101 101		ļ						2	6	Interrupt	ŀ	•	•	٠	•	•
		01 011 110	1									mode 2	ı					
	NOP	00 000 000	ł				ŀ		1	1	3	No operation	١.	•		•	٠	•
	SLP	11 101 101	1					1		2		Steep				•	•	•
		01 110 110										l						
			1						1									
		1					1		1									

⁽⁵⁾ Interrupts are not sampled at the end of DI or EI.

³⁾ Z=1:8r-1=0 Z=0:8r-1≠0 4) N=1 MS8 of Deta=1 N=0 MS8 of Deta=0

20 INSTRUCTION SUMMARY IN ALPHABETICAL ORDER

MNEMONICS	Bytes	Machine Cycles	States
ADC A,m	2	2	6
ADC A.g	1	2	4
ADC A, (HL)	1	2	6
ADC A, (IX+d)	3	6	14
ADC A, (Y+d)	3	6	14
ADD A,m	2	2	6
ADD A.g	1	2	4
ADD A, (HL)	1	2	6
ADD A, (IX+d)	3	6	14
ADD A, (IY+d)	3	6	14
ADC HL,ww	2	6	10
ADD HL,ww	1	5	7
ADD IX,xx	2	6	10
ADD IY,yy	2	6	10
AND m	2	2	6
AND g	1	2	4
AND (HL)	1	2	6
AND (IX+d)	3	6	14
AND (IY+d)	3	6	14
BIT b, (HL)	2	3	9
BIT b, (IX+d)	4	5	15
BIT b, (1Y+d)	4	5	15
BIT b,g	2	2	6
CALL f,mn	3	2	6
1	[(If condition is false)
	3	6	16
			(If condition is true)

MNEMONICS	Bytes	Machine Cycles	States
CALL mn	3	6	16
CCF	1	1	3
CPD	2	6	12
CPDR	2	8	14
			(If BC _R ≠0 and Ar≠(HL) _M)
	2	6	12
			()f BC _R =0 or Ar=(HL) _M)
CP (HL)	1	2	6
СРІ	2	6	12
CPIR	2	8	14
			(If BC _R ≠0 and Ar≠(HL) _M)
	2	6	12
			(# BC _R =0 or Ar=(HL) _M)
CP (IX+d)	3	6	14
CP (IY+d)	3	6	14
CPL	1	1	3
CP m	2	2	6
CP g	1	2	4
DAA	1	2	4
DEC (HL)	1	4	10
DEC IX	2	3	7
DEC IY	2	3	7
DEC (IX+d)	3	8	18
DEC (TY+d)	3	8	18
DEC g	1	2	4
DEC ww	1	2	4
DI	1	1	3

MNEMONICS	Bytes	Machine Cycles	States
DJNZ j	2	5	9 (If Br≠0)
	2	3	7 (If B r=0)
EI	1	1	3
EX AF,AF'	1	2	4
ex de,hl	1	1	3
EX (SP),HL	1	6	16
EX (SP),IX	2	7	19
EX (SP),IY	2	7	19
EXX	1	1	3
HALT	1	1	3
IM O	2	2	6
IM 1	2	2	6
IM 2	2	2	6
INC g	1	2	4
INC (HL)	1	4	10
INC (IX+d)	3	8	18
INC (IY+d)	3	8	18
INC ww	1	2	4
INC IX	2	3	7
INC IY	2	3	7
IN A,(m)	2	3	9
IN g,(C)	2	3	9
INI	2	4	12
INIR	2	6	14 (If Br≠0)
	2	4	12 (If Br=0)
IND	2	4	12
INDR	2	6	14 (lf Br≠0)

MNEMONICS	Bytes	Machine Cycles	States
INDR	2	4	12 (If Br=0)
INO g,(m)	3	4	12
JP f,mn	3	2	6
			(If f is false)
	3	3	9
			(If f is true)
JP (HL)	1	1	3
JP (IX)	2	2	6
JP (IY)	2	2	6
JP mn	3	3	9
JR j	2	4	8
JR C,j	2	2	6
			(If condition is false)
	2	4	8
			(If condition is true)
JR NC,j	2	2	6
			(If condition is false)
	2	4	8
			(If condition is true)
JR Z,j	2	2	6
			(If condition is false)
	2	4	8
			(If condition is true)
JR NZ,j	2	2	6
			(If condition is false)
	2	4	8
			(If condition is true)

MNEMONICS	Bytes	Machine Cycles	States
LD A, (BC)	1	2	6
LD A, (DE)	1	2	6
LD A,I	2	2	6
LD A, (mn)	3	4	12
LD A,R	2	2	6
LD (BC),A	1	3	7
LDD	2	4	12
LD (DE),A	1	3	7
LD ww,mn	3	3	9
LD ww,(mn)	4	6	18
LDDR	2	6	14 (If BC _R ≠0)
,	2	4	12 (If BC _R =0)
LD (HL),m	2	3	9
LD HL,(mn)	3	5	15
LD (HL),g	1	3	7
LDI	2	4	12
LD I,A	2	2	6
LDIR	2	6	14 (If BC _R ≠0)
	2	4	12 (If BC _R =0)
LD IX,mn	4	4	12
LD IX,(mn)	4	6	18
LD (IX+d),m	4	5	15
LD (1X+d),g	3	7	15
LD IY,mn	4	4	12
LD IY,(mn)	4	6	18
LD (IY+d),m	4	5	15
LD (1Y+d),g	3	7	15

MNEMONICS	Bytes	Machine Cycles	States
LD (mn),A	3	5	13
LD (mn),ww	4	7	19
LD (mn),HL	3	6	16
LD (mn),IX	4	7	19
LD (mn),IY	4	7	19
LD R,A	2	2	6
LD g,(HL)	1	2	6
LD g,(IX+d)	3	6	14
LD g,(IY+d)	3	6	14
LD g,m	2	2	6
LD g,g'	1	2	4
LD SP,HL	1	2	4
LD SP,IX	2	3	7
LD SP,IY	2	3	7
MLT ww	2	13	17
NEG	2	2	6
NOP	1	1	3
OR (HL)	1	2	6
OR (IX+d)	3	6	14
OR (IY+d)	3	6	14
OR m	2	2	6
OR g	1	2	4
ОТОМ	2	6	14
OTDMR	2	8	16 (lf Br≠0)
1	2	6	14 (If Br=0)
OTDR	2	6	14 (If Br≠0)
	2	4	12 (If Br=0)

MNEMONICS	Bytes	Machine Cycles	States
ОТІМ	2	6	14
OTIMR	2	8	16 (If Br≠0)
	2	6	14 (If Br=0)
OTIR	2	6	14 (If Br≠0)
	2	4	12 (If Br=0)
OUTD	2	4	12
OUTI	2	4	12
OUT (m),A	2	4	10
OUT (C),g	2	4	10
OUTO (m),g	3	5	13
POP IX	2	4	12
POP IY	2	4	12
POP zz	1	3	9
PUSH IX	2	6	14
PUSH IY	2	6	14
PUSH zz	1	5	11
RES b.(HL)	2	5	13
RES b.(1X+d)	4	7	19
RES b.(IY+d)	4	7	19
RES b,g	2	3	7
RET	1	3	9
RET f	1	3	5
			(If condition is false)
	1	4	10
			(If condition is true)
RETI	2	4	12
RETN	2	4	12

MNEMONICS	Bytes	Machine Cycles	States
RLA	1	1	3
RLCA	1	1	3
RLC (HL)	2	5	13
RLC (IX+d)	4	7	19
RLC (IY+d)	4	7	19
RLC g	2	3	7
RLD	2	8	16
RL (HL)	2	5	13
RL (IX+d)	4	7	19
RL (IY+d)	4	7	19
RL g	2	3	7
RRA	1	1	3
RRCA	1	1	3
RRC (HL)	2	5	13
RRC (IX+d)	4	7	19
RRC (IY+d)	4	7	19
RRC g	2	3	7
RRD	2	8	16
RR (HL)	2	5	13
RR (IX+d)	4	7	19
RR (IY+d)	4	7	19
RR g	2	3	7
RST v	1	5	11
SBC A,(HL)	1	2	6
SBC A, (IX+d)	3	6	14
SBC A,(IY+d)	3	6	14
SBC A,m	2	2	6

MNEMONICS	Bytes	Machine Cycles	States
SBC A,g	1	2	4
SBC HL,ww	2	6	10
SCF	1	1	3
SET b, (HL)	2	5	13
SET b,(IX+d)	4	7	19
SET b,(IY+d)	4	7	19
SET b,g	2	3	7
SLA (HL)	2	5	13
SLA (IX+d)	4	7	19
SLA (IY+d)	4	7	19
SLA g	2	3	7
SLP	2	2	8
SRA (HL)	2	5	13
SRA (IX+d)	4	7	19
SRA (TY+d)	4	7	19
SRA g	2	3	7
SRL (HL)	2	5	13
SRL (IX+d)	4	7	19
SRL (IY+d)	4	7	19
SRL g	2	3	7
SUB (HL)	1	2	6
SUB (IX+d)	3	6	14
SUB (IY+d)	3	6	14
SUB m	2	2	6
SUB g	1	2	4
TSTIO m	3	4	12
TST g	2	3	7



MNEMONICS	Bytes	Machine Cycles	States
TST m	3	3	9
TST (HL)	2	4	10
XOR (HL)	1	2	6
XOR (IX+d)	3	6	14
XOR (IY+d)	3	6	14
XOR m	2	2	6
XOR g	1	2	4
		1	

		_	_					_		_	_			_					_				_	_				
		Z	ţ	>			0	-	2	က		4	2	9	7	8	Œ		V	œ	0	۵	ŧ	L.		-	>	
ſ		AF	۵.	30H	1111	F				ā				19 0			95 07	Ŧ		ᇤ		NOTE3)	CP m		ı.	Σ	五 8 8	
	7	呈	ЬО	20H	1110	Ε	ļ	72	٤	(8)	Ŧ	f, mn	72	ADD A,m SUB m AND m OR	^	Į	EXX IN (HI) ID SP		UIL	XDE,H.	f, mn	CALL III NOTES Tables NOTES	M MO3	^	ш	PE	18E	L~
ľ	L0=0-7	씸	NC	10H	1101	0	RET	POP zz	JP f, mn	JP mm/CUT (m) EX (SP)	۸.	CALL f, mn	PUSH zz	₩ 8r	RST v	RET (X		JPf,mn	Table 2 IN A, (m) EXDE, HL	CALL f, min	TE3}	CA.	RST v	۵	၁	18H	L0=8~F
ľ	}	 8	ZN	- HOO	1100	္				E		0) Am St			RET			Die2	0	L mm	3.A.m. (SB		၁	Z	- 188 - 188	
L		ш	۷	ð	_	Ĺ	L	_		<u> </u>	S		L	<u>~</u>			Œ					₫	2) AD	L			0	L
					1011	8					R			NOTE						8		- 1	NOTE	_	8			
					1010	٧					\$			NOTEZ						XOR.		i	NOTE2		۷			
					1001	6					SUB s			NOTE2)				_		880 A	ø,		NOTE2)] 	9			
					1000	8					ADD A SUB s AND s OR s	o,		NOTE2) NOTE2) NOTE2)						ADC A SBC A XOR S CP S	ø.		NOTEZ) NOTEZ) NOTEZ) NOTEZ) NOTEZ) ADC A.M SSC A.M XOR M CP		8			
				Ţ		1	H	NOTE1)			_			HALT	L	r				_				 	7	∀]
				Ę	0 0111	-	-	2						Ì										 				
				Ξ	9	စ					•			2 .	 					LD g, s)TE2)	 	9	٦		
				۵	1010	ြ					LD g, s			NOTE2)	1 					2			NOTE2	! ! !	၈	ш	ļ	
			(/~0	8	0100 0101 0110	4					_			1	1								() 	 	4	O	8~F)	
		g S	(LO=0-7)	Œ		၈	Š	-		⋖.		MOTE1)	NOTE1	NOTE1)	Š	<u>ي</u> ي		Ą Q	E					SOF	က	۷	K(L0=8~F)	
	Ę	呈	"	Ξ	1100 0100	2	NOP DJNZ JANZ JANG	Ę	LD(ww), A LD(m) LD(m)	Ŧ	 ≱	┝╌		<u>*</u>	RLCA RLA DAA SCF	121	≩	LD A, (ww) LD HL LD A	E	ž			E	П	7	_	×	1
	ww (LO = ALL)	⊢	┨	┝	_	├	<u> </u>	LD ww, mn	A	_	NC W		<u></u>	٤	<u> </u>	JR i JRZi	ADD HL, ww		_	DEC ww	NC g	DEC 8	LD g. m		H	H		
		핑	1	╚	8	_	3	먑	\frac{1}{8}	:	▐▔	SC	DEC R	L0 g.m	표	٣	ă	کے زر		P		ľ		R	_	Ш		l
		8		a	0000	0	ջ		٥						A CO	EWF. AF	L						L	RRCA RRA	0	0		
			ᆀ		Ī		0	-	2		က	4	ما	စ	~	80	۵	⋖		æ	ပ	6	w	u				
		de.	Tant:			/ ១	000	1000	00100		1100	0100	1010	0110	0111	1000	100	1010		1011	1100	1101	1110	1111				
_		Table 18 1st op-code map	Instruction format: XX		_		8	Т	T		ш	1	_	E	4	T	O	t		w	Ŧ	_	Œ	4	1			
¥ W		90 25	struc				L	_			<u> </u>	_	(ירו	7=	IH)	_	١.	\$		_				İ			
COD	1	18 1	£																									
21 OP-CODE MAP	;	able																										
~	•	_																										

ex. 34H: INC (HL)
FDH 34H: INC (Y+d)
However, JP (HL) and EX DE, HL are acception and note the followings.
HOWEVER, JP (HL) and EX DE, HL are acception and note the followings.
H DDH is supplemented as 1st op-code for JP (HL), (IX) replaces (HL) as operand and JP (IY) is executed.
Even if DDH or FDH is supplemented as 1st op-code for JP (HL), (IX) replaces (HL) as operand and JP (IY) is executed.
Even if DDH or FDH is supplemented as 1st op-code for EX DE, HL, HL is not replaced and the instruction is regarded as illegal instruction.

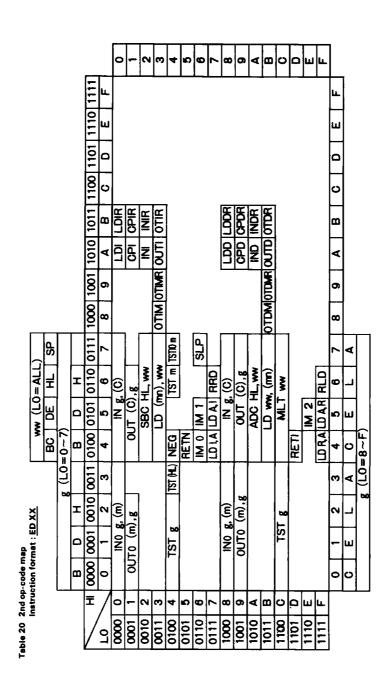
Table 19 2nd op-code map Instruction format: CBXX

				0	-	7	က	4	5	9	7	œ	6	A	8	ပ	٥	ш	H.				
	8	1111	ı						1											F	7		
	4	1110	Е					b,g	i	(E1)						ф 8	i i	NOTE1)		Ε	5		
	7	1101	D					SET b, g	1	NOTE1)						SET b, g	1	N.		a	3		
	0	1100	0						i								i			ပ	1		
	80	101	8																1	8	7		
0-7	4	1010	A					b ,8		NOTE1)						ō, 80		NOTE1)) } !	4	5	(LO=8~F)	
(LO=0-7)	7	100	6					RES b, g	1	NOTE1)						RES b, g		Š		6	3	_	
٥	0	<u>1</u> 00	æ														,	i i	1 1	∞	-	٩	
	9	0111	7							 								1	i ! !	7	7		
	4	0110	စ					p,g		E1)						b ,8		£	; ()	9	က		
	2	0101	2	,				BIT b, g		NOTE1)	1					BIT b, g		NOTE1)	;]]	2	က		
	0	0100	4							 	1								} !	4	-		
		HI [0000][0001][0010][0011][0100][0101][0110][0111][1000][1001][1010][1011][1100][1101][1110][1111]	က						·	, . <u>.</u>	•					<u>8</u>		NOTE1)	i— ! !	65		•	,
		0010	2		•			STAB		NOTE!	1 1 1			•		C RRC & RR & SRA & SRL &		NOTE1) NOTE1) NOTE1)	[7			
		1000	-				-	RL 8	•		1				•	RR g		NOTE1)	! ! !	-			
		000	0					RLC g RL g SLA g) 					PRC g		NOTE:	} 	0			
		Ī	7	0	-	7	က	4	က	0	7	8	6	⋖	8		├	Ш	7				
			<u>'</u> ച	8	8	00100	1100	0100	0101	0110	0111	1000	18	1010	101	1100	1101	1110	1111				
				8	ပ	۵	ш	I	با	Ξ	٨	8	O	۵	ш	Ι	د	<u>E</u>	4				
									<u>(T</u>	78	=1	<u>H)</u>		8]			

NOTE1) If DDH is supplemented as 1st op-code for the instructions which have (HL) as operand in Table 19, the instructions are executed raplacing (HL) with IX+d).

If FDH is supplemented as 1st op-code for the instructions which have (HL) as operand in Table 19, the instructions are executed replacing (HL) with IY+d).

OHITACHI



22 BUS AND CONTROL SIGNAL CONDITION IN EACH MACHINE CYCLE

* (ADDRESS) : invalid Z (DATA) : high impedance.

Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	ЮĒ	UR	HALT	ST
ADD HLww	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	٥
ADD IILWW	MC ₂ ~MC ₅	ग्रामक		z	1	1	1	1	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
ADD IX,xx ADD IY,yy	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1		1	1
	MC ₃ ~MC ₆	चनम	•	z	1	1	1	1	1	1	1
	MC:	T1T2T3	1st op-code Address	. 1st op-code	0	1	0	1	0	1	0
ADC HL,ww SBC HL,ww	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1		,	1
	MC ₃ ~MC ₄	च्चक		z	1	1	1	1	1	1	1
ADD A.g ADC A.g SUB g	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	o
SBC A.g AND g OR g XOR g CP g	MC ₂	Ti		z	1	1	1	1	1	1	1
ADD A,m ADC A,m SUB m SBC A,m	MC,	Ť₁Τ₂Τ₃	1st op-code Address	1st op-code	o	1	0	1	o	1	0
AND m OR m XOR m CP m	MC ₂	T1T2T3	1st operand Address	m	0	1	0	1	1	1	1
ADD A, (HL) ADC A, (HL) SUB (HL) SBC A, (HL) AND (HL)	MCı	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
OR (HL) XOR (HL) CP (HL)	MC2	T1T2T3	HL	DATA	0	1	o	1	1	1	1
ADD A, (IX+d) ADD A, (IY+d) ADC A, (IX+d)	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	o	1	0
ADC A, (TY+d) SUB (TX+d) SUB (TY+d) SBC A, (TX+d)	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	o	1	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	IOE	UR	HALT	ST
SBC A, (IY+d) AND (IX+d)	MC ₃	T1T2T3	1st operand Address	d	0	1	0	1	1	1	1
AND (IY + d) OR (IX + d) OR (IY + d) XOR (IX + d) XOR (IY + d)	MC ₄ ~MC ₅	TiTi		z	1	1	1	1	1	1	1
CP (IX+d) CP (IY+d)	MCe	T+T2T3	IX+d IY+d	DATA	0	1	0	1	1	1	1
BiT b,g	MC+	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
on o.g	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	o	1	0	1	1
	MC 1	T1T2T3	1st op-code Address	1st op-code	0	1_	0	1	0	1_	0
BIT b, (HL)	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	o	,	o	1	0	1	1
	MC ₃	T1T2T3	HL	DATA	0	1	0	1	1	1	1
	MC i	T1T2T3	1st op-code Address	1st op-code	0	1	o	. 1	0	1	0
	MC2	T1T2T3	2nd op-code Address	2nd op-code	0	1_	0	1	0	1	1
BIT b, (IX+d) BIT b, (IY+d)	MC ₃	Τ₁Τ2Τ3	1st operand Address	d	0	1	٥	1	1	1	1
	MC ₄	T+T2T3	3rd op-code Address	3rd op-code	0	1	0	1	0	1	1
	MC ₅	T ₁ T ₂ T ₃	IX+d IY+d	DATA	0	1_	0	1	1	1_	1
	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC2	T ₁ T ₂ T ₃	1st operand Address 2nd operand	n	0	1	0	1	1	1_	1
CALL mn	MC ₃	T1T2T3	Address	m	0	1	0	1	1	1	1
	MC4	Ti		z	1	1	1	1	1	1_	1
	MC s	T₁T₂T₃	SP-1	РСН	1	0	0	1	1	1	1
	MC ₆	T ₁ T ₂ T ₃	SP-2	PCL 1st	1	0	0	1	1	1	1
CALL f,mn (If condition is false)	MC:	T1T2T3	Address 1st operand	op-code	0	1	0	1	0	1	0
10 1010-01	MC₂	T1T2T3	Address	n	0	1	0	1	1	1	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	ĬŒ	LIR	HALT	ST
	MC1	T1T2T3	1st op-code Address	1 st op-code	0	1	0	1	0	1	
	MC ₂	T,T2T3	1st operand Address	n	0	1	0	1	1	1	٦,
CALL f.mn	MC ₃	T,T2T3	2nd operand Address		0	1	0	1	1	1	1
CALL 1,mn (# condition is true)	MC ₄	Ti	•	z	,	1	1	1	1	1	1
	MCs	T1T2T3	SP 1	РСН	,	,	-	1	1	,	1
	MCs	T1T2T3	SP-2	PCL	1	 	-	-	1	 , 	1
CCF	MC:	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1		1	0	1	0
CPI CPD	MC1	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	 	0	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	,	,		,		1	,
	MC ₃	T1T2T3	HL	DATA	0	1	0	1	1	1	1
	MC ₄ ~ MC ₆	τιτιτί		z	,	1	1	1	1	1	1
CPIR CPDR OF BC _n ≠0 and Ar≠(HL) _M)	MC	T1T2T3	1st op-code Address	1st op-code	٥	1	0	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
	MC ₃	T1T2T3	HL	DATA	o	1	٥	1	1	1	1
	MC4 ~MC4	रतताव ा		Z	1_	1	ι	1	1	1	1
CPIR CPDR OF BC _R =0 or Ar=0HL) _M	MC:	T1T2T3	1st op-code Address	1st op-code		1	0	1		1	0
	MC ₂	T,T2T3	2nd op-code Address	2nd op-code		١,	0	1_	0	1	1
	MC ₃	T1T2T3	HL	DATA	0	1	0	1_	1	1	1
	MC4 ~MC6		•	z	1	1	<u></u>	1_	1	1	,
CPL	MC:	T,T2T3	1st op-code Address	1st op-code	٥	1	٥	1_	0	1	0
DAA	MC	T1T2T3	1st op-code Address	1st op-code	0	1		,	0	1	0
	MC ₂	Ti	•	_ z	1	,	<u>,</u>	١,	1	1	1
Di	MC.	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	٥	1	0



Instruction	Machine Cycle	States	ADDRESS	DATA	RO	WR	ME	ΙΟĒ	UR	HALT	S T
DJNZ j (ff Br≠0)	MC ₁	T1T2T3	1st op-code Address	1st op-code	o	1	0	1	0	1	0
	MC ₂	Ti *1	•	z	1	1	1	1	1	1	1
	MC ₃	T1T2T3	1st operand Address	j-2	0	1	٥	1	1	1	1
	MC ₄ ~MC ₅	TiTi		Z	1	1	1	1	,	1	1
	MC ₁	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	o
DJNZ j (If Br=0)	MC ₂	Ti *1		Z	1	1	1	1	1	1	1
	MC ₃	T ₁ T ₂ T ₃	1st operand Address	j-2	0	1	0	1	1	1	1
EI	MC ₁	T,T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
EX DE, HL EXX	MC.	T1T2T3	1st op-code Address	1st op-code	0	,	0	,	0	,	0
	MC i	T1 T 2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
EX AF, AF'	MC ₂	Ti		z	1	1	1	1	1	1	1
	MC ₁	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	o	1	o
	MC ₂	T1T2T3	SP	DATA	o	1	0	1	١,	1	,
EX (SP), HL	MC ₃	T1T2T3	SP+1	DATA	0	1	0	1	1	1	1
EX (SF), FIL	MC ₄	Ті		z	1	1	1	1	1	1	1
	MC ₅	T ₁ T ₂ T ₃	SP+1	н	1	o	0	1	1	1	1
	MC ₆	T ₁ T ₂ T ₃	SP	L	1	0	0	1	1	1	1
_	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	11	0	1	0	1	1
EX (SP),IX EX (SP),IY	MC ₃	T ₁ T ₂ T ₃	SP	DATA	0	1_	0	1	1	1	1
	MC ₄	T1T2T3	SP+1	DATA	0	1	0	1	1	1	1
	MC ₅	Ti		Z	1	1	1	1	1	1	1

*1 DMA, REFRESH, or BUS RELEASE cannot be executed after this state. (Request is ignored)

Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	ĪŌĒ	ŪA.	HALT	ST
ex (SP), IX ex (SP), IY	MC₃	T ₁ T ₂ T ₃	SP+1	IXH	1	0	0	1	1	1	1
	MC ₇	T1T2T3	SP	IXL IYL	1	0	0	1	1	1	1
HALT	MC t	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	٥
			Next op-code Address	Next op-code	0	1	0	1	0	0	0
Mo	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
M 1 M 2	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	o	1	0	1	1
INC g	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	٥
DEC g	MC₂	Ti		z	1	1	1	1	1	1	1
INC (HL) DEC (HL)	MC ₁	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	HL	DATA	0	1	٥	1	1	1	1
	MC ₃	Ti	•	Z	1	1	1	1	1	1	1
	MC4	T1T2T3	HL	DATA	1	0	0	1	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
INC (DX+d)	MC ₃	T1T2T3	1st operand Address	d	0	1	٥	1	1	1	1
INC (IX+d) DEC (IX+d)	MC4 ~MCs	TiTi		z	1	1	1	1	1	1	,
DEC (IY+d)	MC ₆	T1T2T3	IX+d IY+d	DATA	0	1	0	1	,	1	1
	MC ₇	Ti		Z	1	1	٦	1	1	1	1
	MCe	T1T2T3	IX+d IY+d	DATA	1	0	0	1	1	1	1
INC ww DEC ww	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC2	Ti		z	1	1	,	1	,	,	1
INC DX INC IY DEC IX DEC IY	MC:	₹1T2T3	1st op-code Address	1st op-dode	0	1	0	1	0	1	٥
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	,	0	1	1
	MC ₃	Ti		z	1	1	1	1	1	1	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	ЮĒ	LIR	HALT	ST
	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
IN A,(m)	MC ₂	T1T2T3	1st operand Address	m	o	1	٥	1	1	1	1
	MC ₃	T1T2T3	m to A ₀ ~A ₇ A to A ₈ ~A ₁₅	DATA	0	1	1	0	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	o	1	0	1	0	1	0
IN g.(C)	MC₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
	MC ₃	T1T2T3	вс	DATA	0	1	1	0	1	1	1
	МС	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
INO g,(m)	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
	MC ₃	T1T2T3	1st operand Address	m	0	1	0	1	1	1	1
·····	MC4	T1T2T3	m to A ₀ ~A ₇ OOH to A ₈ ~A ₁₅	DATA	0	1	1	0	1	1	1
	MC i	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1_1_	0	1	0	1	٥
NI n	MC ₂	Τ₁ͳ2ͳ3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
IND	MC ₃	T ₁ T ₂ T ₃	вс	DATA	0	1	1	٥	1	1	1
	WC1	T1T2T3	HL	DATA	1	0	0	1	1	1	1_
	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
INIR	MC2	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
INDR (If Br≠0)	MC ₃	T1T2T3	вс	DATA	0	1	1	0	1	1	1
	MC ₄	T1T2T3	HL	DATA	1	0	0	1	1	1	1
	MCs ~MCs	TiTi		Z	1	1	1	1	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
INIR INDR	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	۰	1	٥	1	0	1	,
(If Br≔O)	MC ₃	T172T3	BC	DATA	0	١,	1	0	1	1	1
	MC4	T1T2T3	HL.	DATA	1	0	0	1	1	,	_1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	ЮĒ	LIR	HALT	ST
	MCı	Τ₁Τ₂Τ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
JP mn	MC ₂	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
	MC ₃	T ₁ T ₂ T ₃	2nd operand Address	m	0	1	0	1	1	1	1
JP f,mn	MC ₁	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
(If f is false)	MC ₂	T1T2T3	1st operand Address	n	0	1	0_	1	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
JP f,mn (If f is true)	MC ₂	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
	MC ₃	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
JP (HL)	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
JP (DK) JP (TY)	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1_	0	1	0	1	1
	MC.	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
JR j	MC ₂	T ₁ T ₂ T ₃	1st operand Address	j-2	0	1	0_	1	1	1	1
	~MC4	TiTi		z	1	1	1	1	1	1	1
JR C.j JR NC.j JR Z.j JR NZ.j Of condition	MC	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
is false)	MC ₂	T1T2T3	1st operand Address	j-2	٥	1	0_	1	1	1	1
JR C.j. JR NC.j	MCı	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
JR Z.j JR NZ.j (If condition is true)	MC ₂	Ť1Ť2T3	1st operand Address	j-2	0	1	0_	1	1	1	1
	MC ₃ ~MC ₄	TiTi		<u>z</u>	1	1	1	1	1	1	1
LD g.g'	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	Ti		Z	1	1	1_	1	1	1	1
LD g.m	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	1st operand Address	m	0	1	0	1	1	1	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WŘ	ME	ЮĒ	ŪĀ	HALT	ST
LD g, (HL)	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	HL	DATA	0	1	0	1	1	1	1
	MC 1	T+T2 T 3	1st op-code Address	1st op-code	0	1	o	1	0	1	0
	MC ₂	T₁T2T3	2nd op-code Address	2nd op-code	o	1	0	1	0	1	1
LDg, (IX+d) LDg, (IY+d)	MC ₃	T1T2T3	1st operand Address	d	o	1	o	1	1	1	1
	MC₄ ~MC₅	TiTi	•	z	1	1	1	1	1	1	1
	MC ₆	T ₁ T ₂ T ₃	IX+d IY+d	DATA	0	1	0	1	1	1	1
1	MCı	Τ₁Τ₂Τ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
LD (HL),g	MC ₂	Ti		z	1	1	1	1	1	1	1
	MC ₃	T1T2T3	HL	9	1	0	0	1	1	1	1
	MC:	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	٥	1	1
LD (IX+d).g LD (IY+d).g	MC ₃	T ₁ T ₂ T ₃	1st operand Address	d	0	1	0	1	1	1	1
	MC ₄ ~ MC ₆	τιτιτι		z	1	1	1	1	1	1	1_
	MC ₇	T1T2T3	IX+d IX+d	g	1	0	o	1	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1_	0
LD (HL),m	MC ₂	T+T2T3	1st operand Address	m	0	1	0	1	1	1	1
	MC ₃	T₁T2Ť3	HL	DATA	1	٥	0	1	1	1	1
	MCı	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T,T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
LD (IX+d),m LD (IY+d),m	MC ₃	T1T2T3	1st operand Address	d	0	1	0	1	1	1	1
	MC.	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
	MC ₅	T1T2T3	IX+d IY+d	DATA	1	0	0	1	1	1	1
LD A, (BC) LD A, (DE)	MC	T : T 2 T 3	1st op-code Address	1st op-code	0	1	0	1	0	1	0



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	₩R	ME	ΪΟĒ	TÜR	HALT	ST
LD A, (BC) LD A, (DE)	MC₂	T1T2T3	BC DE	DATA	0	1	0	1	1	,	1
	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	o	1	0
10.4()	MC ₂	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
LD A,(mn)	MC ₃	T 1 T 2 T 3	2nd operand Address	m	0	1	0	1	1	1	1
	MC ₄	T1T2T3	mn	DATA	0	1	0	1	1	1	1
	MC+	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
LD (BC),A LD (DE),A	MC ₂	Ti		z	1	,	1	1	1	1	1
	MC ₃	T1T2T3	BC DE	A	1	0	0	1	1	1	1
	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1 T 2T3	1st operand Address	n	0	1	0	1	1	1	1
LD (mn),A	MC ₃	T₁T₂Ť₃	2nd operand Address	m	0	1	0	1	1	1	1
	MC4	Ti		z	1	1	1	1	1	1	1
	MC s	T1T2T3	mn	А	1	0	0	1	1	1	1_
LD A,I LD A,R	MCı	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0_
LD I,A LD R,A	MC ₂	Ť1Ť2Ť3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
	MC ₁	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	o	1	0_
LD ww. mn	MC2	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
	MC₃	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
	MC ₁	T1T2T3	1st op-code Address	1st op-code	o	1	o	1	0	1	o
LD IX,mn	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
LD IY,mn	MC₃	T,T2T3	1st operand Address	n	0	1	0	1	1	1	1
	MC ₄	T1T2T3	2nd operand Address	m	o	1	0	1	1	1	1
LD HL, (mn)	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T₁TzŤ3	1st operand Address	n	0	1	0	1	1	1	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	TOE	UR	HALT	ST
	MC ₃	T1T2T3	2nd operand Address	m	o	1	0	1	1	1	1
LD HL, (mn)	MC ₄	T1T2T3	mn	DATA	0	1	0	1	1	1	1
	MC ₅	T ₁ T ₂ T ₃	mn+1	DATA	0	1	0	1	1	1	1
	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
LD ww.(mn)	MC ₃	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
LD ww.(Itin)	MC ₄	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
	MC s	T1T2T3	mn	DATA	0	1	0	1	1	1	1
	MC ₆	T1T2T3	mn+1	DATA	0	1	٥	۱,	1	1	1
	MC 1	T1T2T3	1st op-code Address	1st op-code	0	1	o	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
LD IX,(mn)	MC ₃	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
LD IY,(mn)	MC4	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
	MC ₅	T 1T2T3	mn	DATA	o	1	0	1	1	ı	1
	MC ₆	T,T2T3	mn+1	DATA	0	١,	0	1	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC2	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
LD (mn),HL	MC ₃	TıTzTa	2nd operand Address	m	0	1	0	1_	1	1	1
FO AIRM'NIF	MC4	Ti	•	z	1	1	1	1	1	1	1
	MCs	T1T2T3	mn	L	1	0	0	1	1	1	1
	MC ₅	T1T2T3	mn+1	н	1	o	0	1_	1	1	1

Instruction	Machine Cycle	States	ADDRESS	DATA	RO	WR	ME	ЮĒ	LIR	HALT	ST
-	MCı	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	o	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	o	1	0	1	1
	MC₃	T11213	1st operand Address	n	0	1	0	1	1	1	1
LD (mn),ww	MC4	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
	MC ₅	Ti		Z	1	1	1	t	1	1	1
	MC ₆	T1T2T3	mn	wwL	1	0	0	1	1	1	1.
	MC ₇	T ₁ T ₂ T ₃	mn+1	wwH	1	0	0	1	1	1	1
	MC1	Τ1Τ2Τ3	1st op-code Address	1st op-code	0	1	0	1	0	1	٥
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	o	1	0	1	0	1	1
	MC ₃	Τ,Τ2Τ3	1st operand Address	n	o	1	0	1	1	1	1
LD (mn),IX LD (mn),IY	MC ₄	T1T2T3	2nd operand Address	m	o	1	0	1	1	1	1
	MCs	Τi	•	z	1	1	1	1	1	1	1
	MC ₆	T1T2T3	mn	IXL IYL	1	0	0	1	1	1	1
	MC7	T1T2T3	mn+1	IXH	1	0	0	1	1	1	1
LD SP, HL	MC v	T1T2T3	1st op-code Address	1st op-code	o	1	o	1	0	1	0
	MC ₂	Ti		z	1	1	1	1	1	1	1
	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
LD SP,IX LD SP,IY	MC2	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
	MC ₃	Ti		Z	1	1	1	1	1	1	1
	MCı	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
LDI	MC₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
LDD	MC ₃	T1T2T3	HL	DATA	0	1	0	1	1	1	1
	MC4	T1T2T3	DE	DATA	1	0	0	1	1	1	1

Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	WE	IDE:	UR	HALT	ST
	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
LDIR LDIR LDIR LDIR LDDR (If BC _R =0)	MC₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
LDDR (If BC _R ≠0)	MC ₃	T172T3	HL.	DATA	0	,	0	1	1	1	1
	MC.	T1T2T3	DE	DATA	1	0	0	1	1	1	,
	MC ₅ ~MC ₆	TiTi	•	z	1	1	1	1	1	1	1
	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
LDIR LDDR	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	o	1	0	1	0	1	1
(If BC _R =0)	MC ₃	T1T2T3	HL	DATA	0	1	0	1	1	1	1
	MC4	T1T2T3	D€	DATA	1	0	0	1	1	1	1
	MC ₁	T1T2T3	1st op-code Address	1st op-code	o	1	0	1	0	1	0
MLT ww	MC2	TıTaTa	2nd op-code Address	2nd op-code	0	1	0	,	0	1	1
	MC ₃ ~MC ₁₃	रतातः स्तातः स्ततः		z	1	1	1	1	1	٦_	1
NEG	MC ₁	TıTaTa	1st op-code Address	1st op-code	0	1	o	1	0	1	٥
	MC₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
NOP	MC ₁	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC:	T:TeTa	1st op-code Address	1st op-code	o	1	0	1	٥	1	0
A.(m) TUO	MC ₂	T172T3	1st operand Address	m	0	1	0	1	1	1	1
1	MC ₃	Ti_	•	Z	1	1	1	1	1	1	1
	MC4	T1T2T3	m to A ₀ ~A ₇ A to A ₈ ~A ₁₅	Α	1	0	1	0	1	1	1

Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	MÉ	ЮĒ	ŪŔ	HALT	S T
	MCı	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	٥
OUT (C),g	MC2	TıT2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
OUT ICING	MC ₃	Ti		Z	1	1	1	1	1	1	1
L	MC.	T1T2T3	8C	g	1	o	1	0	1	,	1
	MC1	T 1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
Q.(m) OTUO	MC ₃	T ₁ T ₂ T ₃	1st operand Address	m	0	1	0	1	1	1	1
	MC4	Ti		z	1	1	1	1	1	1	1
	MC ₅	T1T2T3	m to Ao~Az OOH to Aa~A15	g	1	0	1	0	1	1	1
	MC,	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC₂	T1T2T3	2nd op-code Address	2nd op-code	o	1	0	1	0	1	1
ОТІМ	MCs	Ti		z	1	1	1	1	1	1	1
ОТОМ	MC1	T1T2T3	HL	DATA	0	1	0	1	1	1	1
j	MCs	T1T2T3	C to Ao~A7 OOH to A (~A16	DATA	1	o	1	0	1	1	1
	MC₃	Ti		Z	1	1	1	1	1	1	1
	MC,	T1T2T3	1st op-code Address	1st op-code	0	1	o	1	0	,	0
	MC2	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
OTIMR OTDMR	MC ₃	Ti	•	z	1	1	1	1	1	1	1
(H Br≠O)	MC4	T1T2T3	н	DATA	0	1_	0	1	1	1	1
	MCs	T:T2T3	C to Ao~A7 OOH to A1~A15	DATA	1	0_	1	0_	1	1	1
	MCs ∼MCs	TITITI	•	z	1	1	1	1	1	1	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	₩ħ	ME	₩.	UR	HALT	ST
	МС	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
OTIMR OTDMR	MC ₃	Ti		z	1	1	1	1	1	1	1
(If Br=O)	MC4	T1T2T3	HL	DATA	0	1	٥	1	1	1	1
	MC ₅	T1 T 2T3	C to A ₀ ~A ₇ OOH to A ₆ ~A ₁₅	DATA	1	0	1	0	1	1	1
	MCs	Ti		z	1	1	1	1	1	1	1
	MC,	T1 T2 T3	1st op-code Address	1st op-code	٥	,	0	1	0	1	٥
OUTI	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
OUTD	MC ₃	T,T2T3	HL	DATA	0	1	o	1	1	1	1
	MC ₄	T1T2T3	ВС	DATA	1	0	1	0	1	1	1
i.	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
ОТИЯ	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
OTDR (If Br≠0)	MC ₃	T₁T2Ť3	HL	DATA	0	1	0	1	1	1	1
	MC4	T1T2T3	ВС	DATA	1	0	1	0	1	1	1
	MCs ~MCs	TiTi	•	z	1	1	1	1	1	1	1
	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1_	٥	1	0
OTIR OTDR	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	۰	1	0	1	0	۱ ا	1
(If Br=O)	MC ₃	T1T2T3	HL	DATA	0	1	0	1	1	1	1
	MC4	TıT2T3	ВС	DATA	1	0	1	0	1	1	1
POP zz	MC.	T1T2T3	1st op-code Address	1st op-code	٥	1	0	1	0	1	0
	MC ₂	T1T2T3	SP	DATA	0	1	0	١,	1	1	1
	MC ₃	T1T2T3	SP+1	DATA	0	1	0	1	1	1	1
POP IX POP IY	MC:	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	o	1	٥



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	ME	KOE	UR	HALT	ST
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
POP IX POP IY	MC ₃	T1T2T3	SP	DATA	0	1	0	1	1	1	1
	MC ₄	T,T2T3	SP+1	DATA	o	1	0	1	1	1	1
	MC1	₹1 Т2 Т3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
PUSH zz	MC ₂ ~MC ₃	ТіТі	•	z	1	1	١,	1	1	1	1
	MC4	T1T2T3	SP-1	zzH	1	0	0	1	1	1	1
	MCs	T₁T₂T₃	SP-2	zzl	1	0	0	1	1	1	1
	МС	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	٥	1	0
	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	o	1	0	1	0	1	1
PUSH IX PUSH IY	MC₃ ~MC₄	TiTi	•	z	1	1	1	1	1	1	1
	MCs	T,T2T3	SP-1	IXH	1	0	0	1	1	1	1
	MC ₆	T1T2T3	SP-2	IXL IYL	1	0	0	1	1	1	1
RET	MC1	T·T2T3	1st op-code Address	1st op-code	0	1	o	1	0	1	0
	MC2	T1T2T3	SP	DATA	0	1	0	1	1	1	1
	МС₃	T1T2T3	SP+1	DATA	0	1	0	1	1	1	1
RET f	MC ·	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
is false)	MC₂ ~MC₃	TiT:		z	1	1	,	1	1	1	1
	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	٥	1	0	1	0
RET f	MC ₂	Tı	•	z	1	1	1	1	1	1	1
is true)	MC ₃	T1T2T3	SP	DATA	0	1	0	1	1	1	1
	MC4	T+T2T3	SP+ 1	DATA	0	1	0	1	1	1	1
RETI	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
RETN	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	o	1	0	1	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RID	WR	MË	ЮĒ	TUR	HALT	ST
RETI	MC ₃	T1T2T3	SP	DATA	0	1	0	1	1	1	1
RETN	MC4	T1 T 2T3	SP+1	DATA	o	1	0	1	1	1	1
RLCA RLA RRCA RRA	MC ₁	T1T2T3	1st op-code Address	1st op-code	o	1	0	1	0	1	0
RLC g RL g	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	٥	1	0	1	0
RRC g RR g SLA g	MC ²	T ₁ T ₂ T ₃	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
SRA g SRL g	MC₃	ті		z	1	1	1	1	1	1	1
	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
RLC (HL) RL (HL) RRC (HL)	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
RR (HL) SLA (HL)	MC ₃	T1T2T3	HL	DATA	o	1	o	1	١ .	1	1
SRA (HL) SRL (HL)	MC ₄	Ti	•	2	1	1	1	1	1	1	1
	MC ₅	T₁T₂T₃	HL	DATA	1	0	o	1	1	1	1
RLC (0X+d)	MC ₁	T 1T2T3	1st op-code Address	1st op-code	0	,	٥	1	0	1	D
RL (IX+d) RL (IX+d) RL (IY+d)	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	•	1	0	1	1
RRC (IX+d) RRC (IY+d)	MC ₃	T1T2T3	1st operand Address	d	0	1	0	1	1	1	1
RR (IX+d) RR (IY+d)	MC4	T:T2T3	3rd op-code Address	3rd op-code	0	1	0	1	0	1	1
SLA (IX+d) SLA (IY+d) SRA (IX+d)	MC ₅	T ₁ T ₂ T ₃	IX+d IY+d	DATA	0	1	0	1	1	1	1
SRA (IY+d) SRL (IX+d)	MCs	Ti		Z	1	1	1	1	1	1	1
SRL (IY+d)	MC ₇	T,T2T3	IX+d IY+d	DATA	1	0	0	1	1	1	1
	MC 1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
RLD RRD	MC ₂	Τ1Τ2Τ3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
	MC ₃	T1T2T3	HL	DATA	o	,	0	1	1	1	1

Instruction	Machine Cycle	States	ADDRESS	DATA	RO	₩ħ	ME	KOE	UR	HALT	ST
RLD	MC4 ~MC7	TITITITI		z	1	1	1	1	1	1	1
RRD	MC ₈	T ₁ T ₂ T ₃	HL	DATA	1	0	0	1	1	1	1
	MC:	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₂ ~MC ₃	TiTi		z	1	1	1	1	1	1	1
RST v	MC ₄	T1T2T3	SP1	PCH	1	0	0	1	1	1	1
	MC ₅	T1T2T3	SP-2	PCL	1	0	0	1	1	1	1
SCF	MCı	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC ₁	T1 T 2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
SET b,g RES b,g	MC ₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	o	1	0	1	1
_	MC ₃	Ti		Z	1	1	1	1	1	1	1
	MC ₁	T1T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
	MC₂	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	o	1	1
SET b. (HL) RES b. (HL)	MC ₃	T ₁ T ₂ T ₃	HL	DATA	0	1	0	1	1	1	-
	MC4	Ti	•	z	1	1	1	1	1	1	٦
	MC ₅	T ₁ T ₂ T ₃	HL	DATA	1	0	0	1	1	1	1_
	MC1	T1T2T3	1st op-code Address	1st op-code	0	1	0	1_	0	1	0_
	MC ₂	T:T2T3	2nd op-code Address	2nd op-code	0	1	o	1	0	1	1
SET b, (IX+d)	MC ₃	T1T2T3	1st operand Address	d	0	1	0	1	1	1	1
SET b, (1Y+d) RES b, (IX+d)	MC4	T1T2T3	3rd op-code Address	3rd op-code	0	1	0	1	0	1	1
RES b, (1Y+d)	MC ₅	T1T2T3	IX+d IY+d	DATA	0	1	0	1	1	1	1
	MC ₆	Ti	•	Z	1	1	1	1	1	1	1
	MC ₇	Τ,Τ2Τ3	IX+d IY+d	DATA	1	0	0	1	1	,	1



Instruction	Machine Cycle	States	ADDRESS	DATA	RD	WR	WE	ЮĒ	UR	HALT	ST
	MC ·	T1 T 2 T 3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
SLP	MCz	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
			7FFFFH	Z	1	1	1	1	1	0	1
	MCı	T, F2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
TSTIO m	MC2	T1T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
TORO III	MC ₃	T1T2T3	1st operand Address	m	o	1	0	1	1	1	1
	MC4	T+T2T3	C to Ao~A7 OOH to A-~A15	DATA	0	1	1	0	1	1	1
	MC1	T,T2T3	1st op-code Address	1st op-code	0	1	0	1	0	1	0
TST g	MC₂	T,T2T3	2nd op-code Address	2nd op-code	0	1	0	1	0	1	1
	MC ₃	Ti		z	1	1	1	1	1	1	1
	MC 1	T1T2T3	1st op-code Address	1st op-code	0	1	o	1	0	1	0
TST m	MC ₂	T₁T₂T₃	2nd op-code Address	2nd op-code	0	1	٥	1	o	1	1
·- ····	MC ₃	T ₁ T ₂ T ₃	1st operand Address	m	0	1	0	1	1	1	1
	MC.	T ₁ T ₂ T ₃	1st op-code Address	1st op-code	0	1	٥	1	0	1	0
TST (HL)	MC 2	T1T2T3	2nd op-code Address	2nd op-code	٥	1	0	1	٥	1	1
	MC ₃	Tı		Z	1	1	1_	1	1	1	1
į.	MC4	T1T2T3	HL	DATA	0	1	0	1	1	1	1_
INTERRUPT		,	1	_		1	_		,	1	
	MC 1	T : T2T3	Next op-code Address (PC)		0	1	0	1	0	1	0
NMI	MC₂ ~MC₃	ТіТі	•	Z	1	1	1	1	1	1	1
	MC4	T,T2Ť3	SP-1	РСН	1	0	0	1	1	1	1
	MC s	<u>└</u>	SP- 2	PCL	1	0	٥	1	1	1	1
INT₀ MODE O	MC 1	T ₁ T ₂ T _W T _W T ₃	Next op-code Address (PC)	1st op-code	1	1	1	0	٥	1	0
(RST INSERTED)	MC ₂ ~MC ₃	TiTi		z	1	1	1	1	1	1	1

Instruction	Machine Cycle	States	ADDRESS	DATA	RD	₩Ŕ	MĒ	ЮĒ	UR	HALT	ST
INTo MODE 0 (RST INSERTED)	MC4	T1T2T3	SP-1	РСН	1	0	0	1	1	1	1
MOT MOERICO	MC s	T1T2T3	SP-2	PCL	1	0	0	1	1	1	1
	MC1	T ₁ T ₂ T _W T _W T ₃	Next op-code Address (PC)	1st op-code	1	1	1	0	0	1	0
	MC ₂	T1T2T3	PC	n	0	1	0	1	1	1	1
NT ₀ MODE 0	MC₃	Τ₁Τ₂Τ₃	PC+1	m	٥	1	0	1	1	1	1
NSERTED)	MC4	Ti	•	z	1	1	1	1	1	,	1
	MC₅	T1T2T3	SP-1	PC+2(H)	1	0	0	1	1	1	1
	MC ₆	T1T2T3	SP-2	PC+ 2(L)	1	0	0	1	1	1	1
	MC:	T ₁ T ₂ T _W T _W T ₃	Next op-code Address (PC)		1	1	1	o	0	1	0
INTo MODE 1	MC ₂	T1T2T3	SP-1	РСН	1	0	0	1	1	1	1
	MC ₃	T1T2T3	SP-2	PCL	1	0	0	1	1	1	1
	MC:	T ₁ T ₂ T _W T _W T ₃	Next op-code Address (PC)	Vector	1	1	1	o	0	1	0
	MC ₂	Ti		z	1	1	1	1	1	1	1
NT₀ MODE 2	MC ₃	T1T2T3	SP-1	РСН	1	0	0	1	1	1	1
	MC ₄	T1T2T3	SP-2	PCL.	1	0	0	1	1	1	1
	MC ₅	T1T2T3	I, Vector	DATA	٥	1	0	1	1	1	1
	МСв	T1T2T3	i, Vector+1	DATA	0	1	0	1	1	1	1
	MC:	T ₁ T ₂ T _W T _W T ₃	Next op-code Address (PC)		1	1	1	1	1	1	0
	MC₂	Ti		z	1	1	1	1	1	1_	1
INT :	MC ₃	T1T2T3	SP-1	РСН	1	0	0	1	1	1	1
internal Interrupts	MC ₄	T ₁ T ₂ T ₃	SP-2	PCL	1	0	0	1	1	1	1
	MCs	T,T2T3	l, Vector	DATA	0	1	0	1	1	1	1
	MC ₆	T1T2T3	I, Vector+1	DATA	0	1	0	1	1	1	1

23 REQUEST ACCEPTANCES IN EACH OPERATING MODE

SYSTEM STOP mode	Not acceptable	Not acceptable	Not acceptable	Acceptable	Acceptable Return from SYSTEM STOP mode to normal	Not acceptable	Acceptable Return from SYSTEM STOP mode to normal operation.
SLEEP mode	Not acceptable	Not acceptable	Not acceptable	Acceptable	Acceptable Return from SLEEP mode to normal operation.	1	-
BUS RELEASE mode	Not acceptable	Not acceptable	Accentable * After BUS RELEASE cycle, DMA cycle begins at the end of one MC.	Continue BUS RELEASE mode.	Not acceptable	1	_
DMA Cycle	Acceptable	Refresh cycle begins at the end of MC.	Acceptable Refer to "2.9 DMA Controller" for details.	Bus is released at the end of MC.	Not acceptable	-	Acceptable DMA cycle stops.
Interrupt Acknowledge Cycle	Acceptable	Refresh cycle begins at the end of MC.	Acceptable DMA cycle begins at the end of MC.	Bus is released at the end of MC.	Not acceptable		Not acceptable interrupt acknowledge acknowledge. NMI is accepted after executing the next instruction.
Refresh Cycle	Not acceptable	Not acceptable	Acceptable Refresh cycle precedes. DMA cycle begins at the end of one MC.	Not acceptable	Not acceptable	-	-
WAIT State	Acceptable	Not acceptable	DMA cycle begins at the end of MC.	Not acceptable	Accepted after executing the current instruction	-	-
Normal Operation (CPU mode) (IOSTOP mode)	Acceptable	Refresh cycle begins at the end of MC.	DMA cycle begins at the end of MC.	Bus is released at the end of MC.	Accepted after executing the current instruction.	-	-
Current		Refresh Request (Request of Refresh by the on-chip Refresh Controller)			NT ₀ , NT ₁	internal I/O Interrupt	IV.
Request	WAIT	Refresh Request (Request of Refresh by the on- Refresh Controller)	DREQ.	BUSREO	Interrupt		

NOTE) : not acceptable when DMA Request is in level sense.
| same as the above
MC: Machine Cycle

OHITACHI

HD64180R/Z

24 REQUEST PRIORITY

The HD64180 has the following three types of requests.

Type 2.

To be accepted in each machine cycle..... Refresh Reg. DMA Req. Bus Req.

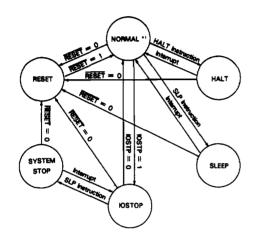
Type 3.

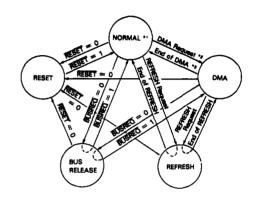
To be accepted in each instruction...... Interrupt Req.

Type 1, Type 2, and Type 3 requests priority is shown as follows. highest priority Type 1 > Type 2 > Type 3 lowest priority Each request priority in Type 2 is shown as follows. highest priority Bus Req. > Refresh Req. > DMA Req. lowest priority

(NOTE) If Bus Req. and Refresh Req. occurs simultaneously, Bus Req. is accepted but Refresh Req. is cleared. Refer to "2.7 Interrupts" for each request priority in Type 3.

25 OPERATION MODE TRANSITION





- 11 NORMAL: CPU executes instructions normally in NORMAL mode NOTE)
- DMA request: DMA is requested in the following cases.

 (1) DREQ_0, DREQ_1 = 0 (memory <---> (memory mapped) I/O DMA transfer)
 - (2) DEO = 1 (memory <---> memory DMA transfer)
 - 13 DMA end: DMA ends in the following cases
 - (1) DREQ., DREQ. = 1 (memory -> (memory mapped) I/O DMA transfer
 - (2) BCRO, BCR1 = 0000H (all DMA transfers)
 - (3) NIMI = 0 (all DMA transfers)

Other operation mode transitions

The following operation

BUS RELEASE

1. HALT DMA REFRESH BUS RELEASE IOSTOP ... (DMA REFRESH

2. SLEEP BUS RELEASE

SYSTEM STOP TO BUS RELEASE

26 STATUS SIGNALS

The following table shows pin outputs in each operating mode.

	Mode	LIR	ME	ΙΌĒ	RD	WR	ŘEF	HALT	BUSACK	ST	Address BUS	Data BUS
	Op-code Fetch (1st op-code)	0	0	1	0	1	1	1	1	0	A	iN
CPU	Op-code Fetch (except 1st op-code)	0	0	1	o	1	1	1	1	1	А	N.
operation	Memory Read	1	0	1	0	1	1	1	1	1	Α	IN
	Memory Write	1	0	1	1	Ö	1	1	1	1	Α	OUT
	I/O Read	1	1	0	0	1	1	1	1	1	A	IN
	I/O Write	1	1	0	1	0	1	1	1	1	Α	OUT
	Internal Operation	1	1	1	1	1	1	1	1	1	A	N.
Refresh		1	0	1	1	1	0	1_	1		А	EN.
nterrupt	NMI	0	0	1	0	1	1	1	1	0	A	IN
Acknowledge Cycle	INT ₀	0	1	0	1	1	1	1	1	0	Α	IN
(1st machine cycle)	INT 1, INT 2 & Internal Interrupts	1	1	1	1	1	1	1	1	0	A	#N
BUS RELEAS	SE	1	z	z	z	z	1	1	0	•	Z	7
HALT		0	0	1	0	1	1_	0	1	0	Α	. IN
SLEEP		1	1	1	1	1	1	0	1	1	1	N
	Memory Read	1	0	1	0	1	1	1	1	0	Α	IN
Internal	Memory Write	1	0	1	1	0	1_	1	1	0	Α	OUT
DMA	I/O Read	1	1	0	0	1	1	1	1	٥	Α	IN
	I/O Write	1	1	0	1	0	11	1	1	0	Α	OUT
RESET		1	1	1	1	1	1	1	1	1	Z	2

NOTE) 1 : HIGH

0 : LOW

A : Programmable Z : High Impedance

IN : Input

OUT : Output

Invalid

27 PIN STATUS DURING RESET AND LOW POWER OPERATION MODES

				Pin status in each	operation mode		
Pin No.	Symbol	Pin function	RESET	SLEEP	IOSTOP	SYSTEM STOP	
4	WAIT	_	IN (N)	IN (N)	N (A)	IN (N)	
6	BUSACK	-	1	OUT	OUT	OUT	
8	BUSREQ	-	IN (N)	IN (A)	IN (A)	IN (A)	
7	RESET	-	0	IN (A)	IN (A)	IN (A)	
8	NIXI	-	IN (N)	IN (A)	IN (A)	IN (A)	
9	NTo	_	IN (N)	IN (A)	IN (A)	IN (A)	
10	NT:	-	IN (N)	IN (A)	IN (A)	IN (A)	
11	NTi	-	IN (N)	N (A)	IN (A)	IN (A)	
12	ST	-	1	1	OUT	1	
13~30	Aa~A12	-	Z	1	A	1	
31	A1./TOUT	A ₁₄	Z	1	A	1	
		TOUT	Z	OUT	н	н	
34~41	Do~D7	-	Z	Z	A	Z	
42	RTS.	-	1	н	OUT	н	
43	ство	-	IN (N)	IN (A)	IN (N)	IN (N)	
44	DCDo	-	IN IN	IN (A)	IN (N)	IN (N)	
45	TXA ₀	-	1	OUT	Н	н	
48	RXAo		IN (N)	IN (A)	IN (N)	IN (N)	
47	CKAo/DREQo	CKAo (internal clock mode)	Z	OUT	Z	Z	
		CKAo (external clock mode)	Z	IN (A)	IN (N)	IN (N)	
		DREC	Z	IN (N)	IN (A)	IN (N)	
48	TXA	<u> </u>	1	OUT	н	н	
49	RXA		IN (N)	IN (A)	IN (N)	IN (N)	
50	CKA (/TENDo	CKA: (internal clock mode)	Z	OUT	Z	Z	
		CKA i (external clock mode)	Z	IN (A)	IN (N)	IÑ (N)	
		TEND₀	z	1	OUT	1	
51	TXS	<u>-</u>	1	OUT	н	н	
52	RXS/CTS.	RXS	IN (N)	iN (A)	IN (N)	IN (N)	
		CTS:	IN (N)	IN (A)	IN (N)	IN (N)	
53	CKS	CKS (internal clock mode)	Z	OUT	1 	1	
		CKS (external clock mode)	Z	IN (A)	Z	Z	
54	DREQ.	-	IN (N)	IN (N)	iN (A)	IN (N)	
55	TEND:		1	1	OUT	1	
56	HALT	-	1	0	OUT	0	
57	REF	-	1	1	OUT	1	
58	TOE	<u> </u>	1	1	OUT	1	
59	ME	_	1	1	OUT	1	
60	E		0	E clock output	-		
61	UR	-	1	1	OUT	1	
62	WR		1	1	OUT	1	
63	RD		1	1	OUT	1	
64	φ	-	φ clock output	-	-	-	

^{1:} HIGH 0: LOW A: Programmable 2: High Impedence IN (A): Input (Active) IN (N): Input (Not active) OUT: Output

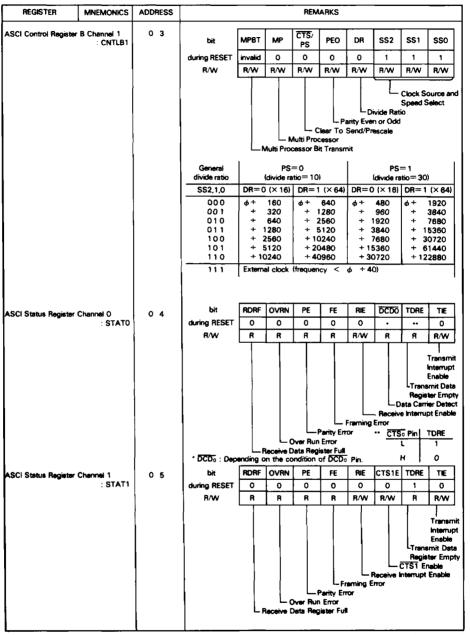
H: Holds the previous state :: same as the left

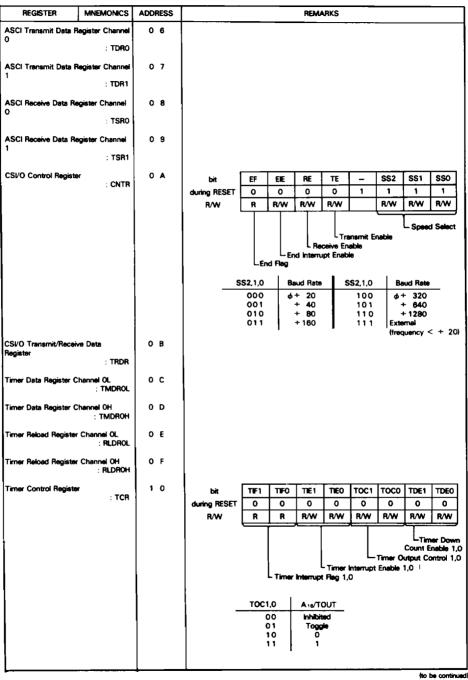
28 INTERNAL I/O REGISTERS

By programming IOA7 and IOA6 in the I/O control register, in-

ternal 1/O register addresses are relocatable within ranges from 0000H to 00FFH in the 1/O address space.

REGISTER	MNEMONICS	ADDRESS				REN	IARKS				
ASCI Control Register	A Channel 0 : CNTLA0	0 0	bit	MPE	RE	TE	RTSO	MPBR/	MOD2	MOD1	моро
			during RESET	├	-	0	1	invalid	0	0	
			R/W	R/W	R/W	RW	R/W	R/W	R/W	R/W	R/W
						Receive (Transmit Enable	Em equest T	or Flag F	ssor Bit	Selection Receive/
ASCI Control Register		0 1									
	: CNTLA1		bit	MPE	RE	TE	CKA1D	MPBR/ EFR	MOD2	MOD1	MODO
			during RESET	O R/W	0	0	1	invalid	0	0	
			I POW	LH/W_	R/W	R/W	R/W	R/W	R/W	R/W	R/W
			MOD2, 1, 0	L		Teceive Er	ransmit nable	KA1 Dis	or Flag	Reset	
			0 0 0 0 0 1 0 1 0 0 1 1 1 0 0 1 0 1 1 1 0 1 1 1	Start + Start + Start + Start + Start + Start + Start + Start +	7 bit Di 7 bit Di 7 bit Di 8 bit Di 8 bit Di 8 bit Di	eta + 2 eta + P eta + P eta + 1 eta + 2 eta + P	Stop anty + arity + Stop Stop arity +	2 Stop 1 Stop			
ASCI Control Register I	B Channel 0 : CNTLBO	0 2	bit	мрвт	MP	CTS/ PS	PEO	DR	SS2	SS1	sso
			during RESET	invalid	0		0	0	1	1	1
			R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
			- CTS : Dep PS : Clea	ending or	ulti Proc	Aulti Pro essor Bi	ear To S cessor t Transm	arity Eve iend/Pre: nit	S Divide Ra n or Ode	peed Se stio	urce and



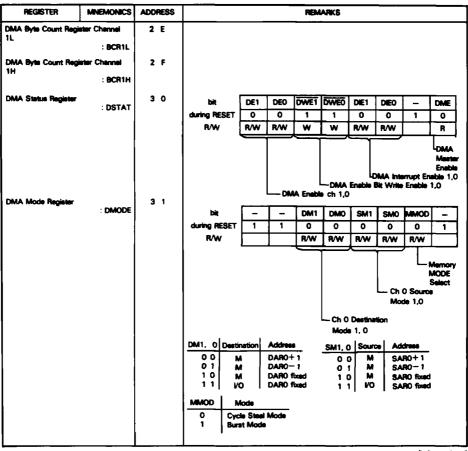


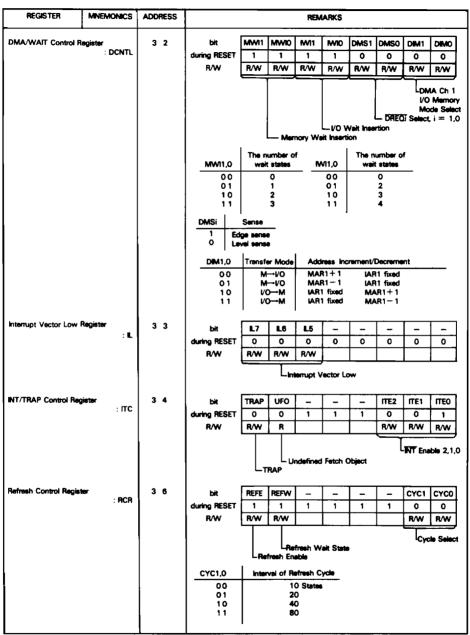
(40 DE COURTERO)

SAROL Chennel OH SAROH	REGISTER	MNEMONICS	ADDRESS	REMARKS
Timer Reload Register Channel 1L	Timer Data Register Cl		1 4	
Timer Reload Register Channel 1H RIDR1H Tree Running Counter 1 8 read only	Timer Data Register Ch		1 5	
RLDR1H	Timer Reload Register		1 6	
FRC	Timer Reload Register		1 7	
DMA Source Address Register Channel OL SAROL	Free Running Counter		1 8	read only
Channel OL SAROL DMA Source Address Register Channel OB SAR		: FRC		
DMA Source Address Register Chennel OH SAR	DMA Source Address I Channel OL	,	2 0	
SAROH SAROH SAROH SAROH SAROH SAROB SARO				
DMA Source Address Register Channel OB SAROB SAROB	DMA Source Address I Channel OH		2 1	
SAROB SARO		: SAROH		
SAROB	DMA Source Address i	Register	2 2	l
DMA Destination Address Register Channel OL DAROL DMA Destination Address Register Channel OH DAROB DMA Destination Address Register Channel OB DAROB DAROB DAROB DMA Byte Count Register Channel OL BEROL DMA Byte Count Register Channel OH BEROH DMA Byte Count Register Channel OH BEROH DMA Byte Count Register Channel OH BEROH DMA Memory Address Register Channel 1H MAR1L DMA Memory Address Register Channel 1B MAR1B DMA Wo Address Register Channel 1L I AR1L DMA VO Address Register Channel 1L I AR1L DMA VO Address Register Channel 1L I AR1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L	Channel Ob	: SAROB		
DMA Destination Address Register Channel OL DAROL DAROH DMA Destination Address Register Channel OH DMA Destination Address Register Channel OB DAROB				X 0 1 RDRO (ASCIO)
DMA Destination Address Register Channel OH DMA Destination Address Register Channel OB DAROB A1a, A1r, A1a DAROB DAROB A1a, A1r, A1a DAROB DAROB A1a, A1r, A1a DAROB	DMA Destination Addre	es Register	2 3	
Channel OH DMA Destination Address Register Channel OB DMA Destination Address Register Channel OB DMA Dyte Count Register Channel OL BCROL DMA Byte Count Register Channel OH BCROH DMA Memory Address Register Channel 1L MAR1L DMA Memory Address Register Channel 1B MAR1B DMA WO Address Register Channel 1L LIARIL DMA VO Address Register Channel 1L LIARIL DMA VO Address Register Channel 1L LIARIL DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L LIARIL DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L	Channel OL	: DAROL		'
DMA Destination Address Register Chennel OB DAROB	DMA Destination Addre Channel OH	-	2 4	
Chennel OB : DAROB				
DMA Byte Count Register Channel BCROL BCROH BCROH DMA Mernory Address Register Channel 1H MAR1H DMA Memory Address Register Channel 1B MAR1B DMA VO Address Register Channel 1 I I I I I I I I I I I I I I I I I I	DMA Destination Addre Channel OB	ss Register	2 5	1
DMA Byte Count Register Channel OL.: BCROL DMA Byte Count Register Channel OH: BCROH DMA Memory Address Register Channel 1L: MAR1L DMA Memory Address Register Channel 1H: MAR1H DMA Memory Address Register Channel 1B: MAR1B DMA VO Address Register Channel 1L: IAR1L DMA VO Address Register Channel 1L: IAR1L DMA VO Address Register Channel 1L: IAR1L DMA VO Address Register Channel 1L: IAR1L DMA VO Address Register Channel 1L: IAR1L		: DAROB		X O O DREQ (external)
DMA Byte Count Register Channel OH : BCROH DMA Memory Address Register Channel 1L : MAR1L DMA Memory Address Register Channel 1H : MAR1H DMA Memory Address Register Channel 1B : MAR1B DMA VO Address Register Channel 1L : IAR1L DMA VO Address Register Channel 1H DMA VO Address Register Channel 1L : IAR1L DMA VO Address Register Channel 1H	DMA Byte Count Regis OL		2 6	X 1 0 TDR1 (ASCI1)
DMA Memory Address Register Channel 1L I MAR1L DMA Memory Address Register Channel 1H I MAR1H DMA Memory Address Register Channel 1B I MAR1B DMA VO Address Register Channel 1L I L IAR1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L DMA VO Address Register Channel 1L	DAAA Daar Carres Baarin		2.7	
DMA Memory Address Register Channel 1L : MAR1L DMA Memory Address Register Channel 1H : MAR1H DMA Memory Address Register Channel 1B : MAR1B DMA VO Address Register Channel 1L : IAR1L DMA VO Address Register Channel 1H DMA VO Address Register Channel 1C : IAR1L	OH Syte Count Regis		2 /	
Channel 1L : MAR1L DMA Memory Address Register Channel 1H : MAR1H DMA Memory Address Register Channel 1B : MAR1B DMA VO Address Register Channel 1L : IAR1L DMA VO Address Register Channel 1H		: BCROH		
Chennel 1H : MAR1H DMA Memory Address Register Chennel 1B : MAR1B DMA I/O Address Register Chennel 1L : IAR1L DMA I/O Address Register Channel 2 B 1L DMA I/O Address Register Channel 2 C C	DMA Memory Address Channel 1L	-	28	
DMA Memory Address Register Chennel 1B : MAR1B DMA VO Address Register Channel 1L : IAR1L DMA VO Address Register Channel 2 B 1H	DMA Memory Address Channel 1H	-	2 9	
Chennel 18 : MAR18 DMA I/O Address Register Channel 2 B L: IAR1L DMA I/O Address Register Channel 2 C 1H		: MAR1H		
DMA I/O Address Register Channel 1	DMA Memory Address Channel 1B	-	2 A	Bits 0-2 are used for MAR1B.
1L : IAR1L DMA I/O Address Register Channel 2 C 1H	Data 1/0 4 34 5 :		2.0	
DMA I/O Address Register Channel 2 C	DMA VO Address Regi 1L		2 8	
1H		: IAR1L		
: IARTH	DMA I/O Address Regi 1H		2 C	
		: IAR1H		

Ito be continuedi







REGISTER	MNEMONICS	ADDRESS				REM	ARKS					
MMU Common Base	Register : CBR	3 8	bit		CB6	C85	CB4	СВЗ	CB2	CB1	СВО	
	· CBN		during RESET	0	0	0	0	. 0	0	0	0	
			R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
,			MMU Common Base Register									
MMU Bank Base Reg	ister : 888	3 9	bit	_	BB6	BB5	884	883	882	981	вво	
,			during RESET	0	0	0	0	0	0	0	0	
			R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	_								MMU B	onk Base	Register	
MMU Common/Bank	Area Register : CBAR	3 A	bit	CA3	CA2	CA1	CAO	BA3	BA2	BA1	BAO	
			during RESET	1	1	1	1	0	0	0	0	
			R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
							IU Com		,		Bank Register	
I/O Control Register	: ICR	3 F	bit	IOA7	IQA6	IOSTP	-	[-	-	I _	- 1	
			during RESET	0	0	0	1	1	1	1	1	
			R/W	R/W	R/W	R/W						
					-VO Ac) Stop					